

NEHRU COLLEGE OF ENGINEERING AND RESEARCH CENTRE (NAAC Accredited) (Approved by AICTE Affiliated to API Abdul Kalam Technological University



(Approved by AICTE, Affiliated to APJ Abdul Kalam Technological University, Kerala)

DEPARTMENT OF ELECTRONICS & COMMUNICATION ENGINEERING



SYLLABUS BOOK FOR STUDENTS

2015 SCHEME



VISION OF THE INSTITUTION

To mould true citizens who are millennium leaders and catalysts of change through excellence in education.

MISSION OF THE INSTITUTION

NCERC is committed to transform itself into a center of excellence in Learning and Research in Engineering and Frontier Technology and to impart quality education to mould technically competent citizens with moral integrity, social commitment and ethical values.

We intend to facilitate our students to assimilate the latest technological know-how and to imbibe discipline, culture and spiritually, and to mould them in to technological giants, dedicated research scientists and intellectual leaders of the country who can spread the beams of light and happiness among the poor and the underprivileged.

ABOUT DEPARTMENT

Established in: 2002

• Course offered : B.Tech in Electronics and Communication Engineering

M.Tech in VLSI

- Approved by AICTE New Delhi and Accredited by NAAC
- Affiliated to the University of Dr. A P J Abdul Kalam Technological University.

DEPARTMENT VISION

Providing Universal Communicative Electronics Engineers with corporate and social relevance towards sustainable developments through quality education.

DEPARTMENT MISSION

1) Imparting Quality education by providing excellent teaching, learning environment.

2) Transforming and adopting students in this knowledgeable era, where the electronic gadgets (things) are getting obsolete in short span.

3) To initiate multi-disciplinary activities to students at earliest and apply in their respective fields of interest later.

4) Promoting leading edge Research & Development through collaboration with academia & industry.

PROGRAMME EDUCATIONAL OBJECTIVES

PEOI. To prepare students to excel in postgraduate programmes or to succeed in industry / technical profession through global, rigorous education and prepare the students to practice and innovate recent fields in the specified program/ industry environment.

PEO2. To provide students with a solid foundation in mathematical, Scientific and engineering fundamentals required to solve engineering problems and to have strong practical knowledge required to design and test the system.

PEO3. To train students with good scientific and engineering breadth so as to comprehend, analyze, design, and create novel products and solutions for the real life problems.

PEO4. To provide student with an academic environment aware of excellence, effective communication skills, leadership, multidisciplinary approach, written ethical codes and the life-long learning needed for a successful professional career.

PROGRAM OUTCOMES (POS)

Engineering Graduates will be able to:

1. **Engineering knowledge**: Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialization to the solution of complex engineering problems.

- 2. **Problem analysis**: Identify, formulate, review research literature, and analyze complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.
- 3. **Design/development of solutions**: Design solutions for complex engineering problems and design system components or processes that meet the specified needs with appropriate consideration for the public health and safety, and the cultural, societal, and environmental considerations.
- 4. **Conduct investigations of complex problems**: Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions.
- 5. **Modern tool usage**: Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools including prediction and modeling to complex engineering activities with an understanding of the limitations.
- 6. **The engineer and society**: Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal and cultural issues and the consequent responsibilities relevant to the professional engineering practice.
- 7. **Environment and sustainability**: Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.
- 8. **Ethics**: Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.
- 9. **Individual and team work**: Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.
- 10. **Communication**: Communicate effectively on complex engineering activities with the engineering community and with society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.
- 11. **Project management and finance**: Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments.
- 12. Life-long learning: Recognize the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.

PROGRAM SPECIFIC OUTCOMES (PSO)

PSO1: Ability to Formulate and Simulate Innovative Ideas to provide software solutions for Realtime Problems and to investigate for its future scope.

PSO2: Ability to learn and apply various methodologies for facilitating development of high quality System Software Tools and Efficient Web Design Models with a focus on performance optimization.

PSO3: Ability to inculcate the Knowledge for developing Codes and integrating hardware/software products in the domains of Big Data Analytics, Web Applications and Mobile Apps to create innovative career path and for the socially relevant issues.



B Toch Sullaburg

B. Tech. Syllabus



Modified Syllabus for I & II Semester B. Tech. Degree

2016

Estd.

2014



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COURSE NO.	COURSE NAME	CREDITS	YEAR OF INTRODUCTION
MA 101	CALCULUS	4	2016

In this course the students are introduced to some basic tools in Mathematics which are useful in modelling and analysing physical phenomena involving continuous changes of variables or parameters. The differential and integral calculus of functions of one or more variables and of vector functions taught in this course have applications across all branches of engineering. This course will also provide basic training in plotting and visualising graphs of functions and intuitively understanding their properties using appropriate software packages.

Syllabus

Single Variable Calculus and Infinite series, Functions of more than one variable, Partial derivatives and its applications, Calculus of vector valued functions, Multiple Integrals.

Expected outcome

At the end of the course the student will be able to (i) check convergence of infinite series (ii) find maxima and minima of functions two variables (iii) find area and volume using multiple integrals (iv) apply calculus of vector valued functions in physical applications and (v) visualize graphs and surfaces using software or otherwise.

Text Books

(1)Anton, Bivens, Davis: Calculus, John Wiley and Sons, 10thed

(2)Thomas Jr., G. B., Weir, M. D. and Hass, J. R., Thomas' Calculus, Pearson

References:

- 1. Sengar and Singh, Advanced Calculus, Cengage Learning, Ist Edition
- 2. Erwin Kreyszig, Advanced Engineering Mathematics, Wiley India edition, 10thed.
- 3. B. S. Grewal, Higher Engineering Mathematics, Khanna Publishers, New Delhi.
- 4. N. P. Bali, Manish Goyal, Engineering Mathematics, Lakshmy Publications
- 5. D. W. Jordan, P Smith. Mathematical Techniques, Oxford University Press, 4th

Edition.

 A C Srivastava, P K Srivasthava, Engineering Mathematics Vol 1. PHI Learning Private Limited, New Delhi.

	APJ ABDUL KA	LAN	A
	COURSE NO: MA101 COURSE NAME: CALCULUS	L-T-P:3-1-0 CREDITS:4	L
MODULE	CONTENT	HRS	END SEM. MARK %
Ι	 Single Variable Calculus and Infinite series (Book I – sec 9.3,9.5,9.6,9.8) Basic ideas of infinite series and convergence - .Geometric series- Harmonic series-Convergence tests-comparison, ratio, root tests (without proof). Alternating series- Leibnitz Test- Absolute convergence, Maclaurins series-Taylor series - radius of convergence. (For practice and submission as assignment only: Sketching, plotting and interpretation of hyperbolic functions using suitable software. Demonstration of convergence of series bysoftware packages) 	9	15%
	Partial derivatives and its applications(Book I -sec. 13.3 to 13.5 and 13.8) Partial derivatives–Partial derivatives of functions of more than two variables - higher order partial derivatives - differentiability, differentials and local linearity -	5	
Π	The chain rule – Maxima and Minima of functions of two variables - extreme value theorem (without proof)-relative extrema .	4	15%

	FIRST INTERNAL EXAM		
	Calculus of vector valued functions(Book I- 12.1,12.2,12.4&12.6,13.6 &13.7)		
III	 Introduction to vector valued functions-parametric curves in 3-space Limits and continuity – derivatives - tangent lines – derivative of dot and cross product-definite integrals of vector valued functions- unit tangent-normal- velocity-acceleration and speed–Normal and tangential components of acceleration. Directional derivatives and gradients-tangent planes and normal vectors (For practice and submission as assignment only: Graphing parametric curves and surfaces using 	ALAM IC ³ AL Y ₃	15%
IV	software packages)Multiple integrals(Book I-sec. 14.1, 14.2, 14.3, 14.5)Double integrals- Evaluation of double integrals– Double integrals in non-rectangular coordinates- reversing the order of integration-Area calculated as a double integral- Triple integrals(Cartesian co ordinates only)- volume calculated as a triple integral- (applications of results only)	4 2 2 2	15%
	SECOND INTERNAL EXAM		
	Topics in vector calculus		
	(Book I-15.1, 15.2, 15.3)		
	Vector and scalar fields- Gradient fields –	2	

	conservative fields and potential functions –	2	
	divergence and curl - the ∇ operator - the	2	20%
V	Laplacian ∇^2 ,		
	Line integrals - work as a line integral-	2	
	independence of path-conservative vector field –	L2AA	Λ
	(For practice and submission as assignment only: graphical representation of vector fields using software packages)	ICA Y	L
	Topics in vector calculus (continued)		
VI	 (Book I sec., 15.4, 15.5, 15.7, 15.8) Green's Theorem (without proof- only for simply connected region in plane), surface integrals – Divergence Theorem (without proof for evaluating surface integrals), 	2 2 3	20%
	Stokes' Theorem (without proof for evaluating line integrals)	3	
	(All the above theorems are to be taught in regions in the rectangular co-ordinate system only)		
	END SEMESTER EXAM	19	

Open source software packages such as gnuplot, maxima, scilab ,geogebra or R may be used as appropriate for practice and assignment problems.

TUTORIALS: Tutorials can be ideally conducted by dividing each class in to three groups. Prepare necessary materials from each module that are to be taught using computer. Use it uniformly to every class.

Course No.	Course Name	L-T-P-Credits	Year of Introduction
PH100	ENGINEERING PHYSICS	3-1-0-4	2016

Most of the engineering disciplines are rooted in Physics. In fact a good engineer is more or less an applied physicist. This course is designed to provide a bridge to the world of technology from the basics of science and to equip the students with skills in scientific inquiry, problem solving, and laboratory techniques.

Syllabus

Harmonic Oscillations: Damped and Forced Harmonic Oscillations. Waves: One Dimensional and Three Dimensional waves, Interference: Interference in thin films (Reflected system) Diffraction: Fraunhofer and Fresnel Diffraction, Grating, Polarization of Light: Double refraction, production and detection of polarized light, Superconductivity: Properties and Applications. Quantum Mechanics: Schrodinger Equations- Formulation and Solution, Operators, Applications. Statistical Mechanics: Microstates and macro states Maxwell - Boltzmann, Bose-Einstein and Fermi Dirac statistics. Fermi level and its significance. Acoustics: Intensity of sound, Reverberation and design concepts, Ultrasonics: Production, Detection and Applications, NDT methods, Lasers: Properties, Working Principles, Practical Lasers. Photonics: Basics of Solid State lighting, Photo detectors, Solar Cells, Fiber Optics.

Expected outcome

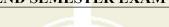
Familiarity with the principles of Physics and its significance in engineering systems and technological advances.

References:

- Aruldhas, G., Engineering Physics, PHI Ltd.
- Beiser, A., Concepts of Modern Physics, McGraw Hill India Ltd.
- Bhattacharya and Tandon, Engineering Physics, Oxford India
- Brijlal and Subramanyam, A Text Book of Optics, S. Chand & Co.
- Dominic and Nahari, A Text Book of Engineering Physics, Owl Books Publishers
- Hecht, E., Optics, Pearson Education
- Mehta, N., Applied Physics for Engineers, PHI Ltd
- Palais, J. C., Fiber Optic Communications, Pearson Education
- Pandey, B. K. and Chathurvedi, S., Engineering Physics, Cengage Learning
- Philip, J., A Text Book of Engineering Physics, Educational Publishers
- Premlet, B., Engineering Physics, Mc GrawHill India Ltd
- Sarin, A. and Rewal, A., Engineering Physics, Wiley India Pvt Ltd
- Sears and Zemansky, University Physics, Pearson
- Vasudeva, A. S., A Text Book of Engineering Physics, S. Chand & Co

Web:	physics.org		
	howstuffworks.com		
	physics.about.com		
	Course Plan		
Module	APJ ABContents L KALAM	Hours	Sem. Exam Marks
I	Harmonic Oscillations: Differential equation of damped harmonic oscillation, forced harmonic oscillation and their solutions- Resonance, Q factor, Sharpness of resonance- LCR circuit as an electrical analogue of Mechanical Oscillator (Qualitative)	5	15%
	Waves: One dimensional wave - differential equation and solution. Three dimensional waves - Differential equation & its solution. (No derivation) Transverse vibrations of a stretched string.	4	
Π	Interference: Coherence. Interference in thin films and wedge shaped films (Reflected system) Newton's rings-measurement of wavelength and refractive index of liquid Interference filters. Antireflection coating.	5	
	Diffraction Fresnel and Fraunhofer diffraction. Fraunhofer diffraction at a single slit. Plane transmission grating. Grating equation - measurment of wavelength. Rayleigh's criterion for resolution of grating- Resolving power and dispersive power of grating.	4	15%
	FIRST INTERNAL EXAM		
III	Polarization of Light: Types of polarized light. Double refraction. Nicol Prism. Quarter wave plate and half wave plate. Production and detection of circularly and elliptically polarized light. Induced birefringence- Kerr Cell - Polaroid & applications.	4	15%
	Superconductivity: Superconducting phenomena. Meissner effect. Type-I and Type-II superconductors. BCS theory (qualitative). High temperature superconductors - Applications of superconductors. 2014	5	1.570
IV	Quantum Mechanics: Uncertainty principle and its applications- formulation of Time dependent and Time independent Schrödinger equations- physical meaning of wave function- Energy and momentum Operators-Eigen values and functions- well potential .Quantum mechanical Tunnelling (Qualitative)	6	15%
	Statistical Mechanics: Macrostates and Microstates. Phase space. Basic postulates of Maxwell- Boltzmann, Bose-Einstein and Fermi Dirac	3	

	statistics. Distribution equations in the three cases (no derivation). Fermi Level and its significance.			
	SECOND INTERNAL EXAM			
V	V Acoustics: Intensity of sound- Loudness-Absorption coefficient -			
	Reverberation and reverberation time- Significance of reverberation time-	3		
	Sabine's formula (No derivation) -Factors affecting acoustics of a building.			
	Ultrasonics: Production of ultrasonic waves - Magnetostriction effect and		20%	
	Piezoelectric effect - Magnetostriction oscillator and Piezoelectric	4		
	oscillator - Detection of ultrasonics - Thermal and piezoelectric methods-			
	Applications of ultrasonics - NDT and medical.			
VI	Laser: Properties of Lasers, absorption, spontaneous and stimulated			
	emissions, Population inversion, Einstein's coefficients, Working principle		5	
	of laser, Optial resonant cavity. Ruby Laser, Helium-Neon Laser,	5		
	Semiconductor Laser (qualitative). Applications of laser, holography			
	(Recording and reconstruction)			
	Photonics: Basics of solid state lighting - LED – Photodetectors - photo		20%	
	voltaic cell, junction & avalanche photo diodes, photo transistors, thermal		207	
	detectors, Solar cells- I-V characteristics - Optic fibre-Principle of			
	propagation-numerical aperture-optic communication system (block	5		
	diagram) - Industrial, medical and technological applications of optical			
	fibre. Fibre optic sensors - Basics of Intensity modulated and phase			
	modulated sensors.			
	END SEMESTER EXAM			





Course No.	Course Name	L-T-P-Credits	Year of Introduction
CY100	ENGINEERING CHEMISTRY	3-1-0-4	2016

To enable the students to acquire knowledge in the concepts of chemistry for engineering applications and to familiarize the students with different application oriented topics like new generation engineering materials, storage devices, different instrumental methods etc. And to develop abilities and skills that are relevant to the study and practice of chemistry.

Syllabus

Spectroscopy - Principles and Applications, Electrochemistry - Electrodes, Electrochemical series and applications, Nernst Equation, Potentiometric titration and application, Cells, Instrumental Methods-Thermal Analysis, Chromatography; Conductivity, Chemistry of Engineering Materials, Copolymers, Conducting Polymers, Advanced Polymers, Nano materials, Fuels and Calorific value; Lubricants and their properties, Water Technology - Hardness, Water softening methods, Sewage water Treatment.

Expected outcome

The student will be able to apply the knowledge of chemistry and will be equipped to take up chemistry related topics as part of their project works during higher semester of the course.

- Ahad, J., Engineering Chemistry, Jai Publications
- Dara, S. S., Engineering Chemistry, S Chand Publishers
- Fernandez, A., Engineering Chemistry, Owl Book Publishers, ISBN 9788192863382
- Jain and Jain, Engineering Chemistry, Dhanpat Rai Publishers
- Kaurav, Engineering Chemistry with Laboratory Experiments. PHI, ISBN 9788120341746
- Manjooran K. S., Modern Engineering Chemistry, Kannatheri Publication
- Seymour, R. B., Introduction to Polymer Chemistry, McGraw Hill
- Rath, P., Engineering Chemistry, Cengage Learning, ISBN 9788131526699
- Wiley India, Engineering Chemistry, ISBN 9788126543205

	Course Plan			
Module	Contents	Hours	Sem.	
	2014		Exam	
	2014		Marks	
Ι	Spectroscopy: Introduction, Beer Lamberts Law (no derivations)(Numericals)	1		
	UV-visible spectroscopy - Principle, Instrumentation and applications	2		
	IR spectroscopy - Principle and applications (Numaericals)	2	15%	
	¹ H NMR spectroscopy - Principle, chemical shift - spin - spin splitting and applications including MRI(brief), Spectral Problems	4		
II	Electrochemistry: Different types of electrodes (general) – SHE, Calomel		15%	
	electrode, Glass electrode and determination of E^0 using SHE & Calomel	2	1070	

	electrode		
	Electrochemical series and its applications.(Numericals)	1	
	Nernst equation - Derivation, application & numericals	2	
	Potentiometric titration - Acid-base and redox titration	2	
	Lithium ion cell and Fuel cell.	1	
	FIRST INTERNAL EXAM		
III	Instrumental Methods: Thermal analysis - Principle, instrumentation and applications of TGA and DTA.	3	
	Chromatographic methods - Basic principles, column, TLC. Instrumentation and principles of GC and HPLC.	4	15%
	Conductivity - Measurement of conductivity	1	-
IV	Chemistry of Engineering Materials: Copolymers - BS, ABS - Structure and Properties.	1	
	Conducting Polymers - Polyaniline, Polypyrrole - Preparation, Structure and Properties.	2	
	OLED – An introduction	1	
	Advanced Polymers – Kevlar, Polybutadiene rubber and silicone rubber: Preparation, Structure and Properties.	2	15%
	Nanomaterials – Definition, Classification, chemical methods of preparation - hydrolysis and reduction	2	
	Properties and Applications – Carbon Nano Tubes and fullerenes.	1	
	SECOND INTERNAL EXAM		
V	Fuels and Lubricants: Fuels - Calorific Value, HCV and LCV -		
·	Determination of calorific value of a solid and liquid fuel by Bomb calorimeter - Dulongs formula and Numericals.	3	
	Liquid fuel - Petrol and Diesel - Octane number & Cetane number	1	200/
	Biodiesel - Natural gas.	2	20%
	Lubricant - Introduction, solid, semisolid and liquid lubricants.	1	
	Properties of lubricants - Viscosity Index, Flash point, Fire point, Cloud point, Pour point and Aniline point.	2	
VI	Water Technology: Types of hardness, Units of hardness, Estimation of Hardness – EDTA method. Numericals based on the above	3	
	Water softening methods - Ion exchange process - Principle. Polymer ion exchange.	2	20%
	Reverse Osmosis - Disinfection method by chlorination and UV	1	
	Dissolved oxygen, BOD and COD.	2	
	Sewage water Treatment - Trickling Filter and UASB process.	1	
	END SEMESTER EXAM		

Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE100	ENGINEERING MECHANICS	3-1-0-4	2016

- 1. To apply the principles of mechanics to practical engineering problems.
- 2. To identify appropriate structural system for studying a given problem and isolate it from its environment.
- 3. To develop simple mathematical model for engineering problems and carry out static analysis.
- 4. To carry out kinematic and kinetic analyses for particles and systems of particles.

Syllabus

Statics: Fundamental concepts and laws of mechanics; Force systems; Principle of moments; Resultant of force and couple systems; Equilibrium of rigid body; Free body diagram; Equilibrium of a rigid body in three dimension; Support reactions; Properties of surfaces and solids - Centroid, Moment of inertia, Polar moment of inertia, Mass moment of inertia, Product of inertia and Principal moment of inertia; Theorems of Pappus – Guldinus; Friction; Principle of virtual work.

Dynamics: Rectangular and cylindrical coordinate system; Combined motion of rotation and translation; Newton's second law in rectilinear translation; D' Alembert's principle; Mechanical vibration; Simple harmonic motion; Spring-mass model.

Expected outcome

- 1. Students will be able to apply and demonstrate the concepts of mechanics to practical engineering problems.
- 2. Students will be able to determine the properties of planes and solids.
- 3. Students will be able to apply fundamental concepts of dynamics to practical problems.

Text Books:

• Shames, I. H., Engineering Mechanics - Statics and Dynamics, Pearson Prentice

Estd.

• Timoshenko, S. & Young D. H., Engineering Mechanics, McGraw Hill

- Babu, J., Engineering Mechanics, Pearson Prentice Hall
- Beer and Johnson, Vector Mechanics for Engineers Statics and Dynamics, Tata McGraw Hill Publishing Company Limited
- Benjamin J., Engineering Mechanics, Pentex Book Publishers and Distributors
- Bhavikkatti, S. S., Engineering Mechanics, New Age International Publishers
- Hibbeler, R. C., Engineering Mechanics: Statics and Dynamics. Pearson Prentice Hall
- Kumar, K. L., Engineering Mechanics, Tata McGraw Hill Publishing Company Limited
- Merriam J. L. and Kraige L. G., Engineering Mechanics Vol. I and II, John Wiley
- Rajasekaran S. and Sankarasubramanian, G., Engineering Mechanics, Vikas Publishing House Private Limited
- Tayal, A. K., Engineering Mechanics- Statics and Dynamics, Umesh Publications

	Course Plan		
Module	Contents	Hours	Sem. Exam Marks
Ι	Statics: Fundamental concepts and laws of mechanics – Rigid body – Principle of transmissibility of forces	2	
	Coplanar force systems - Moment of a force – Principle of moments Resultant of force and couple system	2 4	15%
	Equilibrium of rigid body – Free body diagram – Conditions of equilibrium in two dimensions – Two force and three force members.	3	
II	Types of supports – Problems involving point loads and uniformly distributed loads only.	5	15%
	Force systems in space – Degrees of freedom – Free body diagram – Equations of equilibrium – Simple resultant and Equilibrium problems.	4	1,3 70
	FIRST INTERNAL EXAM	<u> </u>	
III	Properties of planar surfaces – Centroid and second moment of area (Derivations not required) - Parallel and perpendicular axis theorem – Centroid and Moment of Inertia of composite area.	3	
	Polar Moment of Inertia – Radius of gyration – Mass moment of inertia of cylinder and thin disc (No derivations required).	2	15%
	Product of inertia – Principal Moment of Inertia (conceptual level).	3	
	Theorems of Pappus and Guldinus.	1	
IV	Friction – Characteristics of dry friction – Problems involving friction of ladder, wedges and connected bodies.	6	1.50/
	Definition of work and virtual work – Principle of virtual work for a system of connection bodies – Problems on determinate beams only.	4	15%
	SECOND INTERNAL EXAM		
V	Dynamics: Rectangular and Cylindrical co-ordinate system Combined motion of rotation and translation – Concept of instantaneous	1	
	centre – Motion of connecting rod of piston and crank of a reciprocating pump.	4	20%
	Rectilinear translation – Newton's second law – D'Alembert's Principle – Application to connected bodies (Problems on motion of lift only).	4	
VI	Mechanical vibrations – Free and forced vibration - Degree of freedom. Simple harmonic motion – Spring-mass model – Period – Stiffness –	1 7	20%
	Frequency – Simple numerical problems of single degree of freedom. END SEMESTER EXAM		

Course No:	Course Name	L-T-P Credits	Year of Introduction
BE110	*ENGINEERING GRAPHICS	1-1-3-3	2016
*As this course is	practical oriented, the evaluation is diff	ferent from other lec	ture based courses.
Points to note:	APJ ABDUI	l kal	AM
(1) End seme	ster examination will be for 50 marks and	of 3 hour duration.	`AI
(2) End seme	ster exam will include all modules except	Module IV.	Contraction of the second seco
	s are allotted for internal evaluation: first AD Lab Practice) and class exercises 20 m		arks, second internal exam 40
practical	internal exam will be based on modules exam in CAD based on Module IV along semester.		
Course Objective	es		-
To enable the stud per standards.	lent to effectively communicate basic	designs through gra	phical representations as
Syllabus			
	ngineering Graphics; Orthographic pro		
Perspective projection	and sketching, Introduction to CAD, Section.	ctions of solids, De	evelopment of surfaces,
Expected outcon	ne Estd		
Upon successful of abilities and skills	completion of this course, the student v	vould have accomp	lished the following
1. Fundamenta	l Engineering Drawing Standards.	4	
2. Dimensionin	ng and preparation of neat drawings an	d drawing sheets.	
3. Interpretation	n of engineering drawings		
4. The features	s of CAD software		

- Agrawal, B. and Agrawal, C. M., Engineering Drawing, Tata McGraw Hill Publishers
- Anilkumar, K. N., Engineering Graphics, Adhyuth Narayan Publishers
- Benjamin, J., Engineering Graphics, Pentex Publishers
- Bhatt, N., D., Engineering Drawing, Charotar Publishing House Pvt Ltd.
- Duff, J. M. and Ross, W. A., Engineering Design and Visualization, Cengage Learning, 2009
- John, K. C., Engineering Graphics, Prentice Hall India Publishers
- Kirstie Plantenberg, Engineering Graphics Essentials with AutoCAD 2016 Instruction, 4th Ed., SDC Publications
- Kulkarni, D. M., Rastogi, A. P. and Sarkar, A. K., Engineering Graphics with AutoCAD, PHI 2009
- Luzadder, W. J. and Duff, J. M., Fundamentals of Engineering Drawing, PHI 1993
- Parthasarathy, N. S., and Murali, V., Engineering Drawing, Oxford University Press
- Varghese, P. I., Engineering Graphics, V I P Publishers
- Venugopal, K., Engineering Drawing & Graphics, New Age International Publishers
 Course Plan

Module	Contents	Hours	Sem. Exam Marks
	6 exercises		
	Introduction to Engineering Graphics: Need for engineering		
I	drawing.	14	20%
	Drawing instruments; BIS code of practice for general	1.5	
	engineering drawing.	1	
	Orthographic projections of points and lines:-Projections of		
	points in different quadrants; Projections of straight lines		
	inclined to one of the reference planes, straight lines		
	inclined to both the planes; True length and inclination of		
	lines with reference planes; Traces of lines.		

	12 exercises		
II	Orthographic projections of solids:-Projections of simple solids* in simple positions, projections of solids with axis inclined to one of the reference planes and axis inclined to both the reference planes.	11 Г <u>А </u> А	20%
	ALL ADDOLL'NA	LAIV	1
ш	 12 exercises Isometric Projections:-Isometric projections and views of plane figures simple* and truncated simple* solids in simple position including sphere and hemisphere and their combinations. Freehand sketching: Freehand sketching of real objects, conversion of pictorial views into orthographic views and vice versa. 	QAI 09	20%
IV	6 exercises Introduction to Computer Aided Drafting - familiarizing various coordinate systems and commands used in any standard drafting software - drawing of lines, circle, polygon, arc, ellipse, etc. Creating 2D drawings. Transformations: move, copy, rotate, scale, mirror, offset and array, trim, extend, fillet, chamfer. Dimensioning and text editing. Exercises on basic drafting principles, to create technical drawings. Creation of orthographic views of simple solids from pictorial views. Creation of isometric views of simple solids from orthographic views. Solid modelling and sectioning of solids, extraction of 2D drawings from solid models. (For internal examination only, not for University Examination).	15 (Additional hours are allotted in U slot for CAD practice)	Internal
	SECOND INTERNAL EXAM (to be conducted only after fin	ishing CAD Pra	ctice.)
	9 exercises		
v	Sections and developments of solids: - Sections of simple* solids in simple vertical positions with section plane inclined to one of the reference planes - True shapes of sections. Developments of surfaces of these solids.	12	20%

	6 exercises		
VI	Intersection of surfaces: - Intersection of prism in prism and cylinder in cylinder - axis bisecting at right angles only. Perspective projections: - perspective projections of simple* solids.	09	20%
	riangular, square, pentagonal and hexagonal prisms, pyramids, c inders.	cones and	1
	TECHNOLOGI	ÇAI	-
	END SEMESTER EXAM	Y	

Note:

- 1. First angle projection is to be followed.
- 2. CAD Practice is mandatory and shall be conducted in the time slot allotted for U slot in addition to 15 hours allotted for Module IV

Question Paper Pattern: Question Paper shall contain eight questions of 10 marks each out of which five questions are to be answered as explained below. The duration of examination is 3 hours.

Part A: Three questions from Modules I & II out of which two are to be answered.

Part B: Five questions from Modules III, V & VI out of which three are to be answered.

The questions are to be answered in A4 size booklet containing grid/plain sheets supplied by the university. Drawing sheets are not needed.

The evaluation of answers shall be based on the correctness of solution, judging the knowledge of student in concepts and principles of Engineering Graphics. Accuracy and neatness shall not be criteria for evaluation. 2014

Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE101-01	INTRODUCTION TO CIVIL	2-1-0-3	2016
	ENGINEERING		

- 1. To provide the students an overview of the profession of Civil Engineering.
- 2. To give the students an illustration of the use and properties of various building materials and explain the building construction aspects.

Syllabus

Civil Engineering as a profession; General introduction to history of Civil Engineering; types and classification of building; setting out of a building; Building materials - Stones, Bricks, Tiles, Cement, Aggregate, Cement mortar, Timber, Steel; Building Construction - Stone Masonry, Brick Masonry, Floors and flooring, Roofs and roof coverings.

Expected outcome

Students will be able to explain the importance of Civil Engineering in the infrastructural development of the society.

- 1. They will be able to illustrate the types, uses and properties of various building materials.
- 2. Students will be able to explain the method of construction of different components of a building.

- Chen, W. F. and Liew, J. Y. R., (Eds.), The Civil Engineering Handbook, Second Edition, CRC Press (Taylor and Francis)
- Dalal, K. R., Essentials of Civil Engineering, Charotar Publishing House
- Gopi, S., Basic Civil Engineering, Pearson Publishers
- Kandya, A. A., Elements of Civil Engineering, Charotar Publishing house
- Mamlouk, M. S. and Zaniewski, J. P., Materials for Civil and Construction Engineering, Pearson Publishers.
- McKay, W. B. and McKay, J. K., Building Construction Volumes 1 to 4, Pearson India Education Services
- Rangwala, S. C. and Dalal, K. B., Engineering Materials, Charotar Publishing house
- Rangwala, S. C. and Dalal, K. B., Building Construction, Charotar Publishing house

Course Plan			
Module	Contents	Hours	Sem. Exam Marks
Ι	General introduction to Civil Engineering - History of CivilEngineering - Relevance of Civil Engineeringin the overallinfrastructural development of the country.	2	15%
	Types and classification of structures - buildings, towers, chimneys, bridges, dams, retaining walls, water tanks, silos, roads, railways,	3	

	runways and pipelines (Brief description only)			
	Definition and types of buildings as per National Building Code of India (brief description only).	1		
	Selection of site - Components of a building and their functions - Setting out of a building.	2		
П	Stones: Classification of stones - Qualities of good building stones - Quarrying - Dressing - Tests - Specifications - Uses of common building stones.	2		
	Bricks: Composition of good brick earth - Classification - Qualities of good bricks - Field and laboratory tests - Specifications.	- 2	15%	
	Tiles: Classification - Manufacture - Properties - Tests - Specifications	3		
	FIRST INTERNAL EXAM			
III	Cement: Basic Ingredients – Manufacturing process - Grades - Properties - Tests - Specifications.	4	- 15%	
	Aggregates: Fine and coarse aggregate - Properties - Uses - Tests.	3	1570	
	Cement Mortar: Types and preparation.	1		
IV	Stone Masonry: Types - Details of Ashlar, Random Rubble, CoarseRubble and Dry Rubble Masonry.	3		
	Brick Masonry: Types - Bond - Introduction to all types of bonds - English bond in detail (1, 1 ¹ / ₂ and 2 brick walls) - Comparison of stone and brick masonry.	4	15%	
	SECOND INTERNAL EXAM			
V	Timber: Properties - Uses - Classification - Seasoning - Defects - Preservation - Tests; Hard board and Particle board - Manufacture and use.	3	20%	
	Steel: Structural steel and steel as reinforcement - Types - Properties - Uses - Market forms.	3		
VI	Floors and Flooring materials: Different types and selection of floors and floor coverings.	3	20%	
	Roofs and roof coverings: Different types of roofs - Suitability - Types and selection of roofing materials.	3	2070	
	END SEMESTER EXAM			

Course No:	Course Name	L-T-P Credits	Year of Introduction
BE101-02	INTRODUCTION TO MECHANICAL ENGINEERING SCIENCES	2-1-0-3	2016
Course Obje	ectives		
1. To int	troduce different disciplines of Mechanical En	gineering	N A
2. To kin	ndle interest in Mechanical Engineering	KALA	M
	part basic mechanical engineering principles	NOIC	À T
Syllabus	IECHNOL	JUL	AL
	mics & Power sources, Thermal Engineering, & Aeronautical Engineering, Engineering Mat		
Expected Ou	tcome		
	the course, the students will have exposed to the		
Engineering;	gained idea about nature, scope and applications	s of Mechanical En	gineering principles.
References I	Books:		
	ossat, R. J., Principles of Refrigeration, PHI		
	eywood, J., Internal Combustion Engine Fund	amentals. McGray	w Hill Publishers
	olman, J. P., Thermodynamics, McGraw Hill		
	in, K. K. and Asthana, R. B., Automobile Eng		nopal
	nathan Wickert, Introduction to Mechanical E		-
	alpakjian, S. and Schmid, S. R., Manufa	cturing Processe	s for Engineering
• M	laines, R., Landmarks in Mechanical Engineer	ing, ASME	
• Pe	eng, W. W., Principles of Turbomachinery, Jol	hn Wiley & Sons	
• Pi	ta, E. G., <mark>Air Conditioning P</mark> rinciples & Syste	ms, PHI.	
	palding, D. B. and Cole, E. H., Engineerin rnold (Pub) Ltd.	g Thermodynami	cs, ELBS & Edward
• St	one, R. and Ball, T. K., Automotive Engineer	ing Fundamentals,	SAE International
• Sı	utton, G. P. and Ro <mark>ss, D. M., Rocket Propulsic</mark>	on Elements, John	Wiley & Sons
	on Karman, T., Aerodynamics: Selected Tistorical Development, Courier Corporation	Fopics in the Li	ght of Their
• 0	nline course on Refrigeration & Air condition	ing, IIT Kharagpu	r <u>www.nptel.ac.in</u>
		. –	

	Course Plan		
Module	Contents	Hours	Sem. Exam Marks
I	Thermodynamics : Nature and scope of thermodynamics; Basic concepts ; Laws of thermodynamics- Discovery, Significance & Applications; Qualitative ideas on Entropy, Available energy, Irreversibility, Principle of increase of entropy & Carnot engine; Limitations of Thermodynamics; Sources of power; history of power production; power production in the future.	8	15%
П	Thermal Engineering: Historical development of steam engine, steam turbines, gas turbines and hydraulic turbines; Principle of turbomachinery; History of IC engines; two stroke and four stroke engines-working, applications; Air compressors- types and uses; Principles of Rocket propulsion, chemical rockets, Indian space programme	8	15%
	FIRST INTERNAL EXAM		
III	Refrigeration & Air Conditioning: History & scope of refrigeration; applications of refrigeration; Food preservation, refrigerated storage; applications in chemical and process industries; special applications; Air conditioning- Principles & systems; scope of air conditioning;Psychrometric properties of air; Human comfort; comfort standards.	7	15%
IV	Automobile & Aeronautical Engineering: Introduction to an Automobile; history of the automobile; Indian Automobiles; Types of automobiles; Major components and their functions; Manufacturers of motor vehicles in India; Fundamentals of aerodynamics; drag force and lift force; jet engines types and applications.	7	15%
	SECOND INTERNAL EXAM	LI	
V	Engineering Materials: Introduction and history of materials; Basic crystallography; metals, alloys, composites, ceramics, polymers; mechanical properties and testing of engineering materials.		
V		5	20%
VI	Manufacturing Engineering :	7	20%

Methods of manufacturing; casting, forging, rolling, extrusion; machining operations – turning, milling, drilling, grinding, shaping, planing; Joining operations – soldering, brazing & welding; Introduction to CNC machines(elementary idea only); examples of typical products manufactured by above methods.

END SEMESTER EXAM

Question Paper Pattern:

Part A: Modules I and II – three questions of 15 marks each – out of which two questions are to be answered.

Part B: Modules III and IV – three questions of 15 marks each – out of which two questions are to be answered.

Part C: Modules V and VI – three questions of 20 marks each – out of which two questions are to be answered.

Estd.

2014

Each question can have maximum of four subdivisions (a,b,c,d).

Course No.	Course Name	L-T-P Credits	Year of Introduction
BE101-03	INTRODUCTION TO	2-1-0-3	2016
	ELECTRICAL ENGINEERING		
A	DIADDIII	LZATA	A. A.
Course Objectiv	REPT ABDUL	KALA	IVI

The objective of this course is to set a firm and solid foundation in Electrical Engineering with strong analytical skills and conceptual understanding of basic laws and analysis methods in electrical and magnetic circuits.

Syllabus

Fundamental Concepts of Circuit Elements and Circuit variables, Real and Ideal independent voltage and current sources, V-I relations; Basic Circuit Laws, Analysis of resistive circuits, Magnetic Circuits, Electromagnetic Induction; Alternating current fundamentals, Phasor Concepts, Complex representation, Phasor analysis of RL, RC, RLC circuit, admittances; Complex Power, Resonance in series and parallel circuits; Three-phase systems, analysis of balanced and unbalanced star and delta connected loads.

Expected outcome

The course will enable students to learn advanced topics in Electrical Engineering

- •Bhattacharya, S. K., Basic Electrical & Electronics Engineering, Pearson
- •Bird, J., Electrical Circuit Theory and Technology, Routledge, Taylor & Francis Group
- •Edminister, J., Electric Circuits, Schaum's Outline Series, Tata McGraw Hill
- •Hayt, W. H., Kemmerly, J. E., and Durbin, S. M., Engineering Circuit Analysis, Tata McGraw Hill
- •Hughes, Electrical and Electronic Technology, Pearson Education
- •Parker and Smith, Problems in Electrical Engineering, CBS Publishers and Distributors
- •Sudhakar and Syam Mohan, Circuits and Networks Analysis and Synthesis, Tata McGraw Hill
- •Suresh Kumar, K. S, Electric Circuits and Networks, Pearson Education

	Course Plan		
Module	Contents	Hours	Sem. Exam. Marks
1	Fundamental Concepts of Circuit Elements and Circuit variables: Electromotive force, potential and voltage. Resistors, Capacitors Inductors- terminal V-I relations Electromagnetic Induction: Faraday's laws, Lenz's law, statically and dynamically induced EMF, self and mutual inductance, coupling coefficient-energy stored in inductance		1 L 15%
	Real and Ideal independent voltage and current sources, V-I relations. Passive sign convention Numerical Problems (Module I)	1	
II	Basic Circuit Laws: Kirchhoff's current and voltage laws, analysis of resistive circuits-mesh analysis – super mesh analysis Node analysis-super node analysis, star delta transformation Numerical problems (Module II)	2 2 2	15%
	FIRST INTERNAL EXAMINATION		
	Magnetic Circuits: Magneto motive force, flux, reluctance, permeability -comparison of electric and magnetic circuits, analysis of series magnetic circuitsParallel magnetic circuits, magnetic circuits	2	15%
	with air-gaps. Numerical problems (Module III)	2	
IV	Alternating current fundamentals:-Generation of Alternating voltages-waveforms, Frequency, Period, RMS and average values, peak factor and form factor of periodic waveforms (pure sinusoidal) and composite waveforms	3	15%

	Phasor Concepts, Complex representation (exponential, polar and rectangular forms) of sinusoidal voltages and currents phasor diagrams	2	
	Complex impedance - series and parallel		
	A impedances and admittances, Phasor analysis of RL, RC, RLC circuits	ÅN	1
	Numerical problems. (Module IV)	2	
	SECOND INTERNAL EXAMINATION	/	
	Complex Power : Concept of Power factor:	1	
	active, reactive and apparent power	1	
	Resonance in series and parallel circuits	2	
V	Energy, bandwidth and quality factor, variation		20%
	of impedance and admittance in series and	2	
	parallel resonant circuits	6-1	
	Numerical problems (Module V)	2	
	Three phase systems: Star and delta		
	connections, three-phase three wire and three- phase four-wire systems	2	
VI	Analysis of balanced and unbalanced star and delta connected loads	2	20%
	Power in three-phase circuits. Active and Reactive power measurement by one, two, and three wattmeter methods	2	
	Numerical problems (Module VI)	2	
	END SEMESTER EXAMINATION		

Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE101-04	INTRODUCTION TO ELECTRONICS	2-1-0-3	2016
	ENGINEERING		

- 1. To get basic idea about types, specification and common values of passive components
- 2. To familiarize the working and characteristics of diodes, transistors and MOSFETS
- 3. To understand working of diodes in circuits and in rectifiers
- 4. To familiarize some measuring instruments

Syllabus

Evolution and Impact of Electronics, Familiarization of Resistors, Capacitors, Inductors,

Transformers and Electro mechanical components, Semiconductors, PN junction diode, Zener diode, LED, photo diode, Bipolar Junction Transistors: Structure, principle of operation, different configurations, load line and operating point, biasing and stabilization, Transistor as amplifier, switch, Junction Field Effect Transistors: Structure, principle of operation, characteristics MOSFET: Structure, principle of operation, characteristics, Principle of operation of Photo transistor, UJT, SCR, Diode circuits and power supplies: Series and parallel diode circuits, Half-wave & full wave rectifiers, capacitor filter, zener voltage regulator, Electronic Measurements and measuring Instruments: Performance parameters, Analog and digital multimeter, CRO, DSO, function generator, Testing of Electronic components.

Expected outcome

Student can identify the active and passive electronic components and can design and setup simple circuits using diodes and transistors. Voltage and currents can be measured and monitored using electronic measuring instruments

- Bell, D. A., Electronic Devices and Circuits, Oxford University Press
- Boylested, R. L. and Nashelsky, L., Electronic Devices and Circuit Theory, Pearson Education
- Kal, S., Basic Electronics: Devices, Circuits and its Fundamentals, PHI Learning
- Millman, J., Halkias, C. and Parikhu, C. D., Integrated Electronics, Tata Mc Graw Hill
- Neaman, D. A., Electronic Circuits Analysis and Design, McGraw Hill
- Sedra, A. S. and Smith, K. C., Microelectronic Circuits, Oxford University Press

Course Plan			
Module	Contents	Hours	Sem. Exam Marks
Ι	Evolution of Electronics, Impact of Electronics in industry and in society.	1	
	Resistors, Capacitors: types, specifications. Standard values, marking, colour coding.	3	15%
	Inductors and Transformers: types, specifications, Principle of working.	2]

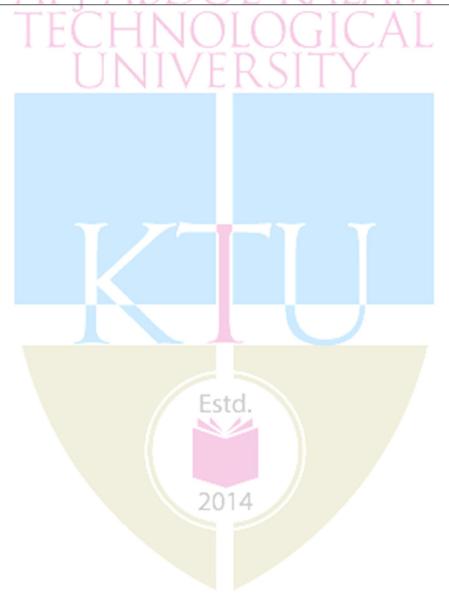
	Electro mechanical components: relays and contactors.	1	
II	Diodes: Intrinsic and extrinsic semiconductors, PN junction diode, barrier		
	potential, V-I characteristics, Effect of temperature. Equivalent circuit of a	3	
	diode. Piece wise linear model.		150/
	Specification parameters of diodes and numbering.	1	15%
	Zener diode, Varactor diodes, characteristics, working principle of LED, photo diode, solar cell.	3	
	FIRST INTERNAL EXAM		
III	Bipolar Junction Transistors: Structure, typical doping, Principle of operation, concept of different configurations. Detailed study of input and output characteristics of common base and common emitter configuration, current gain, comparison of three configurations.	3	1.50/
	Concept of load line and operating point. Need for biasing and stabilization, voltage divider biasing, Transistor as amplifier, switch, RC coupled amplifier and frequency response	3	15%
	Specification parameters of transistors and type numbering	1	
IV	Junction Field Effect Transistors: Structure, principle of operation, characteristics, comparison with BJT.	2	
	MOSFET: Structure, principle of operation of Enhancement type MOSFET, Current voltage characteristics, Depletion-type MOSFET.	2	15%
	Principle of operation of Photo transistor, UJT, SCR.	3	
	SECOND INTERNAL EXAM		
V	Diode circuits and power supplies: Series and parallel diode circuits, Clippers, Clampers, Voltage multipliers	3	
	Half-wave and full wave (including bridge) rectifiers, Derivation of V_{rms} , V_{dc} , ripple factor, peak inverse voltage, rectification efficiency in each case, capacitor filter, working and design of a simple zener voltage regulator. Block diagram description of a DC Power supply, Principle of SMPS	4	20%
VI	Electronic Measurements and measuring Instruments.	2	
	Generalized performance parameters of instruments: error, accuracy, sensitivity, precision and resolution. 2014 Principle and block diagram of analog and digital multimeter, Block diagram of CRO, Measurements using CRO, Lissajous patterns, Principle and block diagram of DSO, function generator.	4	20%
	Testing of Electronic components.	1	
	END SEMESTER EXAM	-	8

Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE101-05	INTRODUCTION TO COMPUTING AND PROBLEM SOLVING	2-1-0-3	2016
Course Obje	ctives		
1. To learn	basics of digital computers		
	op problem solving skills		N A
	programming and to solve problems using comp	puters	IVI
Syllabus Introduction 1	o digital computer, Introduction to programming	g languages, Opera	ting systems, Problem
Solving strate	egies, Examples for algorithms and flow cha	arts, Introduction	to Python language,
functions, pa	rameters and arguments, Boolean Expressions,	logical operators	and control statements
Strings, lists	tuples and dictionaries, operations, Files,	introduction to	objects, attributes and
instances	······································		
Expected out 1. Ability to	b design algorithmic solution to problems.		
•	o convert algorithms to Python programs.		
	b design modular Python programs using function	ons	
4. Ability t	o design programs with Interactive Input and is, decision making, arrays.		g arithmetic expression
-	design programs using file Input and Output.		
	o develop recursive solutions.		
Text Books:			
• Down 2015	ey, A. et al., How to think like a Computer Scie	ntist: Learning wi	th Python, John Wiley,
• Goel,	A., Computer Fundamentals, Pearson Education	n	
	ert K. A., Fundamentals of Python - First Progra		rning India, 2015
• Rajara	aman, V., Computer Basics and C Programming	g, Prentice-Hall In-	dia
References E			
• Barry	, P., Head First Python, , O' Reilly Publishers		
• Drom	y, R. G., How to solve it by Computer, Pearson	India	
• Guzdi	al, M. J., Introduction to Computing and Progra	umming in Python	, Pearson India
• Perko	vic, L., Introduction to Computing <mark>U</mark> sin <mark>g Pytho</mark>	n, 2/e, John Wiley	, 2015
• Spran	kle , M., Problem Solving & Programming Con	cepts, Pearson Inc	lia
• Venit,	S. and Drake, E., Prelude to Programming: Con	ncepts & Design,	Pearson India
	J., Python Programming: An Introduction to Co iates Inc.	omputer Science, I	Franklin, Beedle &

	nttps://www.coursera.org/course/pythonlearn		
	Course Plan		
Module	API ARI VII KALAM	Hours	Sem. Exam Marka
I	 Introduction to digital computer – Von Neumann concept – A simple model of computer, acquisition of data, storage of data, processing of data, output of processed data. Details of functional units of a computer. Storage – primary storage and secondary storage. (<i>The discussion should focus more on the functionalities of the units and their interaction than on specific hardware details. However, concepts like memory cells and their addressability (need not be binary), registers, interconnections (buses) have to introduced at an abstract level. For storage devices – primary and secondary –, various categories have to be introduced along with their distinguishing features. For I-O devices also, various categories are to be introduced. The Von Neumann concept should be effectively introduced. History computers need not be taught. However, students have to be encouraged to read the relevant sections of the text book. Chapters 1 – 4 of 'Goel' may be used to support teaching -learning.)</i> Introduction to programming languages:- types of programming languages - high level language , assembly language and machine language, System software - Operating systems – objectives of operating systems, compiler, assembler and interpreter. (For all the above topics, focus should be more on the concepts, significance and objectives. Chapter 6 and 7 (up to 7.4) of 'Goel' may be used to support the teaching-learning process.) 	8	15%
Ш	Problem Solving strategies – Problem analysis – formal definition of problem – Solution – top- down design – breaking a problem into sub problems- overview of the solution to the sub problems by writing step by step procedure (algorithm) - representation of procedure by flowchart - Implementation of algorithms – use of procedures to achieve modularity. <i>(For this part the instructor has to initially use suitable analogies of real world problems to explain the concepts, before delving into computer- solvable problems.)</i>	8	15%

	with non-numerical examples, and numeric problems like factorial, largest among three numbers, largest among N, Fibonacci <i>etc.; to be introduced</i> <i>with progressive levels of difficulty</i>) must be discussed in detail. (Class assignments and/or tutorials may be used to strengthen understanding of		
	this part. Chapters 4 and 5 of the 'Rajaraman' may be used for the		
	teaching-learning process.)		
	FIRST INTERNAL EXAM	1	
III	Introduction to <i>Python</i> – variables, expressions and statements, evaluation of expressions, precedence, string operations		
	(Note:- the instructor can demonstrate simple programs to the students and encourage them to develop similar ones. In particular, before attempting programs containing functions, the students should be given enough support and time to develop python code containing long sequence of statements for the simple flowcharts developed earlier. This will strengthen the students' understanding of instruction sequencing. Chapters 1 and 2 of 'Downey' have to be covered. Chapter 1 & 2 of 'Lambert' can also be used.) Control statements, Boolean expressions and logical operators, conditional and alternative executions (Note: - Chapter 4 of 'Downey' up to Section 4.9 has to be covered. The instructor should demonstrate each of these concepts with real examples and encourage students to develop as many as possible. Chapter 3 of 'Lambert' can be used for detailed discussion and self-study) Iteration - while statement and tables. (Note: - Chapter 6 of 'Downey' has to be covered. Chapter 3 of	8	15%
	'Lambert' can be used for detailed discussion and self-study.)		
IV	 Functions, calling functions, type conversion and coercion, composition of functions, mathematical functions, user-defined functions, parameters and arguments. (Note: - Chapter 3 of 'Downey' has to be covered. The instructor should demonstrate each aspect of the function with real examples and encourage students to develop their own. Chapter 6 (up to 6.3) of 'Lambert' can be used for detailed discussion and self-study.) 	6	15%
	SECOND INTERNAL EXAM		
V	Strings and lists – string traversal and comparison with examples. (Note: - Chapter 7 of 'Downey' has to be covered. Section 4.1 of 'Lambert' can be used for detailed discussion and self-study.) List operations with examples (Note: - Chapter 8 of 'Downey' up to Section 8.6 has to be covered. Section 5.1 of 'Lambert' can be used for detailed discussion and self-study.); tuples and dictionaries – operations and examples (Note: -	6	20%

	Chapters 9 & 10 of the third text have to be covered. Section 5.4 of 'Lambert' can be used for detailed discussion and self-study.)	
VI	Files and exceptions - text files, directories (Note: - Chapter 11 of 'Downey' has to be covered) Introduction to classes and objects - attributes, instances	×
	(Note: - Chapter 12 of 'Downey' up to Section 12.6 has to be covered)	
	- END SEMESTER EXAM	



Course	No.	Course Name	L-T-P-Credits	Year of In	troductio
BE101-	-06	INTRODUCTION TO CHEMICAL ENGINEERING	2-1-0-3	2	016
Course	Obje	ctives			
1. To	instil	in students the interest, excitement, and u	urge to learn the	e subject of	f Chemic
Enginee	-			N . A	
2. To i	introd	uce the profession of Chemical Engineering	KALA	N	
		uce the purpose of learning important subjects f various professional fields in Chemical Engin		neering for :	meeting th
Syllabu	s	LINUVEDC	TTV		
equation reaction control,	ns of s, DC Intro ring,	to Chemical Engineering, profession, plant of state, Overview of unit operations and proce DA process, basic concepts of P&I diagram. Int duction to safety in chemical process ind Challenges of Chemical Engineer, Introd	esses, Modes of troduction to proc ustries, introduct	heat transfe ess instrume tion to Env	r, chemic entation ar vironment
Expecte		come			
-		ill demonstrate the ability to understand the bas	sic concepts of Ch	emical Engi	neering
Referen				ionnour Engr	
		r and Banchero, Introduction to Chemical Engi	neering McGraw	Hill	
• 1	McCal	be, W. L., Smith, J.C. and Harriott, P., Unit Openwith Hill			ing,
• 1	Pushpa	avanam, S., Introduction to Chemical Engineeri	ng, PHI Learning	Pvt. Ltd.	
• 5	Smith,	R., Chemical Process Design and Integration,	Wiley		
		Course Plan			
Module		Contents C.		Ho	irs Sem Exai Mari
I	role (India	duction to Chemical Engineering: history of Ch of Chemical Engineering– a broad overview; ch ; introduction to Chemical Engineering profess nical plant operation; process development and	nemical industries	in 6	15%
II		e concepts: units and dim <mark>ensions, sy</mark> ste <mark>ms of un</mark> ersion factors of units, concept of mole, weight		rcent.	
	norm	ality, molarity, molality, vapor pressure, partia			15%
	ideal	gas and equations of state.			
		FIRST INTERNAL EX	XAM		
III		view of unit operations such as distillation, eva		on, 8	15%

	adsorption, extraction, crystallization, drying, leaching, size separation and		
	size reduction. Overview of unit processes like saponification,		
	polymerization, biodiesel formation and hydrogenation.		
IV	Modes of heat transfer-principles of conduction, convection and radiation, heat exchangers. Fluid flow- laminar and turbulent flow. Introduction to transportation of fluids. Classification of chemical reactions, order of reaction, rate equation,	8	15%
	Arrhenius equation, conversion and yield, batch reactor, mixed reactor and plug flow reactor.		
	SECOND INTERNAL EXAM		
V	Block diagram, process flow diagram for DCDA process for Sulphuric acid manufacture, basic concepts of P&I diagram. Introduction to process instrumentation and control: common methodologies of measurements, measuring instruments: thermocouple, venturimeter, U-tube manometer, elements of feedback control loop, introduction to control of a distillation column.	7	20%
VI	Introduction to safety in chemical process industries – basic concepts, Case study: Bhopal gas tragedy. Introduction to Environmental Engineering - basic concepts, Typical wastewater, air and solid waste management system.Case study: Effect of Aerial Spraying of Endosulfan on Residents of Kasargod, Kerala. Challenges of Chemical Engineer –need for sustainable alternatives for processes; products with environment friendly life-cycle. Introduction to novel materials and their development.	6	20%
	END SEMESTER EXAM	-	



Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE103	INTRODUCTION TO SUSTAINABLE	2-0-1-3	2016
DEI05	ENGINEERING	2-0-1-5	2010

- To have an increased awareness among students on issues in areas of sustainability
- To understand the role of engineering and technology within sustainable development;
- To know the methods, tools, and incentives for sustainable product-service system development
- To establish a clear understanding of the role and impact of various aspects of engineering and engineering decisions on environmental, societal, and economic problems.

Syllabus

Sustainability- need and concept, challenges, Environment acts and protocols, Global, Regional and Local environmental issues, Natural resources and their pollution, Carbon credits, Zero waste concept ISO 14000, Life Cycle Analysis, Environmental Impact Assessment studies, Sustainable habitat, Green buildings, green materials, Energy, Conventional and renewable sources, Technology and sustainable development, Sustainable urbanization, Industrial Ecology.

Expected outcome

The student will be

- Able to understand the different types of environmental pollution problems and their sustainable solutions
- Able to work in the area of sustainability for research and education
- Having a broader perspective in thinking for sustainable practices by utilizing the engineering knowledge and principles gained from this course

Reference Books:

- Allen, D. T. and Shonnard, D. R., Sustainability Engineering: Concepts, Design and Case Studies, Prentice Hall.
- Bradley. A.S; Adebayo, A.O., Maria, P. Engineering applications in sustainable design and development, Cengage learning
- Environment Impact Assessment Guidelines, Notification of Government of India, 2006
- Mackenthun, K.M., Basic Concepts in Environmental Management, Lewis Publication, London, 1998
- ECBC Code 2007, Bureau of Energy Efficiency, New Delhi Bureau of Energy Efficiency Publications-Rating System, TERI Publications - GRIHA Rating System
- Ni bin Chang, Systems Analysis for Sustainable Engineering: Theory and Applications, McGraw-Hill Professional.
- Twidell, J. W. and Weir, A. D., Renewable Energy Resources, English Language Book Society (ELBS).

	Course Plan			
Module	Contents		Sem. Exam Marks	
I	Sustainability - Introduction, Need and concept of sustainability, Social- environmental and economic sustainability concepts. Sustainable development, Nexus between Technology and Sustainable development, Challenges for Sustainable Development. Multilateral environmental agreements and Protocols - Clean Development Mechanism (CDM), Environmental legislations in India - Water Act, Air Act.	L4	15%	
	 Students may be assigned to do at least one project eg: a) Identifying/assessment of sustainability in your neighbourhood in education, housing, water resources, energy resources, food supplies, land use, environmental protection etc. b) Identify the threats for sustainability in any selected area and explore solutions for the same 	P1		
II	Air Pollution, Effects of Air Pollution; Water pollution- sources, Sustainable wastewater treatment, Solid waste - sources, impacts of solid waste, Zero waste concept, 3 R concept. Global environmental issues- Resource degradation, Climate change, Global warming, Ozone layer depletion, Regional and Local Environmental Issues. Carbon credits and carbon trading, carbon foot print.	L6	15%	
	 Students may be assigned to do at least one project for eg: a) Assessing the pollution status of a small area b) Programmes for enhancing public environmental awareness c) Observe a pond nearby and think about the different measures that can be adopted for its conservation 	Р3		
	FIRST INTERNAL EXAM			
III	Environmental management standards, ISO 14000 series, Life Cycle Analysis (LCA) - Scope and Goal, Bio-mimicking, Environment Impact Assessment (EIA) - Procedures of EIA in India.	L4		
	 Students may be assigned to do at least one project eg: a) Conducting LCA of products (eg. Aluminium cans, PVC bottles, cars etc. or activities (Comparison of land filling and open burning) b) Conducting an EIA study of a small project (eg. Construction of a building) 	Р2	15%	

IV	Basic concepts of sustainable habitat, Green buildings, green materials for building construction, material selection for sustainable design, green	L5	
	building certification, Methods for increasing energy efficiency of buildings. Sustainable cities, Sustainable transport.	23	15%
	Students may be assigned to do at least one project eg: a) Consider the design aspects of a sustainable building for your campus	Р2	1370
	b) Explore the different methods that can be adopted for maintaining a sustainable transport system in your city.	12	
	SECOND INTERNAL EXAM		1
V	Energy sources: Basic concepts-Conventional and non-conventional, solar		
	energy, Fuel cells, Wind energy, Small hydro plants, bio-fuels, Energy derived from oceans, Geothermal energy.	L5	
	Students may be assigned to do at least one project eg:		20%
	a) Find out the energy savings that can be achieved by the installation of a	P2	
	solar water heater		
	b) Conduct a feasibility study for the installation of wind mills in Kerala		
VI	Green Engineering, Sustainable Urbanisation, industrialisation and poverty		
	reduction; Social and technological change, Industrial Processes: Material	L5	
	selection, Pollution Prevention, Industrial Ecology, Industrial symbiosis.		
	Students may be assigned to do a group project eg:		
	a) Collect details for instances of climate change in your locality		
	b) Find out the carbon credits you can gain by using a sustainable transport		20%
	system (travelling in a cycle or car pooling from college to home)	P3	
	c) Have a debate on the topics like: Industrial Ecology is a Boon or Bane for		
	Industries?/Are we scaring the people on Climate Change		
	unnecessarily?/Technology enables Development sustainable or the root		
	cause of unsustainability?		
	END SEMESTER EXAM		

	Course No.	Course Name	L-T-P-Credits	Year of Introduction
	CE100	BASICS OF CIVIL ENGINEERING	2-1-0-3	2016
1	G 011			

- 1. To inculcate the essentials of Civil Engineering field to the students of all branches of Engineering.
- 2. To provide the students an illustration of the significance of the Civil Engineering Profession in satisfying societal needs.

Syllabus

General introduction to Civil Engineering - Introduction to types of buildings, Components of a residential building, Introduction to industrial buildings; Introduction to planning of residential buildings - Simple building plans; Introduction to the various building area terms; Setting out of a building; Surveying – Principles, Objectives, Horizontal measurements with tapes, Ranging; Levelling – Instruments, Reduction of levels; Modern surveying instruments; Building materials – Bricks, cement blocks, Cement, Cement mortar, Steel; Building construction – Foundations, Brick masonry, Roofs, Floors, Decorative finishes, Plastering, Paints and Painting; Basic infrastructure and services – Elevators, Escalators, Ramps, Air conditioning, Sound proofing, Towers, Chimneys, Water Tanks; Intelligent buildings.

Expected outcome

- 1. The students will be able to illustrate the fundamental aspects of Civil Engineering.
- 2. The students will be able to plan and set out a building.
- 3. Students will be able to explain the concepts of surveying for making horizontal and vertical measurements.
- 4. They will able to illustrate the uses of various building materials and explain the method of construction of different components of a building.
- 5. Students will be able to discuss about various services in a building.

References Books:

- Chudley, R., Construction Technology, Vol. I to IV, Longman Group, England
- Chudley, R. and Greeno, R., Building Construction Handbook, Addison Wesley, Longman Group, England
- Gopi, S., Basic Civil Engineering, Pearson Publishers
- Kandya, A. A., Elements of Civil Engineering, Charotar Publishing house
- Mamlouk, M. S., and Zaniewski, J. P., Materials for Civil and Construction Engineering, Pearson Publishers

- McKay, W. B. and McKay, J. K., Building Construction Volumes 1 to 4, Pearson India Education Services
- Minu, S., Basic Civil Engineering, Karunya Publications
- Rangwala, S. C., Essentials of Civil Engineering, Charotar Publishing House
- Rangwala, S. C. and Dalal, K. B., Engineering Materials, Charotar Publishing house
- Rangwala, S. C. and Dalal, K. B., Building Construction, Charotar Publishing house

	Course Plan		~
Module	Contents Contents	Hours	Sem. Exam Marks
Ι	General Introduction to Civil Engineering - Various disciplines of Civil		
	engineering, Relevance of Civil engineering in the overall infrastructural development of the country.	2	
	Introduction to types of buildings as per NBC; Selection of site for buildings.	2	
	Components of a residential building and their functions. Introduction to industrial buildings – office / factory / software development office / power house /electronic equipment service centre (any one related to the branch of study)	2	15%
	Students have to visit one such building and submit an assignment about the features of any one of the listed building related to their branch (Not included for exam).	1	
II	Building planning - Introduction to planning of residential buildings- Site plan, Orientation of a building, Open space requirements, Position of doors and windows, Size of rooms; Preparation of a scaled sketch of the plan of a single storeyed residential building in a given site plan.	4	15%
	Introduction to the various building area terms - Computation of plinth area / built up area, Floor area / carpet area - for a simple single storeyed building; Setting out of a building.	3	
	FIRST INTERNAL EXAM		
III	Surveying - Principles and objectives of surveying;	1	
	Horizontal measurements – instruments used – tape, types of tapes; Ranging (direct ranging only) – instruments used for ranging.	3	
	Levelling - Definitions, principles, Instruments (brief discussion only) - Level field book - Reduction of levels - problems on levelling (height of collimation only).	3	15%
	Modern surveying instruments – Electronic distance meter, digital level, total station, GPS (Brief discussion only).	1	
IV	Building materials - Bricks, cement blocks - Properties and specifications.	2	15%

	Cement – OPC, properties, grades; other types of cement and its uses (in	1	
	brief).	1	
	Cement mortar – constituents, preparation.	1	
	Concrete – PCC and RCC – grades.	1	
	Steel - Use of steel in building construction, types and market forms.	1	
	SECOND INTERNAL EXAM		
V	Building construction – Foundations; Bearing capacity of soil (definition	2	
	only); Functions of foundations, Types - shallow and deep (sketches only).	2	
	Brick masonry – header and stretcher bond, English bonds – Elevation and	2	
	plan (one brick thick walls only).	2	
	Roofs – functions, types, roofing materials (brief discussion only).	1	20%
	Floors – functions, types; flooring materials (brief discussion only).	1	
	Decorative finishes – Plastering – Purpose, procedure.	1	
	Paints and Painting – Purpose, types, preparation of surfaces for painting	2	
	(brief discussion only).	Z	
VI	Basic infrastructure and services - Elevators, escalators, ramps, air	2	
	conditioning, sound proofing (Civil engineering aspects only)	2	20%
	Towers, Chimneys, Water tanks (brief discussion only).	1	2070
	Concept of intelligent buildings.	2	
	END SEME <mark>S</mark> TER EXAM		



Course N	o. Course Name	L-T-P-Credits	Year of Intr	oduction
ME100	BASICS OF MECHANICAL ENGINEERING	2-1-0-3	201	6
Course O	bjectives			
the fundar	the students to the thrust areas in Mechanical nental concepts.	Engineering and their	relevance by c	overing
Syllabus	API ABDUL	. KALA	IV1	
and water devices in	mamics, laws of thermodynamics, implication machines, engines, turbo machines, refrigeran automobiles, latest trends, engineering mate alloys, shape forming methods, machine tools	ion and air condition rials and manufactur	ing, power trai	nsmission
Expected	outcome			
	nt will be able to understand the inter dependen ng and their significance leading to the develop			tems.
Reference	es Books:			
٠	Balachandran, Basic Mechanical Engineering	, Owl Books		
٠	Benjamin, J., Basic Mechanical Engineering,	Pentex Books		
•	Clifford, M., Simmons, K. and Shipway, P. Part I - CRC Press	An Introduction to N	Mechanical En	gineering
٠	Crouse, Automobile Engineering, Tata Mc-G	raw-Hill, New Delhi		
•	Gill, Smith and Zuirys, Fundamentals of IC H Pvt. Ltd. New Delhi. Crouse, Automobile En	gineering, Tata Mc-G	raw-Hill, New	
•	Nag, P. K., Basic and Applied Thermodynam		11	
•	Pravin Kumar, Basic Mechanical Engineering			
٠	Roy and Choudhary, Elements of Mechanica Pvt. Ltd., Mumbai.	l Engineering, Media	Promoters & F	ublishers
•	Sawhney, G. S., Fundamentals of Mechanica	Engineering PHI		
	Course Pla			
Module	Contents 14		Hours	Sem. Exam Marks
I				IVIAI NO
A e	Thermodynamics: Laws of Thermodynamics, applications of thermodynamics, entropy, Ideal quations; Analysis of Carnot cycle, Otto cycle Efficiency of these cycles.	and real gas	7	15%
	Energy conversion devices: Boilers, Steam to Working principle of two stroke and four stroke		; 7	15%

	Engines (SI and CI), Fuels, CRDI,MPFI,Hybrid Engines, Reciprocating pumps, centrifugal pumps and hydraulic turbines.(Elementary ideas only)		
	FIRST INTERNAL EXAM		
III	Refrigeration and Air Conditioning: Vapour compression refrigeration systems, Heat Pump, COP, Study of household refrigerator, Energy		
	Efficiency Rating, Psychrometry, Psychrometric processes, window air	7	15%
	conditioner, split air conditioner.		
	Refrigerants and their impact on environment.		
IV	Automobiles and Power Transmission Devices, Different types of automobiles, types of power units in automobiles; major components and their functions (brief description only); Belts and belt drives; Chain drive; Rope drive; Gears and gear trains; friction clutch (cone and single plate), brakes (types and applications only).	7	15%
	SECOND INTERNAL EXAM		
V	Materials and manufacturing processes: Engineering materials, Classification, properties, Alloys and their Applications; Casting, Sheet metal forming, Sheet metal cutting, Forging, Rolling, Extrusion; Metal joining processes - soldering, brazing and welding; Powder metallurgy.(Elementary ideas only).	7	20%
VI	Machine Tools (Basic elements, Working principle and types of operations), Lathe, Drilling Machine, Shaper, planer, slotter, Milling Machine, Grinding machine; Introduction to CNC machines.	7	20%
	END SEMESTER EXAM		

Question Paper Pattern:

Part A: Modules I and II – three questions of 15 marks each – out of which two questions are to be answered.

Esta.

Part B: Modules III and IV – three questions of 15 marks each – out of which two questions are to be answered.

Part C: Modules V and VI – three questions of 20 marks each – out of which two questions are to be answered.

Each question can have maximum of four subdivisions (a,b,c,d).

Course No.	Course Name	L-T-P Credits	Year of Introduction
EE100	BASICS OF ELECTRICAL ENGINEERING	2-1-0-3	2016
Course O	bjectives		
To impart a	basic knowledge in Electrical Engineering v	with an understa	anding of fundamental concepts.
Syllabus	ALLADOO		LAIVI
Matrix re induction, quantities-	y concepts of electric circuits, Kirchhoff's presentation; Magnetic circuits, energy s Alternating current fundamentals; AC or rectangular, polar; Three phase systems, st smission and distribution; Transformers, Electric	stored in mag circuits, phaso tar and delta co	netic circuits, Electromagnetic r representation of alternating onnection; Generation of power,
Expected			
The course	e will enable the students to gain preliminary	knowledge in	basic concepts of Electrical
Engineerir			
Reference	s Books:		
•	Bhattacharya, S. K., Basic Electrical & Elec	ctronics Engine	ering, Pearson
	Bird, J., Electrical Circuit Theory and Tech	nology, Routle	dge, Taylor & Francis Group
	•Del Toro,V.,Electrical Engineering Fundam	nentals, Prentice	e Hall of India.
	Hayt, W. H., Kemmerly, J. E., and Durbin Tata McGraw Hill	n, S. M., Engi	neering Circuit Analysis,
	Hughes, Electrical and Electronic Technolo	gy, Pearson Ed	ucation
	Mehta, V.K. and Mehta,R., Basic Electrical Parker and Smith, Problems in Electrical Er	0	e
	Sudhakar and Syam Mohan, Circuits ar McGraw Hill	nd Networks A	Analysis and Synthesis, Tata
•	Suresh Kumar, K. S, Electric Circuits and N	Vetworks, Pears	on Education

Course Plan

Module	Contents 2014	Hours	Sem. Exam. Marks
	Elementary concepts of electric circuits: Kirchhoff's laws, constant voltage and current sources-Problems	2	
Ι	Formation of network equations by mesh current and node voltage methods-matrix representation-solution of network equations by matrix methods-problems		15%
	star-delta conversion(resistive networks only-derivation is not needed)-problems	1	

II	Magnetic Circuits:MMF, field strength, flux density, reluctance(definition only)-comparison between electric and magnetic circuitsEnergy stored in magnetic circuits, magnetic circuits with air gap-Numerical problems on series magnetic circuits	2	15%
	Electromagnetic Induction: Faraday's laws, lenz's laws- statically induced and dynamically induced emfs-self inductance and mutual inductance, coefficient of coupling (derivation not needed)	2	
	FIRST INTERNAL EXAMINATION	AL	
	Alternating Current fundamentals: Generation of alternating voltages-waveforms, frequency, period, average, RMS values and form factor of periodic waveform(pure sinusoidal)- Numerical Problems	2	
	AC Circuits: Phasor representation of alternating quantities- rectangular and polar representation	1	15%
III	Analysis of simple AC circuits: concept of impedance, power and power factor in ac circuits-active, reactive and apparent power	2	
	solution of RL,RC and RLC series circuits-Numerical problems	2	
	Three phase systems: Generation of three phase voltages- advantages of three phase systems, star and delta connection (balanced only), relation between line and phase voltages, line and phase currents	3	
	three phase power measurement by two wattmeter method (derivation is not required) - Numerical problems	1	
	Generation of power: Block schematic representation of generating stations- hydroelectric power plants	1	
IV	Block schematic representation of Thermal and nuclear power plants	1	
	Renewable energy sources: solar, wind, tidal and geothermal (Block diagram and working only- No Problems)	1	15%
	Power transmission: Typical electrical power transmission scheme-need for high voltage transmission-(Derivation is not needed, No Problems)	1	
	Power Distribution: substation equipments, primary and secondary transmission and distribution systems- feeder, service	1	

	mains		
	SECOND INTERNAL EXAMINATION	1 1	
V	Electric Machines: DC Generator and Motor-Construction- working principle- Back EMF	2	
	Types of motor-shunt, series, compound (short and long)- principle of operation of dc motor, applications-numerical problems (voltage -current relations only)	A ₃ M	200/
	Transformer: Construction of single phase and three phase Transformers (core type only)-EMF equation and related numerical problems		20%
	Losses and efficiency of transformer for full load –numerical problems (no equivalent circuit)	2	
	AC Motors: Three phase induction motor-squirrel cage and slip ring induction motor	1	
VI	Working principle-synchronous speed, slip and related numerical problems. (no equivalent circuit)	1	200/
VI	AC Motors: Construction, principles of operation of single phase induction motor (no equivalent circuit)	1	20%
	Starting methods in single phase induction motors -split phase and capacitor start	2	



Course	Course Name	L-T-P	Year of Introduction
No:		Credits	
EC100	BASICS OF ELECTRONICS ENGINEERING	2-1-0-3	2016
Course C	bjectives		
1) To	get basic idea about types, specification and components.	imon values	of passive and acti

- 2) To familiarize the working of diodes, transistors, MOSFETS and integrated circuits.
- 3) To understand the working of rectifiers, amplifiers and oscillators.
- 4) To get a basic idea about measuring instruments
- 5) To get a fundamental idea of basic communication systems and entertainment electronics

Syllabus

Evolution and Impact of Electronics in industries and in society, Familiarization of Resistors, Capacitors, Inductors, Transformers and Electro mechanical components, PN Junction diode: Structure, Principle of operation, Zener diode, Photo diode, LED, Solar cell, Bipolar Junction Transistors: Structure, Principle of operation, characteristics, Rectifiers and power supplies: Half wave and full wave rectifier, capacitor filter, zener voltage regulator, Amplifiers and Oscillators: common emitter amplifier, feedback, oscillators, RC phase shift oscillator, Analogue Integrated circuits: operational amplifier, inverting and non-inverting amplifier, Electronic Instrumentation: digital multimeter, digital storage oscilloscope, function generator, Radio communication: principle of AM & FM, Super heterodyne receiver, Satellite communication: geo-stationary satellite system, Mobile communication: cellular communications, Optical communication: system, principle of light transmission through fiber, Entertainment Electronics: Cable TV, CCTV system.

Expected Outcome

Student can identify the active and passive electronic components. Student can setup simple circuits using diodes and transistors. Student will get fundamental idea about basic communication systems and entertainment electronics.

Text Books:

- Bell, D. A., Electronic Devices and Circuits, Oxford University Press
- Tomasy, W., Advanced Electronic Communication system, PHI Publishers

References Books:

- Boylested, R. L. and Nashelsky, L., Electronic Devices and Circuit Theory, Pearson Education
- Frenzel, L. E., Principles of Electronic Communication Systems, Mc Graw Hill
- Kennedy, G. and Davis, B., Electronic Communication Systems, Mc Graw Hill

	Course Plan			
Aodule	Contents	Hours	Sem. Marks	
	Evolution of Electronics, Impact of Electronics in	1		
	industry and in society.	ATAK		
	Resistors, Capacitors: types, specifications.	ALAN	Α.	
Ι	Standard values, marking, colour coding.		10%	
	Inductors and Transformers: types, specifications,		har	
	Principle of working.	l Y		
	Electro mechanical components: relays and contactors.	1		
	PN Junction diode: Intrinsic and extrinsic			
	semiconductors, Principle of operation, V-I characteristics, principle of working of Zener	4		
	diode, Photo diode, LED and Solar cell.			
Π	Director Innetion Transisters: DND and NDN		20%	
	Bipolar Junction Transistors: PNP and NPN			
	structures, Principle of operation, input and output characteristics of common emitter configuration	3		
	(npn only).			
	(nph omy).			
	FIRST INTERNAL EXAM	М		
	Rectifiers and power supplies: Block diagram			
	description of a dc power supply ,Half wave and full wave (including bridge) rectifier, capacitor	4		
	filter, working of simple zener voltage regulator.			
III			15%	
	Amplifiers and Oscillators: Circuit diagram and working of common emitter amplifier, Block			
	diagram of Public Address system, concepts of	4		
	feedback, working principles of oscillators, circuit			
	diagram & working of RC phase shift oscillator.	-		
	Analogue Integrated circuits: Functional block			
	diagram of operational amplifier, ideal	3		
	operational amplifier, inverting and non-inverting			
IV	Amplifier.		15%	
	Digital ICs: Logic Gates.	1		
	Electronic Instrumentation: Principle and block diagram of digital multimeter, digital storage	2		

	oscilloscope, and function generator.	
	SECOND INTERNAL EXAM	
V	Radio communication: principle of AM & FM, frequency bands used for various communication systems, block diagram of super heterodyne receiver.3Satellite communication: concept of geo- stationary Satellite system.2	20%
VI	Mobile communication: basic principles of cellular communications, concepts of cells, frequency reuse.2Optical communication: block diagram of the optical communication system, principle of light transmission through fiber, advantages of optical communication systems.2Entertainment Electronics Technology: Basic principles and block diagram of cable TV, CCTV, DTH system.2	20%
	END SEMESTER EXAM	

Note: Analysis is not required in this course.

Course No.	Course Name	L-T-P-	Year of
		Credits	Introduction
MA102	DIFFERENTIAL EQUATIONS	3-1-0-4	2016

This course introduces basic ideas of differential equations, both ordinary and partial, which are widely used in the modelling and analysis of a wide range of physical phenomena and has got applications across all branches of engineering. The course also introduces Fourier series which is used by engineers to represent and analyse periodic functions in terms of their frequency components.

Syllabus

Homogeneous linear ordinary differential equation, non-homogeneous linear ordinary differential equations, Fourier series, partial differential equation, one dimensional wave equation, one dimensional heat equation.

Expected Outcome

At the end of the course students will have acquired basic knowledge of differential equations and methods of solving them and their use in analysing typical mechanical or electrical systems. The included set of assignments will familiarise the students with the use of software packages for analysing systems modelled by differential equations.

TEXT BOOKS

- Erwin Kreyszig: Advanced Engineering Mathematics, 10th ed. Wiley
- A C Srivastava, P K Srivasthava, Engineering Mathematics Vol 2. PHI Learning Private Limited, New Delhi.

REFERENCES:

• Simmons: Differential Equation with Applications and its historical Notes,2e McGrawHill Education India 2002

Estd.

- Datta, Mathematical Methods for Science and Engineering. CengageLearing, 1st. ed
- B. S. Grewal. Higher Engineering Mathematics, Khanna Publishers, New Delhi.
- N. P. Bali, Manish Goyal. Engineering Mathematics, Lakshmy Publications
- D. W. Jordan, P Smith. Mathematical Techniques, Oxford University Press, 4th Edition.
- C. Henry Edwards, David. E. Penney. Differential Equations and Boundary Value Problems. Computing and Modelling, 3rd ed. Pearson

	COURSE PLAN		
	COURSE NO: MA102	L-T-P:3-1-	-0
	COURSE NAME:	CREDITS	
	DIFFERENTIAL		
	EOUATIONS		
MODULE	CONTENT	HRS	END SEM. EXAM MARKS (OUT OF 100)
	<u>aplabiju ka</u>	AN	(**************************************
	HOMOGENEOUS DIFFERENTIAL EQUATIONS	CAI	
	(Text Book 1 : Sections 1.7, 2.1, 2.2, 2.6, 3.2)	A	
	Existence and uniqueness of solutions for initial	7	
	value problems, Homogenous linear ODEs of second	3	
	order. Homogenous linear ODEs with constant coefficients, Existence and Uniqueness of solutions		
I	Wronskian,		
	Homogenous linear ODEs with constant	4	17
	Coefficients (Higher Order)		
	(For practice and submission as assignment only:		
	Modelling of free oscillations of a mass –		
	spring system)		
	NON-HOMOGENEOUS LINEAR ORDINARY		
	DIFFERENTIAL EQUATIONS		
	(Text Book 2: Sections 1.2.7 to 1.2.14)		
	The particular Integral (P.I.), Working rule for P.I.		
	when $g(x)$ is X^m , To find P.I. when $g(x) = e^{ax} V_1(x)$,	1	
	Working rule for P.I. when $g(x) = x.V(x)$,		
TT	Homogeneous Linear Equations, PI of Homogenous	7	17
II	equations	7	
	Legendde's Linead eduations	2	
	Method of variation of parameters for finding PIs	2	
	(For practice and submission as assignments only:	3	
	Modelling forced oscillations, resonance,		
	electric circuits)	17	
	FIRST INTERNAL EXAM	/	I
	FOURIER SERVICE	·	
	FOURIER SERIES		
	(Text Book 2 - Sections 4.1,4.2,4.3,4.4) Periodic functions ,Orthogonally of Sine and Cosine		
	functions (Statement only), Fourier series and	3	
	Euler's formulas		17
III	Fourier cosine series and Fourier sine series	3	
	(Fourier series of even and Odd functions)		
	Half range expansions (All results without proof)	3	

	(For practice and submission as assignment only: Plots of partial sums of Fourier series and demonstrations of convergence using plotting software)		
IV	PARTIAL DIFFERENTIAL EQUATIONS (Text Book 2 : Sections : 5.1, 5.1.1, 5.1.2, 5.1.5, 5.2.6-5.2.10) Introduction to partial differential equations , formation of PDE, Solutions of first order PDE(Linear only) Lagrange's Method	ILAN IC ³ A Y ₃	17 17
	Linear PDE with constant coefficients , Solutions of Linear Homogenous PDE with constant coefficients , Shorter method for finding PI when $g(x,y)=f(ax+by)$, Method of finding PI when $g(x,y) = x^m y^n$, method of find PI when $g(x,y)=e^{ax+by} V(x,y)$	6	
	SECOND INTERNAL EXAM		
V	ONE DIMENSIONAL WAVE EQUATION (Text Book 2: Sections :6.1 6.4) Method of separation of variables The wave Equation Vibrations of a stretched string Solutions of one dimensional wave equation using method of separation of variables and problems	2 1 1 4	16
VI	ONE DIMENSIONAL HEAT EQUATION (Text Book 2: sections 6.7, 6.8, 6.9, 6.9.1, 6.9.2) The equation of Heat conduction One dimensional Heat transfer equation. Solutions of One Dimensional Heat transfer equation, A long insulated rod with ends at zero temperatures, A long insulated rod with ends at non zero temperatures	1 1 6	16
	END SEMESTER EXAM	1	

TUTORIALS: Tutorials can be ideally conducted by dividing each class into three groups. Prepare necessary materials from each module that can be practiced using computer software. Use them uniformly in every class.

Course No.	Course Name	L-T-P-Credits	Year of Introduction
BE102	DESIGN AND ENGINEERING	2-0-2-3	2016

The purpose of this course is:-

- 1. To excite the student on creative design and its significance;
- 2. To make the student aware of the processes involved in design;
- 3. To make the student understand the interesting interaction of various segments of humanities, sciences and engineering in the evolution of a design;
- 4. To get an exposure as to how to engineer a design.

Syllabus

Design and its objectives; Role of science, engineering and technology in design; Engineering as a business proposition; Creative design and the Design Process; Design evaluation and communication of designs; Design for function and strength; Material selection and design detailing; Role of standards in design Engineering the design; Design for "X"; Product centered and user centered design; Aesthetics and ergonomics; Concepts of value engineering, concurrent engineering and reverse engineering in design; Culture based design; Modular design; Design optimization needs; User interface; Intelligent and autonomous products; Internet of things; Advanced products and human psychology; Life cycle design; Product and its environment; Design as a marketing tool; Products and IPR; Product liability.

Expected outcome

The student will be:-

- Able to appreciate the different elements involved in good designs and to apply them in practice when called for.
- Aware of the product oriented and user oriented aspects that make the design a success.
- Will be capable to think of innovative designs incorporating different segments of knowledge gained in the course;
- Students will have a broader perspective of design covering function, cost, environmental sensitivity, safety and other factors other than engineering analysis.

References Books:

- Balmer, R. T., Keat, W. D., Wise, G., and Kosky, P., Exploring Engineering, Third Edition: An Introduction to Engineering and Design [Part 3 Chapters 17 to 27], ISBN-13: 978-0124158917 ISBN-10: 0124158919
- Dym, C. L., Little, P. and Orwin, E. J., Engineering Design A Project based introduction Wiley, ISBN-978-1-118-32458-5
- Eastman, C. M. (Ed.), Design for X Concurrent engineering imperatives, 1996, XI, 489 p. ISBN 978-94-011-3985-4 Springer
- Haik, Y. And Shahin, M. T., Engineering Design Process, Cengage Learning, ISBN-13: 978-0-495-66816-9
- Pahl, G., Beitz, W., Feldhusen, J. and Grote, K. H., Engineering Design: A Systematic Approach, 3rd ed. 2007, XXI, 617p., ISBN 978-1-84628-319-2
 - Dieter and Schmidt, Engineering Design, McGraw Hill Education(India) Edition 2013

• Voland, G., Engineering by Design, ISBN 978-93-325-3505-3, Pearson India

Web pages:

- 1. E-Book (Free download): http://opim.wharton.upenn.edu/~ulrich/designbook.html
- 2. http://www2.warwick.ac.uk/fac/sci/wmg/ftmsc/modules/modulelist/peuss/designforx/design_for_x_notes_s ection_5.pdf

	Course Plan				
Module	Contents	Hours	Sem. Exam Marks		
Ι	Design and its objectives; Design constraints, Design functions, Design means and Design from; Role of Science, Engineering and Technology in design; Engineering as a business proposition; Functional and	AL L2			
	Strength Designs. Design form, function and strength; How to initiate creative designs? Initiating the thinking process for designing a product of daily use. Need identification; Problem Statement; Market survey- customer requirements; Design attributes and objectives; Ideation; Brain storming approaches; arriving at solutions; Closing on to the Design needs.	L3	15%		
	An Exercise in the process of design initiation. A simple problem is to be taken up to examine different solutions- Ceiling fan? Group Presentation and discussion.	P4			
Π	Design process- Different stages in design and their significance; Defining the design space; Analogies and "thinking outside of the box"; Quality function deployment-meeting what the customer wants; Evaluation and choosing of a design. Design Communication; Realization of the concept into a configuration, drawing and model. Concept of "Complex is Simple". Design for function and strength. Design detailing- Material selection, Design visualisation- Solid modelling; Detailed 2D drawings; Tolerancing; Use of standard items in design; Research needs in design; Energy needs of the design, both in its realization and in the applications. An exercise in the detailed design of two products	L2 L3 P4	15%		
	(Stapler/ door/clock) FIRST INTERNAL EXAM				
III	Prototyping- rapid prototyping; testing and evaluation of design; Design modifications; Freezing the design; Cost analysis.	L2	15%		
	Engineering the design – From prototype to product Planning; Scheduling; Supply chains; inventory; handling;	L3			

	manufacturing/construction operations; storage; packaging; shipping; marketing; feed-back on design.		
	List out the standards organizations. Prepare a list of standard items used in any engineering specialization. Develop any design with over 50% standard items as	P4	
IV	 parts. Design for "X"; covering quality, reliability, safety, manufacturing/construction, assembly, maintenance, logistics, handling; disassembly; recycling; re-engineering etc. 	L4	1.50/
	List out the design requirements(x) for designing a rocketshell of 3 meter diameter and 8 meter length.Design mineral water bottles that couldcompactly for transportation.	P4	15%
	SECOND INTERNAL EXAM		
V	 Product centred and user centred design. Product centred attributes and user centred attributes. Bringing the two closer. Example: Smart phone. Aesthetics and ergonomics. Value engineering, Concurrent engineering, Reverse engineering in design; Culture based design; Architectural designs; Motifs and cultural background; Tradition and design; Study the evolution of Wet grinders; Printed motifs; Role of colours in design. 	L2 L4	20%
	Make sharp corners and change them to smooth curves- check the acceptance. Examine the possibility of value addition for an existing product.	P6	
VI	Modular design; Design optimization; Intelligent and autonomous products; User interfaces; communication between products; autonomous products; internet of things; human psychology and the advanced products. Design as a marketing tool; Intellectual Property rights – Trade secret; patent; copy-right; trademarks; product liability.	L3	20%
	Group presentation of any such products covering all aspects that could make or mar it.	Р6	
	END SEMESTER EXAM		

Evaluation Scheme:

First internal exam - closed book exam - 25 marks

Second internal exam – open book exam – 25 marks

Assignment/projects -50 marks (iv) End semester exam - open book exam -50 marks (2 hours duration - conducted by the University)

First Test: Marks: 25 Closed Book;

Questions may cover:-

Topics covered in the lectures.

How to arrive at the design details for a specific need gap given.

Sketching the design of a product that is to meet the given user requirements.

Second Test: Marks: 25 Open Book:

Students are permitted to bring in class notes, own notes, text books and other books (Maximum 3/4 books) for the test. Access to internet and mobile phones is NOT permitted.

Assignments: Marks: 20 Two assignments are to be given (10 marks each). These assignments are to cover specific design/s, sketching of the design, and a short but well written write-up on the design.

Projects: Marks: 30 Two mini projects are to be assigned. One is to be a group project and the other an individual one. A group of 3 or 4 students can take up the group project. Each project is to be evaluated for 15 marks.

The Group Project is to be done in the practical hours given for the course. Projects including the group projects are to be evaluated based on individual presentations and answers to the questions raised. These presentations could be done during the practical hours.

Question Paper Pattern for End Semester Examination (Open Book)

Part A – Eight questions of each 5 marks, out of which six questions are to be answered.

Part B – Three questions of each 10 marks, out of which two questions are to be answered.



Course No.	Course Name	L-T-P- Credits	Year of Introduction
PH110	ENGINEERING PHYSICS LAB	0-0-2-1	2016
Course Obj	ectives	I	
This course	is designed (i) to impart practical knowledge	about some of the	phenomena they
have studied	in the Engineering Physics course and (ii) to	develop the expe	rimental skills of the
students.	TECLINIOIC	NOIC !	λĭ
	List of Exercises / Experiments (Minin	mum of 8 manda	tory)
Basics	LINIVERS	SITY	
1. Study o	f application of Cathode Ray Oscilloscope (C	CRO) for Frequen	cy and Amplitude
measure	ements. Lissajeous figures (useful for different	types of polarized	light.)
2. Temper	ature measurement – Thermocouple		
3. Measur	ement of strain using strain gauge and Wheat	stones bridge.	
Waves, Osc	illations and Ultrasonics		
	length and velocity measurement of ultra	asonic waves in	a liquid using
5. The LC	R Circuit – Forced and damped harmonic oso	cillations.	
	string apparatus. Measurement of free dinal mode.	uency in the	transverse and
Interference			
7. Wave 1 Rings n	ength measurement of a monochromatic s	ource of light u	sing Newton's
8. Determ	ination of refractive index of a liquid using N	ewton's Rings ap	paratus.
9. Determ	ination of diameter of a thin wire or thick	ness of a thin str	rip of paper using air
	method. 2014		· · · · · · · · · · · · · · · · · · ·
Diffraction	2014		
10. To dete	rmine the slit or pinhole width.		
11. To mea	sure wavelength using a millimeter scale as a	grating.	
12. Determ	ination the wavelength of He-Ne laser or any	standard laser usi	ing diffraction grating.
13. To dete	rmine the wavelength of monochromatic ligh	t using grating.	
14. Determ	ination of dispersive power and resolving pov	ver of a plane tra	smission grating.

Polarisation

- 15. Kerr Effect To demonstrate the Kerr effect in nitrobenzene solution and to measure the light intensity as a function of voltage across the Kerr cell using photo detector.
- 16. To measure the light intensity of plane polarised light as a function of the analyzer position.
- 17. Laurent's Half Shade Polarimeter -To observe the rotation of the plane of polarization of monochromatic light by sugar solution and hence to determine the concentration of solution of optically active substance.

Laser & Photonics

- 18. To determine the speed of light in air using laser.
- 19. Calculate the numerical aperture and study the losses that occur in optical fiber cable.
- 20. Determination of the particle size of lycopodium powder.
- 21. I-V characteristics of solar cell
- 22. To measure Planck's constant using photo electric cell.
- 23. Measurement of wavelength of laser using grating.

Reference Books:

- Avadhanulu, M. N., Dani, A. A. and Pokley, P. M., Experiments in Engineering Physics, S. Chand & Co.
- Gupta, S. K., Engineering Physics Practicals, Krishna Prakashan Pvt. Ltd.
- Koser, A. A., Practical Engineering Physics, Nakoda Publishers and Printers India Ltd
- Rao, B. S. and Krishna, K. V., Engineering Physics Practicals, Laxmi Publications
- Sasikumar, P. R. Practical Physics, PHI.

Website:

• http://www.indosawedu.com

Course No.	Course Name	L-T-P- Credits	Year of Introduction			
CY 110	CY 110ENGINEERING CHEMISTRY LAB0-0-2-12					
	List of Exercises / Experiments (Mini	mum of 8 manda	atory)			
1. Estimati	ion of Total Hardness – EDTA method.	KALA	M			
2. Estimati	ion of Iron in Iron ore.	NOIC	λĭ			
3. Estimati	ion of Copper in Brass.		AL			
4. Estimati	ion of dissolved oxygen by Winklers method	SITY.				
5. Estimati	ion of chloride in water.					
6. Preparat	tion of Urea formaldehyde and Phenol-forma	aldehyde resin.				
7. Determi	nation of Flash point and Fire point of oil by	Pensky Martin A	Apparatus.			
8. Determi in soluti	nation of wavelength of absorption maximu on.	am and colorimet	rric estimation of Fe ³⁺			
9. Determi	nation of molar absorptivity of a compound	other than Fe^{3+} .				
	s of IR spectra of any three organic <mark>co</mark> mpour					
11. Analysis	s of ¹ H NMR spectra of any three organic co	ompounds.				
12. Calibrat	ion of pH meter and determination of pH of	a solution.				
13. Verifica	tion of Nernst equation for electrochemical	cell.				
14. Potentio	metric titrations: acid – base and redox titrat	tions				
15. Conduct	tivity measurements of salt solutions.					
16. Flame p	hotometric estimation of Na+ to find out the	salinity in sand.				
Expected outcome						
The student will be able to apply and demonstrate the theoretical concepts of Engineering Chemistry.						
References: • Practica	al Engineering Chemistry Lab Manual, Owl boo	k publishers				

Course No.	Course Name	L-T-P- Credits	Year of Introduction
CE110	CIVIL ENGINEERING WORKSHOP	0-0-2-1	2016
	List of Exercises / Experiments (Mini	mum of 8 manda	ntory)
	(For Civil Engineering I	Branch)	M
	of a building: The student should set out a bung plan using tape only.	ilding (single roo	m only) as per the
	f a building: The student should set out a buing plan using tape and cross staff.	lding (single roor	n only) as per the
	wall of height 50 cm and wall thickness $1\frac{1}{2}$ b orner portion – length of side walls 60 cm.	ricks using Engli	sh bond (No mortar
	wall of height 50 cm and wall thickness 2 brid orner portion – length of side walls 60 cm.	cks using English	bond (No mortar
window size in windows of	area and/or volume of various features of a l , number of bricks required to construct a wa etc. – To create an awareness of measuremen struments like vernier caliper, screw gauge e	ll of a building, d ts and units (use	liameter of bars used
construction	uilding materials: The student should do the c materials and compare the strength (brick, he e, stone block, and so on).	-	
Computation measuremen	of Centre of gravity and Moment of inertia of the state o	of a given rolled	steel section by actual
Introduction	to simple plumbing and sanitary fittings.		
Home assignment 1: Preparation of a building model - The students in batches should prepare and submit a building model for a given plinth area in a given site plan constrained by a boundary wall. The minimum requirements of a residential building viz., drawing cum dining room, one bed room and a kitchen should be included. The concept of an energy efficient building should also be included in the model.			
Home assignment 2: Report preparation -The student should collect the construction details of any one unique Civil Engineering structure, prepare and submit a detailed report with neat illustrations.			
Home assignment 3: Report preparation - The students should collect samples of building materials, prepare and submit a detailed report including their market rates.			
(For braches other than Civil Engineering)			
Setting out of a building: The student should set out a building (single room only) as per the given building plan using tape only.			
Setting out of a building: The student should set out a building (single room only) as per the			
59			

given building plan using tape and cross staff.

Building area computation: The student should prepare a rough sketch of a given single storeyed building and by taking linear measurements compute plinth area and carpet area of the given building.

Construct a wall of at least a height of 500mm and wall thickness 1brick using English bond (No mortar required) - corner portion – length of side walls at least 600mm.

Compute the area and/or volume of various features of a building/structure such as door and window size, number of bricks required to construct a wall of a building, diameter of bars used in windows etc. – To create an awareness of measurements and units (use tape or other simple measuring instruments like vernier calipers, screw gauge etc.).

Horizontal measurements: Find the area of an irregular polygon set out on the field. Vertical measurements: Find the level difference between any two points.

Computation of Centre of gravity and Moment of inertia of a given rolled steel section by sketching and measurements.

Home assignment 1: Preparation of a building model - The students in batches should prepare and submit a building model for a given plinth area in a given site plan constrained by a boundary wall. The minimum requirements of a residential building viz., drawing cum dining room, one bed room and a kitchen should be included. The concept of an energy efficient building should also be included in the model.

Home assignment 2: Report preparation - The student should collect the construction details of an industrial building related to their branch of study, prepare and submit a detailed report with neat illustrations.

Home assignment 3: Report preparation - The students should collect samples of building materials, prepare and submit a detailed report about their market rates.

Course	Course Name	L-T-P-	Year of
No.		Credits	Introduction
	MECHANICAL ENGINEERING WORKSHOP	0-0-2-1	2016
Course Objec	tives		
	manufacturing processes and applications. Familiari ces, practices and machines used in various worksho		ous tools,
	List of Exercises / Experiments (Minimum of 8	mandatory)	
Sl. Name of Shop floor	No. Exercises	CAL	No of sessions
1 General	Studies of mechanical tools, components and t (a) Tools: screw drivers, spanners, Allen keys And accessories	V	s etc.
	(b) Components: Bearings, seals, O-rings, circ	lips, keys etc.	1
2 Carpentry	Any one model from the following: 1. T-Lap joint 2. Cross lap joint 3. Dovetail joi	nt 4. Mortise	joint ²
3 Smithy	 (a) Demonstrating the forgability of different and Cast steel) in cold and hot state (b) Observing the qualitative differences in the materials (c) Determining the shape and dimensional vaspecimen due to forging under different inspection and measurements 	es. e hardness of t ariations of A	these 2 1 test
4 Foundry	Any one exercise from the following 1. Bench moulding 2. Floor moulding 3. Core	making	2
5 Sheet me	Any one exercise from the following Making 1. Cylindrical 2. Conical 3. Prismatic sheet metal	shaped jobs fr	om 2
6 Welding	Any one exercise from the following Making joints using Electric arc welding. Bea horizontal, vertical and overhead positions	d formation ir	1 2
7 Fitting Assembly	Filing exercise and any one of the following examples and reassembling of 1. Cylinde 2. Tail stock assembly 3. Time piece/clock 4. I machine.	r piston assem	
8 Machine	s Demonstration and applications of Drilling ma machine, Shaping machine, Milling machine a		ng 2

C	ourse	Course Name	L-T-P-	Year of
	No.		Credits	Introduction
EE110 ELECTRICAL ENGINEERING 0-0-2-1 2 WORKSHOP		2016		
Cou	arse Obje	ectives		
The	objectiv	e of this course is to familiarize the stude	ents with commo	only used components,
		nd measuring equipment in Electrical instal	lations. The cour	rse also provides hands
one	experienc	e in setting up of simple wiring circuits.	CIC	λΙ
		List of Exercises / Experiments (Minin	mum of 8 manda	atory)
1.	Identify	different types of cables/wires and switches	and their uses.	
2.	Identify usage.	different types of fuses & fuse carriers, MCI	B and ELCB, MC	CCB with ratings and
3.	-	of simple light circuit for controlling light/far	point (PVC con	duit wiring).
4.	-	of light/fan circuit using Two way switches (-	
5.		of fluorescent lamps and light sockets (6 A)		
6.	-	of Power circuit for controlling power device	(16A socket)	
7.	-	wiring / Tunnel wiring		
8.		of power distribution arrangement using sing Main switch and Energy meter.	le phase MCB di	stribution board with
9.		ment of voltage, current and power in single meter. Calculate the power factor of the circu	· •	ng voltmeter, ammeter
10.	Wiring c installati	of backup power supply including inverter, ba	attery and load fo	or domestic
11.	Demons	tration and measurement of power consumpt	ion of electric irc	on, mixer grinder,
	single pl	nase pump, exhaust fan, etc.		
12.	12. Energy meter reading and tariff calculation			
Exp	Expected outcome			
1. Familiarity with supply arrangements and their limitations, knowledge of standard voltages and their tolerances, safety aspects of electrical systems and importance of protective measures in wiring systems.				
2.	2. Knowledge about the types of wires, cables and other accessories used in wiring. Creating awareness of energy conservation in electrical systems.			
3.	. Students should be able to wire simple lighting circuits for domestic buildings, distinguish between light and power circuits.			
4.	To measure electrical circuit parameters and current, voltage and power in a circuit.			
5.	Familiar	ity with backup power supply in domestic in	stallation.	

Course	Course Name	L-T-P-	Year of
No.		Credits	Introduction
EC110	ELECTRONICS ENGINEERING WORKSHOP	0-0-2-1	2016

This course gives the basic introduction of electronic hardware systems and provides hands-on training with familiarization, identification, testing, assembling, dismantling, fabrication and repairing such systems by making use of the various tools and instruments available in the Electronics Workshop.

List of Exercises / Experiments (Minimum of 8 mandatory)

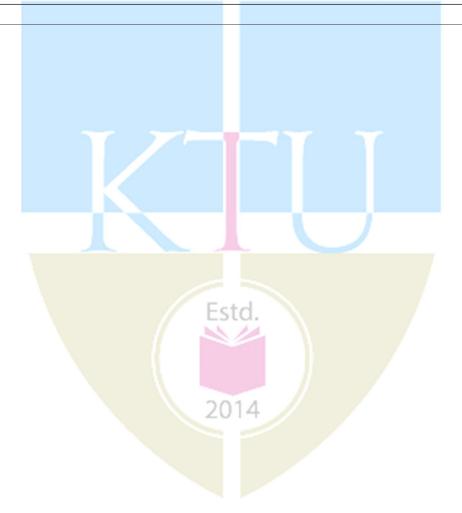
- 1. Familiarization/Identification of electronic components with specification (Functionality, type, size, colour coding, package, symbol, cost etc. [Active, Passive, Electrical, Electronic, Electro-mechanical, Wires, Cables, Connectors, Fuses, Switches, Relays, Crystals, Displays, Fasteners, Heat sink etc.)
- 2. Drawing of electronic circuit diagrams using BIS/IEEE symbols and introduction to EDA tools, Interpret data sheets of discrete components and IC's, Estimation and costing.
- 3. Familiarization/Application of testing instruments and commonly used tools. [Multimeter, Function generator, Power supply, CRO etc.] [Soldering iron, De-soldering pump, Pliers, Cutters, Wire strippers, Screw drivers, Tweezers, Crimping tool, Hot air soldering and de-soldering station etc.]
- 4. Testing of electronic components [Resistor, Capacitor, Diode, Transistor, UJT and JFET using multimeter.]
- 5. Inter-connection methods and soldering practice. [Bread board, Wrapping, Crimping, Soldering types selection of materials and safety precautions, soldering practice in connectors and general purpose PCB, Crimping.]
- 6. Printed circuit boards (PCB) [Types, Single sided, Double sided, PTH, Processing methods, Design and fabrication of a single sided PCB for a simple circuit with manual etching (Ferric chloride) and drilling.]
- 7. Assembling of electronic circuit/system on general purpose PCB, test and show the functioning(Any Four circuits)
 - 1. Fixed voltage power supply with transformer, rectifier diode, capacitor filter, zener/IC regulator.
 - 2. LED blinking circuit using a stable multi-vibrator with transistor BC 107.
 - 3. Square wave generation using IC 555 timer in IC base.
 - 4. Sine wave generation using IC 741 OP-AMP in IC base.
 - 5. RC coupled amplifier with transistor BC 107.
 - 6. AND and NAND gates in diode transistor logic.

8.Familiarization of electronic systems (Any three systems)

- 1. Setting up of a PA system with different microphones, loud speakers, mixer etc.
- 2. Assembling and dismantling of desktop computer/laptop/mobile phones.
- 3. Coil/Transformer winding.
- 4. Identify the subsystems of TV, DTH, CCTV, Cable TV, CRO, Function generator etc.
- 5. Screen printing and PCB pattern transfer
- 6. Soldering & de-soldering of SMD using hot air soldering station.
- 7. Introduction to robotics- Familiarization of components (motor, sensors, battery etc.) used in robotics and assembling of simple robotic configurations.

Expected outcome

Student can identify the active and passive electronic components. Student gets hands-on assembling, testing, assembling, dismantling, fabrication and repairing systems by making use of the various tools and instruments available in the Electronics Workshop.



Course No.	Course Name	L-T-P- Credits	Year of Introduction	
CS110	COMPUTER SCIENCE WORKSHOP	0-0-2-1	2016	
Course Objectives				

- 1. To familiarize students with basic hardware and software tools
- 2. To implement algorithms studied in the course Introduction to Computing & Problem Solving.
- 3. To learn the implementation of control structures, Iterations and recursive functions, Lists, Tuples and Dictionaries.
- 4. To implement operations of files.
- 5. To implement a small micro project using Python

List of Exercises / Experiments (Minimum of 8 mandatory)

List of Exercises:

Introduction: Familiarization of hardware components of a desktop computer (motherboard, cards, memory, slots, power, cables etc.) Familiarization of Operating systems and various tools, particularly those for scientific computing, open source tools etc.

Programming exercises in Python based on the course Introduction To Computing and Problem Solving (BE 101-05). The exercises may include programs using the following concepts–

1. Decision making, branching and looping

- 1. Variables , Expressions & Conditional statements
- 2. Iteration statements (While, For etc.)

2. Function & Function calls

- 1. Function calls, Math functions
- 2. Parameters and arguments
- 3. Adding new functions, Recursion

3. Strings

- 1. String traversal
- 2. String searching, Comparison
- 3. Other important String methods

4. Lists, Tuples and Dictionaries

1. Traversing List, List Operations

- 2. Creation of Dictionary and Operations
- 3. Lists and Tuples

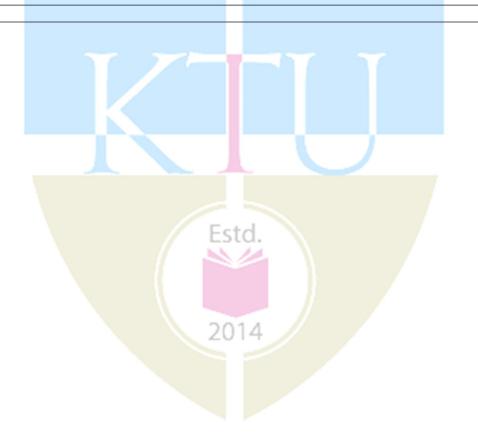
5. Files and Operations

- 1. Files defining, opening/closing, operations
- 2. Pickling

6. **Micro Project**: Students are expected to do a micro project by using Python, preferably related to the Web

Expected outcome

- 1. Students are able to identify common hardware components and their purpose
- 2. Students gain sufficient awareness about latest software tools.
- 3. Students are able to develop programs in Python for common problems of reasonable complexity.



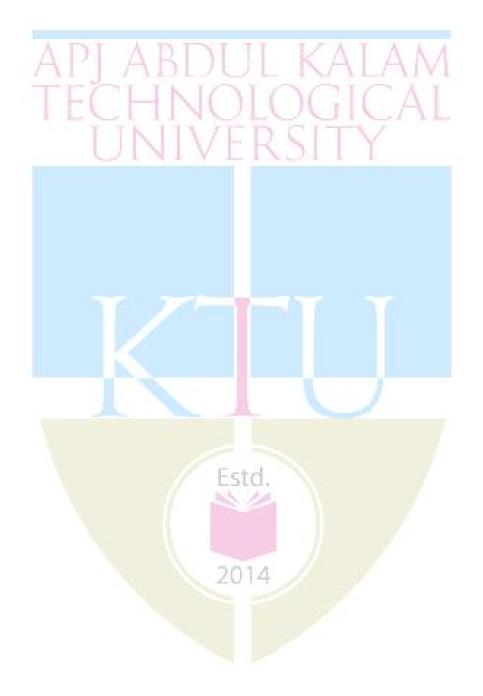
Course No:	Course Name	L-T-P-	Year of
		Credits	Introduction
CH110	CHEMICAL ENGINEERING		
	WORKSHOP	0-0-2-1	2016
Course Objec	tives PJ ABDUL	KALA	M
	udents the basic knowledge in chemical en ad demonstrations.	gineering throug	sh simple
	LINIVER	YTL	
	List of Exercises / Experiments (Min	imum of 8 man	datory)
1. Preparat	ion of soap		
2. Determin	nation of flash and fire point		
3. Preparat	ion of Biodiesel		
4. Specific	gravity measurement		
5. Fabricati	on of FRP laminates/ Study of filtration eq	uipments	
6. Study of	distillation column		
7. Study of	absorption column		
8. Study of	heat exchanger		
9. Study of size reduction equipment			
10. Preparation of Pigment			
Expected outcome			
Students will have a thorough understanding of the basic concepts that they learn in the			
theory paper "	Introduction to Chemical Engineering".		

Introduction to C language; Operators and expressions; Sorting and searching; Pointers; Memory allocation Stacks and Queues. Course Outcomes I. Identify appropriate C language constructs to solve problems. Analyze problems, identify subtasks and implement them as functions/procedures. Analyze problems, identify subtasks and implement them as functions/procedures. Explain the concept of file system for handling data storage and apply it for solving problems Apply sorting & searching techniques to solve application programs. References I. Rajaraman V., Computer Basics and Programming in C, PHI. Anita Goel and Ajay Mittal, Computer fundamentals and Programming in C., Pearson. Gottfried B.S., Programming with C, Schaum Series, Tata McGraw Hill. Horowitz and Sahni, Fundamentals of data structures - Computer Science Press. Gary J. Bronson, ANSI C Programming, CENGAGE Learning India. Kernighan and Ritche D.M., The C. Programming Language, PHI. COURSE PLAN	Course No.	Course Name	L-T-P- Credits	Year of	Introduction
To understand the fundamental concept of C programming and use it in problem solving. Syllabus Introduction to C language; Operators and expressions; Sorting and searching; Pointers; Memory allocation Stacks and Queues. Course Outcomes 1. 1. Identify appropriate C language constructs to solve problems. 2. Analyze problems, identify subtasks and implement them as functions/procedures. 3. Implement algorithms using efficient C-programming techniques. 4. Explain the concept of file system for handling data storage and apply it for solving problems 5. Apply sorting & searching techniques to solve application programs. References 1. 1. Rajaraman V., Computer Basics and Programming in C, PHI. 2. Anita Goel and Ajay Mittal, Computer fundamentals and Programming in C., Pearson. 3. Gottfried B.S., Programming with C, Schaum Series, Tata McGraw Hill. 4. Horowitz and Sahni, Fundamentals of data structures - Computer Science Press. 5. Gary J. Bronson, ANSI C Programming, CENGAGE Learning India. 6. Stewart Venit and Elizabeth Drake, Prelude to Programming – Concepts & Design, Pearson. 7. Dromy R.G., How to Solve it by Computer, Pearson. 8. Kernighan and Ritche D.M., The C. Programming Language, PHI.	CS100	Computer Programming	2-1-0		2016
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Data input and output, control statements.			· ·		
I 7 15%			APICSSIONS.		
	Ι			7	15%

П	Arrays and strings- example programs. Two dimensional arrays - matrix operations. Structure, union and enumerated data type.	8	15%	
III	Pointers: Array of pointers, structures and pointers. Example programs using pointers and structures.		15%	
	FIRST INTERNAL EXAM			
IV	Functions – function definition and function prototype. Function call by value and call by reference. Pointer to a function –. Recursive functions.	7	15%	
	SECOND INTERNAL EXAM			
V	Sorting and Searching : Bubble sort, Selection sort, Linear Search and Binary search. Scope rules Storage classes. Bit-wise operations.	6	20%	
VI	Data files – formatted, unformatted and text files. Command line arguments – examples.	7	20%	
END SEMESTER EXAM				



Course No.	Course Name	L-T-P- Credits	Year of Introduction
110	Computer Programming Lab		2016
Course C	Dbjective:		
• To imp	plement algorithms studied in the course Con	mputerProgrammi	ng
• To lea	rn the implementation of control structures,	Iterations and recu	arsive functions.
•To impl	lement operations on different types of files.	KALA	M
	List of Exercises / E	xperiments	LI CL
	(For Computer Science and 1		
	cises may include the Programs using the fo	llowing concepts.	() have
	on making, branching and looping	CITV	
,	felse statements	JIII	
	ch, goto statements		
	le, do, for statements		
	and strings		
	-dimensional, two-dimensional, multidimens	ional arrays	
	ding/writing strings		
-	rations on strings		
	ng handling		
3.Functio	ons defined functions		
	tion calls, arguments & return values		
	Ing of functions		
	sing arrays and strings to functions		
	ures and unions		
	ying and comparing structure variables		
-	ays of structures		
	ys within structures		
	ctures with in structures		
- stru	ictures and functions		
- unio	ons		
5. Pointe	rs		
- point	ters and arrays		
	ters and character strings		
•	v of pointers 2014		
-	ters and functions		
	ters and structures		
	nemory allocation, bit-level programming		
	fining, opening/closing, input		
	operations		
	nd line arguments		
•	/ allocation functions		
Course C		onrioto nuo cuore	ing language
	is will be able to analyse a problem, find approximate the should be used and implement C program for		ing language
Jonstruc	t should be used and implement C program for	n die problem.	



	No.	Course Name	L-T-P - Credits		Year of troduction
MA20	1	LINEAR ALGEBRA AND COMPLEX ANALYSIS	3-1-0-4		2016
Prerequis	site : N	il			
Course O					
COURSE					
• To ma	o familia any appl	he students with methods of solving a genera rize them with the concept of Eigen values a ications in Engineering. tand the basic theory of functions of a compl	nd diagonalization of	a matrix v	
Syllabus	-	LININ/EDC	ITV		
•	tv of co	mplex functions-Complex differentiation	-Conformal mappin	ngs-Comr	olex
•	•	m of linear equations-Eigen value proble		185 Comp	
U	2	1 0 1			
Expecte	d outco	ome .			
		ourse students will be able to			
		system of linear equations			
	-	values of a matrix and how to diagonalize a	matrix		
		tic functions and Harmonic functions.			
		efinite Integrals as application of Residue Th		aformatio	n a
Text Bo		mal mappings(vi) find regions that are mapp	ed under certain Tran	stormatio	ns
		Advanced Engineering Mathematics, 10 th ed	Wilow		
Referen		Advanced Engineering Mathematics, 10° ed	. whey	_	
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	1]
	The mapping $w = z + \frac{1}{z}$		
	Properties of $w = \frac{1}{7}$	1	
	Circles and straight lines, extended complex plane, fixed points		
	Special linear fractional Transformations, Cross Ratio, Cross Ratio property-Mapping of disks and half planes	3	
	Conformal mapping by $w = \sin z \& w = \cos z$	3	
	(Assignment: Application of analytic functions in Engineering)	1	
	FIRST INTERNAL EXAMINATION		
	Complex Integration. Text 1[14.1-14.4] [15.4&16.1]		
	Definition Complex Line Integrals, First Evaluation Method, Second Evaluation Method	2	
	Cauchy's Integral Theorem(without proof), Independence of path(without proof), Cauchy's Integral Theorem for Multiply Connected Domains (without proof)	2	15%
III	Cauchy's Integral Formula- Derivatives of Analytic Functions(without proof)Application of derivative of Analytical Functions Taylor and Maclaurin series(without proof), Power series as Taylor	2	
	series, Practical methods(without proof) Laurent's series (without proof)	2 2	
	Residue Integration Text 1 [16.2-16.4] Singularities, Zeros, Poles, Essential singularity, Zeros of analytic functions	2	15%
IV	Residue Integration Method, Formulas for Residues, Several singularities inside the contour Residue Theorem.	4	
	Evaluation of Real Integrals (i) Integrals of rational functions of	3	
	$\sin\theta$ and $\cos\theta$ (ii) Integrals of the type $\int f(x)dx$ (Type I, Integrals		
	from 0 to ∞)		
	(Assignment : Application of Complex integration in Engineering)		
	SECOND INTERNAL EXAMINATION		2004
	Linear system of Equations Text 1(7.3-7.5)		20%
v	Linear systems of Equations, Coefficient Matrix, Augmented Matrix	1	
, v	Gauss Elimination and back substitution, Elementary row operations, Row equivalent systems, Gauss elimination-Three possible cases, Row Echelon form and Information from it.	5	



	Linear independence-rank of a matrix	2	
	Vector Space-Dimension-basis-vector space R ³		
	Solution of linear systems, Fundamental theorem of non- homogeneous linear systems(Without proof)-Homogeneous linear	1	
	systems (Theory only		
	Matrix Eigen value Problem Text 1.(8.1,8.3 &8.4)		20%
	Determination of Eigen values and Eigen vectors-Eigen space	3	
VI	Symmetric, Skew Symmetric and Orthogonal matrices –simple properties (without proof)	2	
	Basis of Eigen vectors- Similar matrices Diagonalization of a matrix- Quadratic forms- Principal axis theorem(without proof)	4	
	(Assignment-Some applications of Eigen values(8.2))		
	END SEMESTER EXAM		1

QUESTION PAPER PATTERN:

Maximum Marks : 100

Exam Duration: 3 hours

The question paper will consist of 3 parts.

Part A will have 3 questions of 15 marks each uniformly covering modules I and II. Each question may have two sub questions.

Part B will have 3 questions of 15 marks each uniformly covering modules III and IV. Each question may have two sub questions.

Part C will have 3 questions of 20 marks each uniformly covering modules V and VI. Each question may have three sub questions.

2014

Any two questions from each part have to be answered.

COURS	E CODE	COURSE NAME	L-T-P-C	YEA INTROD	R OF UCTION
EC	201	NETWORK THEORY	3-1-0-4	20	16
Prerequi	site: Nil				
Course o	bjectives:		20.0.2		
• T	o make the	students capable of analyzing any line e domain, phasor and Laplace transfor			
		nt response of networks subject to test signals.	N.IC	A	J. J. L.
	o develop u ort networks	nderstanding of the concept of resona	nce, coupled circ	uits and two	
Syllabus	:	UNIVEN	2111	_	
functions circuits		aplace transforms, Transient analysis gle port and two ports, Parameters o			
		rse students will be able to analyze th	e linear time inva	ariant electric	al circuits.
Text Boo					
		ork Analysis and Synthesis, 2/e, McG Network Analysis, 3/e, PHI, 2011.	raw-Hill, 2015.		
Reference		(etwork 7 mary 515, 57C, 1111, 2011.		5	
Hill, 2 2. Choud 3. Frank 4. Pande	2015. dhary R., No lin F. Kuo, ey S. K., Fur	Shyammohan, Circuits and Networks etworks and Systems, 2/e, New Age I Network Analysis and Synthesis, 2/e, idamentals of Network Analysis and	nternational, 201 Wiley India, 201 Synthesis, 1/e, S.	3. 12. Chand, 2012	
5. Edmin	nister, Elect	ric Circuits – Schaum's Outline Serie	s, McGraw-Hill,	2009.	
Module		Course Plan Course content (48 hrs)	<u> </u>	Hours	Sem.
viouuie		Course content (40 ms)		liours	Exam Marks (9
Ι		n to circuit variables and circuit eles Laws, Independent and dependent			1
	Network to	pology, Network graphs, Trees, Incid	lence matrix,	2	
ľ		ethods applied to dc and phasor circuin network containing independent and]
II		eorems applied to dc and phasor circu		6	1

	Laplace transform, properties	4	
	Laplace Transforms and inverse Laplace transform of common		
	functions, Important theorems: Time shifting theorem, Frequency		
	shifting theorem, Time differentiation theorem, Time integration		
	theorem, s domain differentiation theorem, s domain integration		
	theorem, Initial value theorem, Final value theorem		
	FIRST INTERNAL EXAM		
III	Partial Fraction expansions for inverse Laplace transforms, Solution of differential equations using Laplace transforms	3	1
	Transformation of basic signals and circuits into s-domain	2	-
	Transient analysis of RL, RC, and RLC networks with impulse, step,	3	
	pulse, exponential and sinusoidal inputs	6	
	Analysis of networks with transformed impedance and dependent sources.	3	
IV	Network functions for the single port and two ports, properties of	3	1
	driving point and transfer functions,		
	Poles and Zeros of network functions, Significance of Poles and		
	Zeros		
	Time domain response from pole zero plot, Impulse Response	1	
	Network functions in the sinusoidal steady state, Magnitude and Phase response	3	
	SECOND INTERNAL EXAM		
V	Parameters of two port network: impedance, admittance,	5	2
	transmission and hybrid parameters, Interrelationship among parameter sets		
	Series and parallel connections of two port networks	2	
	Reciprocal and Symmetrical two port network	2	
	Characteristic impedance, Image impedance and propagation constant (derivation not required)	2	
VI	Resonance: Series resonance, bandwidth, Q factor and Selectivity, Parallel resonance	3	2
	Coupled circuits: single tuned and double tuned circuits, dot convention, coefficient of coupling, Analysis of coupled circuits	4	

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark pattern is according to the syllabus with maximum 30% for theory and 70% for logical/numerical problems, derivation and proof.

COURSE CODE	COURSE NAME	L-T-P-C		YEAR O	
EC203	SOLID STATE DEVICES	3-1-0-4		2016	
Prerequisite	: Nil				
To provid	ctives: le an insight into the basic semiconductor le a sound understanding of current semico e its applications to electronics circuits and	onductor devic	es and tec	hnology	to
steady state dependence Hall effect, I potential and ideal diode o piecewise li capacitances	emental and compound semiconductors, F conditions: Equilibrium concentration of carrier concentration, Carrier transpor excess carriers in semiconductors, PN junc- charge density at the junction, energy ba equation, electron and hole component of near model of a diode, effect of ter electrical breakdown in pn junctions olar junction transistor, metal insulator sem	of electrons t in semicond nctions ,contac nd diagram, m f current in fo nperature on , Tunnel Dio	and hol uctors, H t potentia inority ca orward bia VI chara ode, Meta	les, Tem igh field I, electric arrier dist ased pn j acteristics al semico	effects, cal field, ribution, unction, , Diode onductor
Expected ou	tcome:				
	should have a good knowledge in semicor	nductor theory	and electr	onic dev	ices.
Text Books					
6/e, 2010	reetman and Sanjay Kumar Banerjee, Soli , K N Bhat, Fundamentals of Semiconduc				
References:	, K IV Bhat, I undamentais of Semiconduc		, wiedła	<u>v 1111,20</u>	15
1. Tyagi M.	S., Introduction to Semiconductor Materia	lls and Devices	, Wiley Iı	ndia, 5/e,	2008
2. Sze S.M.	Physics of Semiconductor Devices, John	Wiley, 3/e, 20	05		
3. Neamen,	Semiconductor Physics and Devices, McC	Graw Hill, 4/e,	2012		
4. Pierret, S	emiconductor Devices Fundamentals, Pear	rson, 2006			
5. Rita John	, Solid St <mark>ate Devices, McGraw-H</mark> ill, 2014				
6. Bhattacha	rya .Shar <mark>ma, Solid State Electr</mark> onic Devic	es, Oxford Un	iversity P	ress, 2012	2
7. Dasgupta	and Dasgupta, Semiconductor Devices :	Modelling and	Technolo	ogy (PHI))
	Course Plan				
Module	Course content (48hr	5)		Hours	Sem. Exam Marks
di co	ementalandcompoundsemiconductors,Fern stribution, Equilibrium and steady state co ncentration of electrons and holes, Tempe rrier concentration	nditions, Equil		4	15
m H	rrier transport in semiconductors, drift, bility, variation of mobility with temperar gh Field Effects, Hall effect	ture and doping	2,	5	
m Ei	cess carriers in semiconductors: Generation echanisms of excess carriers, quasi Fern instein relations, Continuity equations, adient of quasi Fermi level	mi levels, diff Diffusion le	usion,	9	15
	FIRST INTERNAL EXA	M			

III	PN junctions : Contact potential, Electrical Field, Potential and Charge density at the junction, Energy band diagram, Minority carrier distribution, Ideal diode equation, Electron and hole component of current in forward biased p-n junction, piecewise linear model of a diode effect of temperature on V-I characteristics	9	15
IV	Diode capacitances, switching transients, Electrical Breakdown in PN junctions, Zener and avalanche break down (abrupt PN junctions only), Tunnel Diode basics only, Metal Semiconductor contacts, Ohmic and Rectifying Contacts, current voltage characteristics	9	15
	SECOND INTERNAL EXAM	A. 1	
V	Bipolar junction transistor, current components, Minority carrier distributions, basic parameters, Evaluation of terminal currents (based on physical dimensions), Transistor action, Base width modulation	9	20
VI	Metal Insulator semiconductor devices: The ideal MOS capacitor, band diagrams at equilibrium, accumulation, depletion and inversion, surface potential, CV characteristics, effects of real surfaces, work function difference, interface charge, threshold voltage MOSFET: Output characteristics, transfer characteristics, sub threshold characteristics, MOSFET scaling (basic concepts)	9	20
	FinFET-structure and operation	1	
	END SEMESTER EXAM		

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark pattern is according to the syllabus with maximum 70 % for theory, derivation, proof and 30% for logical/numerical problems.

2014

COUR COD		COURSE NAME	L-T-P- C	YEAR INTRODU	
EC20	5	ELECTRONIC CIRCUITS	3-1-0-4	201	5
Prerequi	isite: N	lil			
Course of • To el	o devel	ves: op the skill of analysis and design of various analic devices as per the specifications.	log circuit	s using discre	te
Syllabus		A DULA DEST ULL	2 A 1	A 3 4	
small sig frequency amplifier and mult equivaler MOSFET	gnal an y and s, Feec ivibrat nt circu <u>f ampli</u>		ll signal Cascade a Power amp MOSFET	hybrid π moments mplifiers, W plifiers, Swee C circuits, sm	del, low ide band p circuits all signal
Expected				1 11 00	
		nd of the course, students will be able to analyse a ic circuits using discrete electronic components.	and design	the different	
Text Boo		e cheurs using discrete electronic components.			
• Sed	ra A. S	and K. C. Smith, Microelectronic Circuits, 6/e, and C. Halkias, Integrated Electronics, 2/e, McGra			s, 2013 •
Reference					
20 3. Sj	011 pencer	 M. H., Microelectronic Circuits - Analysis and De R. R. and M. S. Ghausi, Introduction to Electronic G., Fundamentals of Microelectronics, Wiley, 2015 			
		Course Plan			
Module		Course content (48 hrs)		Hours	Sem. Exam Marks
		ircuits: Response of high pass and low pass RC c		5	
Ι	BJT b factor Conce	step, pulse and square wave inputs, Differentiator biasing circuits: Types, Q point, Bias stability, Sta rs, RC coupled amplifier and effect of various com ept of DC and AC load lines, Fixing of operating j	bility ponents,	5	15
II	Smal signa	ification of amplifiers l signal analysis of CE, CB and CC configuration l hybrid π model (gain, input and output impedan	ce). Small		15
	signa	l analysis of BJT amplifier circuits, Cascade amp	lifier		4
		FIRST INTERNAL EXAM	• .		
III	gain,	frequency equivalent circuits of BJT, Short circuit cutoff frequency, Miller effect, Analysis of high in nse of CE, CB and CC amplifiers		4	15
	Wide	band amplifier: Broad banding techniques, low f igh frequency compensation, Cascode amplifier.	requency	4	
IV	Feedb	back amplifiers: Effect of positive and negative fe frequency response and distortion, Feedback topo			15

	1
6	
6	20
5	
4	20
5	
	6 5 4

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark pattern is according to the syllabus with maximum 60 % for theory, derivation, proof and 40% for logical/numerical problems.

COURS		COURSE NAME	L-T-P-C	YEA INTROD	
EC20		LOGIC CIRCUIT DESIGN	3-0-0-3	20	
Prerequis	site:Nil				
Course of	ojective	S:			
 To exp To sec To To To To Syllabus: Positional Programm Expected The studer 1. Compare 	introdu pression outline quential study th design design Numbe nable Lo outcom nt should re variou	the formal procedures for the analysis and desi circuits e fundamentals of HDL and implement combinational circuits using ba and implement synchronous sequential circuits r Systems, Boolean algebra, Combinational Lo gic Devices, Sequential Logic, Sequential Circ e: d able to:	w the correlation ign of combination sic programmation gic, HDL conce uits	ional circuits	s and
		algebra in logic circuit design			
		ational and sequential circuits			
		lement digital systems using basic programma	ble blocks		
5. Formula Text Bool		ous digital systems using HDL	<u> </u>		
1. Do 2. Joh Refer 1.Ronald 2.Thoma 2009 3.M	nald D (<u>11 F Wal</u> ences: l J Tocci ls L Floy Ioris Ma	Givone, Digital Principles and Design, Tata McG kerly, Digital Design Principles and Practices, Pe , Digital Systems, Pearson Education, 11 th edit d, Digital Fundamentals, Pearson Education, 8 ano, Digital Design, Prentice Hall of India, 3 rd	arson Prentice H tion,2010 th edition edition, 2002		
		ough, Digital Logic Applications and Design, C	0		
		Harris, Sarah L Harris, Digital Design and Com ann – Elsevier, 2009	iputer Architect	ure,	
morga	ii ixauill	Course Plan			
Modul e		Course content (42 hrs)	and the second s	Hours	Sem. Exam Marks
Ι	Number	r systems- decimal, binary, octal, hexa decimal	, base conversio	on 2	15
F	1's and	2's complement, signed number representation arithmetic, binary subtraction using 2's comple	1	2	
	Binary	codes (grey, BCD and Excess-3), Error detection Parity(odd, even), Hamming code (7,4), Alpha	on and correctin		
	function	xpressions, Boolean laws, Duality, De Morgan ns and gates		2	15
	Canonio	cal forms: SOP, POS, Realisation of logic expr	essions using K	- 2	

	map (2,3,4 variables)		
	Design of combinational circuits – adder, subtractor, 4 bit adder/subtractor, BCD adder, MUX, DEMUX, Decoder,BCD to 7 segment decoder, Encoder, Priority encoder, Comparator (2/3 bits)	4	
	FIRST INTERNAL EXAM		
III	Introduction to HDL : Logic descriptions using HDL, basics of modeling (only for assignments)	2	0
	Logic families and its characteristics: Logic levels, propagation delay, fan in, fan out, noise immunity, power dissipation, TTL subfamilies	1	15
	NAND in TTL (totem pole, open collector and tri-state), CMOS:NAND, NOR, and NOT in CMOS, Comparison of logic families (TTL,ECL,CMOS) in terms of fan-in, fan-out, supply voltage, propagation delay, logic voltage and current levels, power dissipation and noise margin	2	
	Programmable Logic devices - ROM, PLA, PAL, implementation of simple circuits using PLA	2	
IV	Sequential circuits - latch, flip flop (SR, JK, T, D), master slave JK FF, conversion of FFs, excitation table and characteristic equations	3	15
	Asynchronous and synchronous counter design, mod N counters, random sequence generator	5	
	SECOND INTERNAL EXAM		
V	Shift Registers - SIPO, SISO, PISO, PIPO, Shift registers with parallelLOAD/SHIFTShift register counter - Ring Counter and Johnson Counter	3	20
	Mealy and Moore models, state machine ,notations, state diagram, state table, transition table, excitation table, state equations	3	
VI	Construction of state diagram – up down counter, sequence detector	3	20
	Synchronous sequential circuit design - State equivalence	2	
	State reduction – equivalence classes, implication chart	2	
	END SEMESTER EXAM		

Assignments:

- 1. Simple combinational circuit design using MUX, DEMUX, PLA & PAL
- 2. HDL simulation of circuits like simple ALU, up-down counter, linear feedback shift register, sequence generator

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark pattern is according to the syllabus with maximum 50 % for theory, derivation, proof and 50% for logical/numerical problems.

Course code	Course Name	L-T-P- Credits	Year of Introduction
HS210	LIFE SKILLS	2-0-2	2016
Prerequisite :	Nil		
Course Objec	tives		
• To dev	elop communication competence in pro	ospective engineer	·S.
• To ena	ble them to convey thoughts and ideas	with clarity and fo	ocus.
• To dev	elop report writing skills.	VAL	A A A
• To equ	ip them to face interview & Group Disc	cussion.	$\pm 1 \times 1$
• To inc	lcate critical thinking process.	CIC	AI
• To pre	pare them on problem solving skills.	JUIC	AL
• To pro descrip	ovide symbolic, verbal, and graphical otion.	interpretations o	f statements in a problem
-	erstand team dynamics & effectiveness		
	ate an awareness on Engineering Ethics		es
	ill Moral and Social Values, Loyalty an		
others.	in fioral and Social Values, Loyarty an		approvide die fights of
	n leadership qualities and practice them	ı	
Application, F Group Discuss Critical Thin Intelligence, P Teamwork: C Dynamics, Ma Ethics, Mora Engineering as ASME, ASCE Leadership S Transactions	kills: Leadership, Levels of Leadershi Vs Transformational Leadership, VUC ship Formulation.	ation and Body I ased Communicat Lateral thinking, d Mapping & Ana formation proce nflicts. Values, Civic R cal Ethics, Global p, Making of a lo	Language, Interview Skills ion. Critical thinking, Multipl alytical Thinking. ss, Stages of Group, Grou ights, Engineering Ethics Issues, Code of Ethics lik
Expected ou	tcome 2014 will be able to		
	unicate effectively.		
	effective presentations.		
	lifferent types of reports.		
	atterview & group discussion.		
	lly think on a particular problem.		
	problems.		
-	n Group & Teams		
	1		
Handle	Engineering Ethics and Human Values		
	e Engineering Ethics and Human Values e an effective leader.	5.	

Resource Book:

Life Skills for Engineers, Complied by ICT Academy of Kerala, McGraw Hill Education (India) Private Ltd., 2016

References:

- Barun K. Mitra; (2011), "Personality Development & Soft Skills", First Edition; Oxford Publishers.
- Kalyana; (2015) "Soft Skill for Managers"; First Edition; Wiley Publishing Ltd.
- Larry James (2016); "The First Book of Life Skills"; First Edition; Embassy Books.
- Shalini Verma (2014); "Development of Life Skills and Professional Practice"; First Edition; Sultan Chand (G/L) & Company
- John C. Maxwell (2014); "The 5 Levels of Leadership", Centre Street, A division of Hachette Book Group Inc.

	Course Plan			
Module	Contents	Hou L-T L		Sem. Exam Marks
Ι	 Need for Effective Communication, Levels of communication; Flow of communication; Use of language in communication; Communication networks; Significance of technical communication, Types of barriers; Miscommunication; Noise; Overcoming measures, Listening as an active skill; Types of Listeners; Listening for general content; Listening to fill up information; Intensive Listening; Listening for specific information; Developing effective listening skills; Barriers to effective listening skills. Technical Writing: Differences between technical and literary style, Elements of style; Common Errors, Letter Writing: Formal, informal and demi-official letters; business letters, Job Application: Cover letter, Differences between bio-data, CV and Resume, Report Writing: Basics of Report Writing; Structure of a report; Types of reports. Non-verbal Communication and Body Language: Forms of non-verbal communication; Interpreting body-language cues; Kinesics; Proxemics; Chronemics; Effective use of body language Interview Skills: Types of Interviews; Ensuring success in job interviews; Appropriate use of non-verbal communication, Group Discussion: Differences between group discussion and debate; Ensuring success in group discussions, Presentation Skills: Oral presentation and public speaking skills; business presentations, Technology-based Communication: Netiquettes: effective e-mail messages; power-point presentation; enhancing editing skills using computer software. 	2	2 4 4	See evaluation scheme

	 Need for Creativity in the 21st century, Imagination, Intuition, Experience, Sources of Creativity, Lateral Thinking, Myths of creativity Critical thinking Vs Creative thinking, Functions of Left Brain & Right brain, Convergent & Divergent Thinking, Critical reading & Multiple Intelligence. 	2	
II	Steps in problem solving, Problem Solving Techniques, Problem Solving through Six Thinking Hats, Mind Mapping, Forced Connections.	2	2
	quantitative reasoning expressed in written form, Numeric, symbolic, and graphic reasoning, Solving application problems.		2
	Introduction to Groups and Teams, Team Composition, Managing Team Performance, Importance of Group, Stages of Group, Group Cycle, Group thinking, getting acquainted, Clarifying expectations.	3	
III	Group Problem Solving, Achieving Group Consensus. Group Dynamics techniques, Group vs Team, Team Dynamics, Teams for enhancing productivity, Building & Managing Successful Virtual Teams Managing Team	3	2
	Managing Successful Virtual Teams. Managing Team Performance & Managing Conflict in Teams. Working Together in Teams, Team Decision-Making, Team		2
	Culture & Power, Team Leader Development.Morals, Values and Ethics, Integrity, Work Ethic, Service	3	
IV	Learning, Civic Virtue, Respect for Others, Living Peacefully. Caring, Sharing, Honesty, Courage, Valuing Time, Cooperation, Commitment, Empathy, Self-Confidence, Character Spirituality, Senses of 'Engineering Ethics', variety of moral issued, Types of inquiry, moral dilemmas, moral autonomy, Kohlberg's theory, Gilligan's theory, Consensus and controversy, Models of Professional Roles, Theories about right action. Solf interest, sustains and roligion, application of	3	2
	right action, Self-interest, customs and religion, application of ethical theories. Engineering as experimentation, engineers as responsible experimenters, Codes of ethics, Balanced outlook on.	3	
	The challenger case study, Multinational corporations, Environmental ethics, computer ethics,		2

	Weapons development, engineers as managers, consulting engineers, engineers as expert witnesses and advisors, moral leadership, sample code of Ethics like ASME, ASCE, IEEE, Institution of Engineers(India), Indian Institute of Materials Management, Institution of electronics and telecommunication engineers(IETE), India, etc.	3		
	Introduction, a framework for considering leadership, entrepreneurial and moral leadership, vision, people selection	4		
	and development, cultural dimensions of leadership, style,	M		
	followers, crises.	1		
V	Growing as a leader, turnaround leadership, gaining control, trust, managing diverse stakeholders, crisis management		2	
	Implications of national culture and multicultural leadership	2		
	Types of Leadership, Leadership Traits.			
	Leadership Styles, VUCA Leadership, DART Leadership,			
	Transactional vs Transformational Leaders, Leadership Grid, Effective Leaders, making of a Leader, Formulate Leadership		2	
	Enective Leaders, making of a Leader, Formulate Leadership END SEMESTER EXAM			

EVALUATION SCHEME

Internal Evaluation

(Conducted by the College)

Total Marks: 100

Part – A

(To be started after completion of Module 1 and to be completed by 30th working day of the semester)

1. Group Discussion – Create groups of about 10 students each and engage them on a GD on a suitable topic for about 20 minutes. Parameters to be used for evaluation is as follows;

(i)	Communication Skills –	10 marks
(ii)	Subject Clarity –	10 marks
(iii)	Group Dynamics -	10 marks
(iv)	Behaviors & Mannerisms -	10 marks

(Marks: 40)

Credits :- APJ KTU | Fair Use Policy



Part – B

(To be started from 31^{st} working day and to be completed before 60^{th} working day of the semester)

2. Presentation Skills – Identify a suitable topic and ask the students to prepare a presentation (preferably a power point presentation) for about 10 minutes. Parameters to be used for evaluation is as follows;

10 marks

10 marks

10 marks

- (i) Communication Skills*
- (ii) Platform Skills**
- (iii) Subject Clarity/Knowledge

(Marks: 30)

* Language fluency, auditability, voice modulation, rate of speech, listening, summarizes key learnings etc.

** Postures/Gestures, Smiles/Expressions, Movements, usage of floor area etc.

Part – C

(To be conducted before the termination of semester)

3. Sample Letter writing or report writing following the guidelines and procedures. Parameters to be used for evaluation is as follows;

(i)	Usage of English & Grammar	-	10 marks
(ii)	Following the format	-	10 marks
(iii)	Content clarity	-	10 marks

(Marks: 30)

External Evaluation (Conducted by the University)

Total Marks: 50

Time: 2 hrs.

Part – A Short Answer questions

There will be one question from each area (five questions in total). Each question should be written in about maximum of 400 words. Parameters to be used for evaluation are as follows;

- (i) Content Clarity/Subject Knowledge
- (ii) Presentation style
- (iii) Organization of content



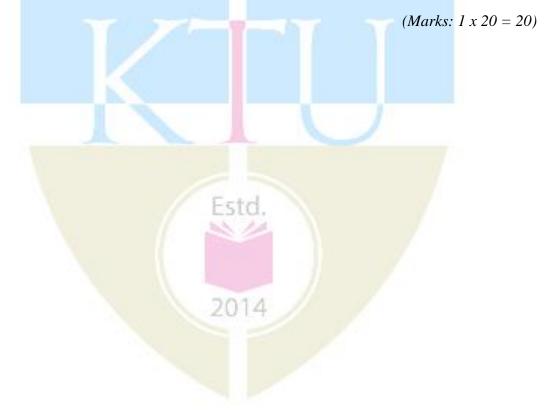
(*Marks*: $5 \times 6 = 30$)

Part – B

Case Study

The students will be given a case study with questions at the end the students have to analyze the case and answer the question at the end. Parameters to be used for evaluation are as follows;

- (i) Analyze the case situation
- (ii) Key players/characters of the case
- (iii) Identification of the problem (both major & minor if exists)
- (iv) Bring out alternatives
- (v) Analyze each alternative against the problem
- (vi) Choose the best alternative
- (vii) Implement as solution
- (viii) Conclusion
- (ix) Answer the question at the end of the case





Course code	Course Name	L-T-P - Credits	Year of
			Introduction
HS200	Business Economics	3-0-0-3	2016
Prerequisite: N	Nil	÷	

Course Objectives

- To familiarize the prospective engineers with elementary Principles of Economics and Business Economics.
- To acquaint the students with tools and techniques that are useful in their profession in Business Decision Making which will enhance their employability;
- To apply business analysis to the "firm" under different market conditions;
- To apply economic models to examine current economic scenario and evaluate policy options for addressing economic issues
- To gain understanding of some Macroeconomic concepts to improve their ability to understand the business climate;
- To prepare and analyse various business tools like balance sheet, cost benefit analysis and rate of returns at an elementary level

Syllabus

Business Economics - basic concepts, tools and analysis, scarcity and choices , resource allocation, marginal analysis, opportunity costs and production possibility curve. Fundamentals of microeconomics - Demand and Supply Analysis, equilibrium, elasticity, production and production function, cost analysis, break-even analysis and markets. Basics of macroeconomics - the circular flow models, national income analysis, inflation, trade cycles, money and credit, and monetary policy. Business decisions - investment analysis, Capital Budgeting decisions, forecasting techniques and elementary Balance Sheet and taxation, business financing, international investments

Expected outcome.

A student who has undergone this course would be able to

- i. make investment decisions based on capital budgeting methods in alignment with microeconomic and macroeconomic theories.
- ii. able to analyse the profitability of the firm, economy of operation, determination of price under various market situations with good grasp on the effect of trade cycles in business.
- iii. gain knowledge on Monetary theory, measures by RBI in controlling interest rate and emerging concepts like Bit Coin.
- iv. gain knowledge of elementary accounting concepts used for preparing balance sheet and interpretation of balance sheet

Text Books

- 1. Geetika, Piyali Ghosh and Chodhury, Managerial Economics, Tata McGraw Hill, 2015
- 2. Gregory Mankiw, Principles of Macroeconomics, Cengage Learning, 2006.
- 3. M.Kasi Reddy and S.Saraswathi, *Economics and Financial Accounting*. Prentice Hall of India. New Delhi.



References:

- 1. Dornbusch, Fischer and Startz, Macroeconomics, McGraw Hill, 11th edition, 2010.
- 2. Khan M Y, Indian Financial System, Tata McGraw Hill, 7th edition, 2011.
- 3. Samuelson, Managerial Economics, 6th edition, Wiley
- 4. Snyder C and Nicholson W, *Fundamentals of Microeconomics*, Cengage Learning (India), 2010.
- 5. Truett, Managerial Economics: Analysis, Problems, Cases, 8th Edition, Wiley
- 6. Welch, *Economics: Theory and Practice* 7th Edition, Wiley
- 7. Uma Kapila, Indian Economy Since Independence, 26th Edition: A Comprehensive and Critical Analysis of India's Economy, 1947-2015
- 8. C Rangarajan, *Indian Economy, Essays on monetary and finance*, UBS Publishers'Distributors, 1998
- 9. A.Ramachandra Aryasri, *Managerial Economics and Financial Analysis*, Tata McGraw-Hill, New Delhi.
- 10. Dominick Salvatore, *Managerial Economics in Global Economy*, Thomas Western College Publishing, Singapore.
- 11. I.M. Pandey, Financial Management, Vikas Publishing House. New Delhi.
- 12. Dominick Salvatore, *Theory and Problems of Micro Economic Theory*. Tata Mac Graw-Hill, New Delhi.
- 13. T.N.Hajela. Money, Banking and Public Finance. Anne Books. New Delhi.
- 14. G.S.Gupta. Macro Economics-Theory and Applications. Tata Mac Graw-Hill, New Delhi.
- 15. Yogesh, Maheswari, Management Economics, PHI learning, NewDelhi, 2012
- 16. Timothy Taylor, Principles of Economics, 3rd edition, TEXTBOOK MEDIA.
- 17. Varshney and Maheshwari. Managerial Economics. Sultan Chand. New Delhi

	Course Plan		
Module	Contents	Hours	Sem. Exam Marks
I	Business Economics and its role in managerial decision making- meaning-scope-relevance-economic problems-scarcity Vs choice (2 Hrs)-Basic concepts in economics-scarcity, choice, resource allocation- Trade-off-opportunity cost-marginal analysis- marginal utility theory, Law of diminishing marginal utility -production	4	15%
	possibility curve (2 Hrs)		
п	Basics of Micro Economics I Demand and Supply analysis- equillibrium-elasticity (demand and supply) (3 Hrs.) -Production concepts-average product-marginal product-law of variable proportions- Production function-Cobb Douglas function-problems (3 Hrs.)	6	15%
	FIRST INTERNAL EXAMINATION		
ш	Basics of Micro Economics II Concept of costs-marginal, average, fixed, variable costs-cost curves-shut down point-long run and short run (3 Hrs.)- Break Even Analysis-Problem-Markets-Perfect Competition, Monopoly and Monopolistic Competition, Oligopoly-Cartel and collusion (3 Hrs.).	6	15%
IV	Basics of Macro Economics - Circular flow of income-two sector and multi-sector models- National Income Concepts-Measurement methods-problems-Inflation, deflation (4 Hrs.)-Trade cycles-Money- stock and flow concept-Quantity theory of money-Fischer's Equation and Cambridge Equation -velocity of circulation of money-credit control methods-SLR, CRR, Open Market Operations-Repo and Reverse Repo rate-emerging concepts in money-bit coin (4 Hrs.).	8	15%

	SECOND INTERNAL EXAMINATION		
	Business Decisions I-Investment analysis-Capital Budgeting-NPV,		20%
\mathbf{V}	IRR, Profitability Index, ARR, Payback Period (5 Hrs.)- Business		
v	decisions under certainty-uncertainty-selection of alternatives-risk	9	
	and sensitivity- cost benefit analysis-resource management (4 Hrs.).	-	
	Business Decisions II Balance sheet preparation-principles and		20%
	interpretation-forecasting techniques (7 Hrs.)-business financing-		
VI	sources of capital- Capital and money markets-international	9	
	financing-FDI, FPI, FII-Basic Principles of taxation-direct tax,		
	indirect tax-GST (2 hrs.).	1	
	FND SEMESTER EXAM	V.L	

END SEMESTER EXAM

Question Paper Pattern

Max. marks: 100, Time: 3 hours

The question paper shall consist of three parts

Part A

4 questions uniformly covering modules I and II. Each question carries 10 marks Students will have to answer any three questions out of 4 (3X10 marks = 30 marks)

Part B

4 questions uniformly covering modules III and IV. Each question carries 10 marks Students will have to answer any three questions out of 4 (3X10 marks =30 marks)

Part C

6 questions uniformly covering modules V and VI. Each question carries 10 marks Students will have to answer any four questions out of 6 (4X10 marks =40 marks)

Note: In all parts, each question can have a maximum of four sub questions, if needed.





COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC231	Electronic Devices & Circuits Lab	0-0-3-1	2016
Prerequisite: Should	have registered for EC205 Electronic circuits	3	
Course objectives:			
• To study the w	orking of analog electronic circuits.		
• To design and	implement analog circuits as per the specific	ations using disc	crete electronic
components.			
List of Experiments:	(12 Mandatory Experiments)		
1. VI Cha	racteristics of rectifier and zener diodes		
2. RC inte	egrating and differentiating circuits (Transien	t analysis with d	lifferent inputs and
frequer	ncy response)		
	ng and clamping circuits (Transients and trans		
	ve Rectifier -with and without filter- ripple fa	U	ion
-	Zener voltage regulator (load and line regula		
	teristics of BJT in CE configuration and eval	-	
	teristics of MOSFET in CS configuration and		arameters
	upled CE amplifier - frequency response char		
	ET amplifier (CS) - frequency response chara	acteristics	
	e amplifier – gain and frequency response		
	le amplifier -frequency response	and for and	
	ck amplifiers (current series, voltage series) - equency oscillators –RC phaseshift, Wien bri		ency response
	requency oscillators – Colpitt's and Hartley	uge,	
	amplifiers (transformer less) - Class B and Cl	lass AB	
	stor series voltage regulator (load and line reg		
	amplifier - frequency response	,uiuiiii)	
	ap sweep circuit		
	ibrators -Astable, Monostable and Bistable		
20. Schmit			
Expected outcome:			
The student should ab	le to:		
1. Design and de	monstrate functioning of various discrete ana	log circuits.	

Design and demonstrate functioning of various discrete analog circuits.
 Function effectively as an individual and in a team to accomplish the given task.

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCT ION
EC233	ELECTRONICS DESIGN AUTOMATION LAB	0-0-3-1	2016
Prerequisite	: Nil		
Course Obje			
- ·	objective of this course is to familiarize the s		
	gital circuits, signals and systems using the soft-wa		
	gn methodologies for the rapid design and verif	fication of co	omplex electronic
systems.	• / •		
	tises / Experiments		
1 Introduc	tion to SPICE		
PSpice, M Introducti resistor, c	on can use any one circuit simulation package with sc fultisim, Proteus or CircuitLab.] on to SPICE software. Recognize various schematic capacitor, inductor, energy sources (VCVS, CCVS, er, DIODE, BJT, FET, MOSFET, etc., units & value	c symbols /mo Sinusoidal s	odel parameters of ource, pulse, etc),
to draw a	nd analyse (DC, AC, Transient) simple analog and di	gital electroni	c circuits.
	speriments using SPICE [Six experiments mandat		
Simulatio	n of following circuits using SPICE [Schematic e	entry of circu	its using standard
	Analysis – Transient, AC, DC]		
	otential divider network		
	C integrating and differentiating circuits		
	ode, BJT and MOSFET characteristics		
	iode Circuits (Clipping, Clamping, Rectifiers)		
	C coupled amplifier (Single & two stages)		
	C oscillator (RC phase shift / Wien Bridge)		
	stable multivibrator		
	ruth table verification of basic and universal gates		
	alf adder /full adder circuits using gates bit adder/BCD adder		
	ncoder/Multiplexers		
	ipflops/Counters		
	tion to MATLAB		
[Institutio	n can use any one numerical computational package	like Scil ab	Octava Spydar
	cipy) or Freemat instead of MATLAB]	ince SeiLuo,	oeuve, spyder,
	ntals, basic operations on array, matrix, complex nu	umbers etc., S	cript and function
· •	ting commands, control statements.		
of analog	imple programs for handling arrays and plotting of 1, discrete and noise signals, analysing the simple e		
List of E	mesh equations. xperiments [Four experiments mandatory]		
-	gram and obtain the solutions	malar and	
	/plot the mathematical equations containing con- plication and quadratic equations etc	inplex numbe	ers, array, matrix

- 2. Obtain different types of plots (2D/3D, surface plot, polar plot)
- 3. Generate and plot various signals like sine square, pulse in same window.
- 4. Plot the diode/transistor characteristics.
- 5. Solve node, mesh and loop equations of simple electrical/network circuits.
- 6. Find the poles and zeros hence plot the transfer functions/polynomials
- 7. Sort numbers in ascending order and save to another text file using text read and sort function after reading n floating point numbers from a formatted text file stored in the system.
- 8. Plot a full wave rectified waveform using Fourier series

3 Introduction to HDL

[Institution can choose VHDL or Verilog as language to describe the problem and any one simulation/synthesis tool like Xilinix ISE, Modelsim, QSim, verilog, VHDL, EDwinXP or ORCAD etc. for the simulation.]

List of Experiments using HDL

Write the HDL code to realise and simulate the following circuits: (at least 4 of the following)

- 1. Basic gates/universal gates
- 2. Combinational Circuits (Half adder/Half subtractor)
- 3. Full adder in 3 modelling styles (Dataflow/structural/Behavioural)
- 4. Multiplexer/De-multiplexer
- 5. Decoder/Encoder
- 6. 4 bit adder/BCD adder
- 7. Flipflops (SR,JK,T,D)
- 8. Binary Counters
- 9. Finite state machines

Expected outcomes:

- 1. An ability to apply knowledge of computer, science, and engineering to the analysis of electrical and electronic engineering problems.
- 2. An ability to design systems which include hardware and software components.
- 3. An ability to identify, formulate and solve engineering problems.
- 4. An ability to use modern engineering techniques

	code	Course Name	L-T-P -Credits	Year Introdu	
MA2	04	Probability, Random Processes and Numerical Methods	3-1-0-4	201	.6
Prerequ					
Course	-				
		oduces the modern theory of probability and processing of random processes and s		to modelli	ng and
a		n most of the important models of discrete dely used models of random processes			
		erstand some basic numerical methods for	interpolation and integr	ration and a	also for
		roots of equations and solutions of ODEs.	interpolation and integr	unon uno i	101
Syllabus		Tools of equations and solutions of ODEs.			
		variables- Continuous Random variables-Mu	ltiple Random variables	Random Pro	ocesses-
		Power spectrum-Special Random Processes. I	*		
Expect					
At the	end of	the course students would have become	familiar with quantifyi	ng and an	alysing
random	n pheno	omena using various models of probabil	ity distributions and ra	andom pro	cesses.
•		lso have learned the concepts of autocorre	1 1	•	
		ental numerical methods learned in the co	1		•
		al problems by the use of computers when	analytical methods fail	or are diff	ficult.
Text B	ook:				
	70 1		: (1 ²⁷ DIHI	·	0.0
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2. E	Erwin K	arapandian, "Probability, Statistics and Qu Kreyszig, "Advanced Engineering Mathem			09
2. E	Erwin K nces:	Kreyszig, "Advanced Engineering Mathem	atics", 10 th edition, Wil	ey, 2015.	
2. E Refere 1. H	Erwin K nces: Hosseinl	Kreyszig, "Advanced Engineering Mathem Pishro-Nik, "Introduction to Probability, S	atics", 10 th edition, Wil Statistics and Random	ey, 2015.	
2. E Referent 1. H R	Erwin K nces: Hosseinl Research	Kreyszig, "Advanced Engineering Mathem	atics", 10 th edition, Wil Statistics and Random <u>ilitycourse.com</u>)	ey, 2015. Processes",	
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2. E Reference 1. H 2. C 3. T	Erwin K nces: Hosseinl Research DliverC.	Kreyszig, "Advanced Engineering Mathem Pishro-Nik, "Introduction to Probability, S n, 2014 (Also available online at <u>www.probab</u> Ibe,FundamentalsofAppliedProbabilityandRau	atics", 10 th edition, Wil Statistics and Random <u>bilitycourse.com</u>) ndomProcesses"Elsevier,2 ess" Third edition-McGra	ey, 2015. Processes", 2005. w Hill.	
2. E Reference 1. H 2. C 3. T	Erwin K nces: Hosseinl Research DliverC.	Kreyszig, "Advanced Engineering Mathem Pishro-Nik, "Introduction to Probability, S h, 2014 (Also available online at <u>www.probab</u> Ibe,FundamentalsofAppliedProbabilityandRan rajan "Probability Statistics and Random Proce	atics", 10 th edition, Wil Statistics and Random I <u>statistics com</u>) adomProcesses"Elsevier,2 ess" Third edition-McGra ag,Cengage Learning-7 th H	ey, 2015. Processes", 2005. w Hill.	Kappa
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	Exponential random variable-mean, variance, memoryless property. Normal random variable-Properties of Normal curve mean, variance	2	
	(without proof), Use of Normal tables.	3	
	FIRST INTERNAL EXAMINATION		
	Joint distributions [Text 1: Relevant portions of sections 4.1, 4.2, 4.4 4.7and 4.10]		15%
III	Joint probability distributions- discrete and continuous, marginal distributions, independent random variables.	4	
	Expectation involving two or more random variables, covariance of pairs of random variables.	3	
	Central limit theorem (without proof).	2	
	Random processes [Text 1: Relevant portions of sections 5.1, 5.2, 5.3 and 6.2]		15%
	Random processes, types of random processes,	2	
TT 7	Mean, correlation and covariance functions of random processes, Wide	4	
IV	Sense Stationary (WSS) process, Properties of autocorrelationand auto covariance functions of WSS processes.		
	Power spectral density and its properties.		
		2	
	SECOND INTERNAL EXAMINATION		
	Special random processes [Text 1: Relevant portions of sections		20%
	5.5, 5.5.1, 5.5.2, 5.5.3, 5.5.4) and 5.6]		
X 7	Poisson process-properties, probability distribution of inter arrival times.	4	
V	Discrete time Markov chain- Transition probability matrix, Chapman	5	
	Kolmogorov theorem (without proof), computation of probability distribution and higher order transition probabilities, stationary distribution.		
-	Numerical Methods [Text 2: Relevant portions of sections 19.2,		20%
	19.3, 19.5 and 21.1]		2070
	(Derivation of formulae not required in this module)		
	Finding roots of equations-Newton-Raphson method.	3	
VI	Interpolation-Newton's forward and backward difference formula,	3	
	Lagrange's interpolation method.	-	
	Numerical Integration-trapezoidal rule, Simpson's 1/3rd rule.	3	
	Numerical solution of first order ODE-Euler method, Runge-Kutta fourth order (classical method).	3	
	END SEMESTER EXAM		

QUESTION PAPER PATTERN:

Maximum Marks : 100 Exam Duration: 3 hours

The question paper will consist of 3 parts.

Part A will have 3 questions of 15 marks each uniformly covering modules I and II. Each question may have two sub questions.

Part B will have 3 questions of 15 marks each uniformly covering modules III and IV. Each question may have two sub questions.

Part C will have 3 questions of 20 marks each uniformly covering modules V and VI. Each question may have three sub questions.

Any two questions from each part have to be answered.

Course code	Course Name	L-T-P - Credits	Year of		
			Introduction		
EC202	SIGNALS & SYSTEMS	3-1-0 -4	2016		
	Prerequisite: N	il			
Course Object					
	udents for an intermediate level of flu				
	time and discrete time, in preparation for		s in digital signal		
	image processing, communication theory		. 1		
	continuous and discrete-time signals				
-	ons and methods those are necessary for s and systems.	the analysis of continu	ous and discrete-		
•	ize with techniques suitable for analyzing	and synthesizing both of	ontinuous time		
	e time systems.	and synthesizing both of	ontinuous-time		
	owledge of time-domain representation an	d analysis concents as th	ev relate to		
•	equations, difference equations, impulse i				
	equency-domain representation and analys	_			
	insform and Z-transform.	pro comp round			
1	y concepts of the sampling process, recon	struction of signals and i	nterpolation.		
Syllabus			1		
•	nals, Continuous time and Discrete time	signals and systems	Signal operations		
	uation representation, Difference equation				
Systems, Discrete time LTI Systems, Correlation between signals, Orthogonality of signals, Frequency domain representation, Continuous time Fourier series, Continuous time Fourier					
Frequency dor	nain representation, Continuous time F	Fourier series, Continue			
	nain representation, Continuous time F lace transform, Inverse Laplace transform		ous time Fourier		
transform, Lap		n, Unilateral Laplace tra	ous time Fourier ansform, Transfer		
transform, Lap function, Frequ transform, Freq	lace transform, Inverse Laplace transform ency response, Sampling, Aliasing, Z tran juency domain representation of discrete	n, Unilateral Laplace tra nsform, Inverse Z transf time signals, Discrete ti	ous time Fourier ansform, Transfer orm, Unilateral Z me Fourier series		
transform, Lap function, Frequ transform, Frec and discrete tin	lace transform, Inverse Laplace transform ency response, Sampling, Aliasing, Z tran juency domain representation of discrete me Fourier transform (DTFT), Analysis	n, Unilateral Laplace tra nsform, Inverse Z transf time signals, Discrete ti	ous time Fourier ansform, Transfer orm, Unilateral Z me Fourier series		
transform, Lap function, Frequ transform, Frec and discrete tin above transform	lace transform, Inverse Laplace transform ency response, Sampling, Aliasing, Z tran juency domain representation of discrete me Fourier transform (DTFT), Analysis ns	n, Unilateral Laplace tra nsform, Inverse Z transf time signals, Discrete ti	bus time Fourier ansform, Transfer orm, Unilateral Z me Fourier series		
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6. Ro	odger E. Ziemer, Signals & Systems - Continuous and Discrete, Pea	rson, 4/e,	2013
	Course Plan		
Module	Contents	Hours	Sem. Exam Marks
	Elementary Signals, Classification and representation of continuous time and discrete time signals, Signal operations	4	
Ι	Continuous time and discrete time systems - Classification, Properties.	3	15%
	Representation of systems: Differential equation representation of continuous time systems. Difference equation representation of discrete systems.	2	
	Continuous time LTI systems and convolution integral.	3	
TT	Discrete time LTI systems and linear convolution.	2	1507
II	Stability and causality of LTI systems.	2	15%
	Correlation between signals, Orthoganality of signals.	2	1
	FIRST INTERNAL EXAMINATION	9.	
	Frequency domain representation of continuous time signals- continuous time Fourier series and its properties.	4	15%
III	Convergence, Continuous time fourier transform and its properties.	3	
	Laplace Transform, ROC, Inverse transform, properties, unilateral Laplace transform.	3	
	Relation between Fourier and Laplace transforms.	1	1
IV	Analysis of LTI systems using Laplace and Fourier transforms. Concept of transfer function, Frequency response, Magnitude and phase response.	4	15%
	Sampling of continuous time signals, Sampling theorem for lowpass signals, aliasing.	3	
	SECOND INTERNAL EXAMINATION		
	Z transform, ROC, Inverse transform, properties, Unilateral Z transform.	4	20%
V	Frequency domain representation of discrete time signals, Discrete time fourier series and its properties.	4	
	Discrete time fourier transform (DTFT) and its properties	4	1
VI	Relation between DTFT and Z-Transform, Analysis of discrete time LTI systems using Z transforms and DTFT, Transfer function, Magnitude and phase response.	6	20%
	END SEMESTER EXAM		-

Assignment: Convolution by graphical methods, Solution of differential equations. **Project:** Use of Matlab in finding various transforms: magnitude and phase responses.

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark pattern is according to the syllabus with maximum 30 % for theory and 70% for logical/numerical problems, derivation and proof.

EC204 ANALOG INTEGRATED CIRCUITS 4-0-0-4 2016 Prerequisite: Nil Course Objectives • To equip the students with a sound understanding of fundamental concepts of operational amplifiers • To understand the wide range of applications of operational amplifiers • To introduce special function integrated circuits To introduce the basic concepts and types of data converters Syllabus Differential amplifier configurations, Operational amplifiers, Block diagram, Ideal op-amparameters, Effect of finite open loop gain, bandwidth and slew rate on circuit performance, op amp applications-linear and nonlinear. Active filters, Specialized ICs and their applications on types. Expected outcome . The students will i. have a thorough understanding of operational amplifiers for various applications Text Books: 1. Franco S., Design with Operational Amplifiers and Analog Integrated Circuits, 3/c, Tata McGraw Hill, 2008 2. Salivahanan S. V. S. K. Bhaaskaran, Linear Integrated Circuits, Tata McGraw Hill, 2008 2. C. G. Clayton, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 3. David A. Bell, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 3. David A. B. Jop Apps and Linear Integrated Circuits, New Age International, 3/e, 2010 5. Ref Coughlin & Fredrick Drisc	Course cod		-T-P - redits		nr of luction
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parameters, Effect of finite open loop gain, bandwidth and slew rate on circuit performance, op amp applications-linear and nonlinear, Active filters, Specialized ICs and their applications Monolithic Voltage Regulators - types and its applications, Data converters - specifications an types. Expected outcome . The students will i. have a thorough understanding of operational amplifiers for various applications Text Books: 1. Franco S., Design with Operational Amplifiers and Analog Integrated Circuits, 3/e, Tata McGraw Hill, 2008 2. Salivahanan S., V. S. K. Bhaaskaran, Linear Integrated Circuits, Tata McGraw Hill, 2008 References: 1. Botkar K. R., Integrated Circuits, 10/e, Khanna Publishers, 2010 2. C.G. Clayton, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 3. David A. Bell, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 3. David A. Bell, Operational Amplifiers & Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. Ref. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. Ref. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, 6/e, Oxford University Press, 20 Module Contents 6/e, Oxford University Press, 2013 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, Mew Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, Mew Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 0. Operational amplifiers: Differential amplifier, Gurrent sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 0. Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations	Syllabus		AL		
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ii. be able to design circuits using operational amplifiers for various applications Text Books: 1. Franco S., Design with Operational Amplifiers and Analog Integrated Circuits, 3/e, Tata McGraw Hill, 2008 2. Salivahanan S., V. S. K. Bhaaskaran, Linear Integrated Circuits, Tata McGraw Hill, 2008 References: 1. Botkar K. R., Integrated Circuits, 10/e, Khanna Publishers, 2010 2. C.G. Clayton, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 3. David A. Bell, Operational Amplifiers & Linear Integrated Circuits, Prentice Hall, 4/e, 2010 3. Ref. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. R.F. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, 6 Edition, PHI,2001 6. Roy D. C. and S. B. Jain, Linear Integrated Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, 6/e, Oxford University Press, 2013 Module Contents Differential amplifiers: Differential amplifier configurations using BJT, Large and small signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance					
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Tata McGraw Hill, 2008 2. Salivahanan S., V. S. K. Bhaaskaran, Linear Integrated Circuits, Tata McGraw Hill, 2008 References: 1. Botkar K. R., Integrated Circuits, 10/e, Khanna Publishers, 2010 2. C.G. Clayton, Operational Amplifiers, Butterworth & Company Publ. Ltd. Elsevier, 1971 nd 3. David A. Bell, Operational Amplifiers & Linear ICs, Oxford University Press, 2 edition, 2010 4. Gayakwad R. A., Op-Amps and Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. R.F. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. R.F. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, 6'e, Oxford University Press, 2013 6 6 Edition, PHI,2001 6. Roy D. C. and S. B. Jain, Linear Integrated Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, 6/e, Oxford University Press, 2013 Course Plan Module Contents Hours Sem. Indegram Marking and Signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifier, Grequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 6 Operational amplifiers: Introduction, Block diagram,	Text Book	s:			
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2010 4. Gayakwad R. A., Op-Amps and Linear Integrated Circuits, Prentice Hall, 4/e, 2010 5. R.F. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, 6 6 Edition, PHI,2001 6. Roy D. C. and S. B. Jain, Linear Integrated Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, 6/e, Oxford University Press, 2013 Course Plan Module Differential amplifiers: Differential amplifier configurations using BJT, Large and small signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 6 15% Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance 5	1. Botk 2. C.G.	ar K. R., Integrated Circuits, 10/e, Khanna Publishers, 2010 Clayton, Operational Amplifiers, Butterworth & Company I		na	
5. R.F. Coughlin & Fredrick Driscoll, Operational Amplifiers & Linear Integrated Circuits, 6 Edition, PHI,2001 6. Edition, PHI,2001 6. Roy D. C. and S. B. Jain, Linear Integrated Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, 6/e, Oxford University Press, 2013 Course Plan Module Contents Hours Sem. Exam Mark Module Contents Hours 1 BJT, Large and small signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 6 15% Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance 5	2010				,
6. Roy D. C. and S. B. Jain, Linear Integrated Circuits, New Age International, 3/e, 2010 7. Sedra A. S. and K. C. Smith, Microelectronic Circuits, 6/e, Oxford University Press, 2013 Course Plan Module Differential amplifiers: Differential amplifier configurations using BJT, Large and small signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only). 6 Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance 5	5. R.F. th	Coughlin & Fredrick Driscoll, Operational Amplifiers & Lir			
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Differential amplifiers: Differential amplifier configurations using BJT, Large and small signal operations, Input resistance, Voltage gain, CMRR, Non-ideal characteristics of differential amplifier. Frequency response of differential amplifiers, Current sources, Active load, Concept of current mirror circuits, Wilson current mirror circuits (Analysis using hybrid 'pi' model only).6IOperational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance5	Module	Contents		Hours	Sem. Exam Marks
Operational amplifiers: Introduction, Block diagram, Ideal op-amp parameters, Equivalent circuit, Voltage transfer curve, Open loop op-amp configurations, Effect of finite open loop gain, Bandwidth and slew rate on circuit performance	I I I I I I	BJT, Large and small signal operations, Input resistance, Volt gain, CMRR, Non-ideal characteristics of differential am Frequency response of differential amplifiers, Current sou Active load, Concept of current mirror circuits, Wilson of	age plifier. rces,	6	
) F C	Operational amplifiers: Introduction, Block diagram, Ideal op parameters, Equivalent circuit, Voltage transfer curve, Open op-amp configurations, Effect of finite open loop gain, Band	loop	5	
		1	dback	3	15%

Time : 3 hours

	configurations, Voltage series feedback, Voltage shunt feedback,		
	Properties of practical op-amp.		
	Op-amp applications: Inverting and non inverting amplifier, DC and AC amplifiers, Summing, Scaling and averaging amplifiers, Instrumentation amplifier.	4	
	FIRST INTERNAL EXAMINATION	II	
III	Op-amp applications: Voltage to current converter, Current to voltage converter, Integrator, Differentiator, Precision rectifiers, Log and antilog amplifier, Phase shift and Wien bridge oscillators	7	15%
IV	Astable and monostable multivibrators, Triangular and saw tooth wave generators, Comparators, Zero crossing detector, Schmitt trigger	5	15%
ĨV	Active filters: Advantages, First and second order low pass, High pass, Band pass and band reject filters, Design of filters using Butterworth approximations	5	13%
	SECOND INTERNAL EXAMINATION		
	Specialized ICs and its applications: Timer IC 555 : Astable and monostable operations, applications. Analog Multipliers: Introduction, Gilbert multiplier cell. Voltage Controlled Oscillator IC AD633 and their applications.	3	20%
V	Phase Locked Loop – Operation, Closed loop analysis, Lock and capture range, Basic building blocks, PLL IC 565, Applications of PLL for AM & FM detection and Frequency multiplication, Frequency division, Frequency synthesizing.	4	
	Monolithic Voltage Regulators - Fixed voltage regulators, 78XX and 79XX series, Adjustable voltage regulators, IC 723 – Low voltage and high voltage configurations, Current boosting, Current limiting, Short circuit and Fold-back protection.	4	
	Data Converters: D/A converter, Specifications, Weighted resistor type, R-2R Ladder type.	3	20%
VI	A/D Converters: Specifications, Classification, Flash type, Counter ramp type, Successive approximation type, Single slope type, Dual slope type, Sample-and-hold circuits.	5	
	type, Dual slope type, Sample-and-hold circuits. END SEMESTER EXAM		

Assignment

- 1. Explain the importance of frequency compensated networks in opamps and the commonly used compensation techniques.
- 2. Write short notes on commercially available integrated circuits (Opamp, ADC, DAC, VCO, Analog multiplier, PLL) with pin outs and their important features

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark patterns are as per the syllabus with maximum60 % for theory and 40% for logical/numerical problems, derivation and proof.



	Course Name L-T-P -		ar of
code	Credits	Intro	luction
EC206	COMPUTER ORGANISATION 3-0-0-3	20)16
Prerequi	site: EC207 Logic Circuit Design		
Course O	bjectives		
• To	impart knowledge in computer architecture.		
• To	impart knowledge in machine language programming.		
То	develop understanding on I/O accessing techniques and memory struc	tures.	
Syllabus	A FIARINI KALAAA	1	
addressing and contro	units of a computer, Arithmetic circuits, Processor architecture, g modes, Execution of program, Micro architecture design process, Do ol units, I/O accessing techniques, Memory concepts, Memory inte emory concepts.	esign of d	lata path
Expected	l outcome .		
The studen	nts will be able to:		
	derstand the functional units of a computer		
	entify the different types of instructions		
	derstand the various addressing modes		
	derstand the I/O addressing system		
	tegorize the different types of memories		
Text Boo	oks:		
	avid A. Patterson and John L. Hennessey, Computer Organisation and esign, Fourth Edition, Morgan Kaufmann		
	avid Money Harris, Sarah L Harris, Digital Design and omputer Architecture, M Kaufmann – Elsevier, 2009		
Reference	2005		
	,cs		
1.	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw	Hill	
2.	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw	Hill	ion
2.	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson	Hill on Educat	
2. 3.	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH	Hill on Educat	
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2. 3. 4. 5.	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan	Hill on Education Education Hours	on Sem. Exam
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor,	Hill on Education Education Hours	Sem. Exam Marks
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearsor Andrew S Tanenbaum: "Structured Computer Organisation", Pearsor Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU	Hill on Education Hours 4 3	Sem. Exam Marks
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division	Hill on Education Hours 4	Sem. Exam Marks
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division Number System: Review of Fixed point & Floating point number	Hill on Education Hours 4 3 1	Sem. Exam Marks
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearsor Andrew S Tanenbaum: "Structured Computer Organisation", Pearsor Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division Number System: Review of Fixed point & Floating point number system	Hill on Education Hours 4 3	Sem. Exam Marks 15%
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division Number System: Review of Fixed point & Floating point number system Architecture : Assembly Language, Instructions, Operands, Registers, Register set, Memory, Constants Machine Language: R-Type, I-Type, J-Type Instructions,	Hill on Education Hours 4 3 1 2	Sem. Exam Marks
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Contents Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division Number System: Review of Fixed point & Floating point number system Architecture : Assembly Language, Instructions, Operands, Registers, Register set, Memory, Constants Machine Language: R-Type, I-Type, J-Type Instructions, Interpreting machine language code	Hill on Education Hours 4 3 1 2	Sem. Exam Marks 15%
2. 3. 4. 5. Module	Carl Hamacher : "Computer Organization ", Fifth Edition, Mc Graw John P Hayes: "Computer Architecture and Organisation", Mc Graw William Stallings: "Computer Organisation and Architecture", Pearson Andrew S Tanenbaum: "Structured Computer Organisation", Pearson Craig Zacker: "PC Hardware : The Complete Reference", TMH Course Plan Functional units of a computer Arithmetic Circuits: Adder-carry propagate adder, Ripple carry adder, Basics of carry look ahead and prefix adder, Subtractor, Comparator, ALU Shifters and rotators, Multiplication, Division Number System: Review of Fixed point & Floating point number system Architecture : Assembly Language, Instructions, Operands, Registers, Register set, Memory, Constants Machine Language: R-Type, I-Type, J-Type Instructions,	Hill on Education Hours 4 3 1 2	Sem. Exam Marks 15%

	MIPS memory map, Steps for executing a program - Compilation,		
	Assembling, Linking, Loading	3	
	Pseudo instructions, Exceptions, Signed and Unsigned instructions, Floating point instructions	3	
	MIPS Microarchitectures – State elements of MIPS processor	1	
IV	Design process and performance analysis of Single cycle processor, Single cycle data path, Single cycle control for R – type arithmetic/logical instructions.		
	Design process and performance analysis of multi cycle processor, Multi cycle data path, Multi cycle control for R – type arithmetic/logical instructions.	3	
	SECOND INTERNAL EXAMINATION	-1	
V	I/O system – Accessing I/O devices, Modes of data transfer, Programmed I/O, Interrupt driven I/O, Direct Memory Access, Standard I/O interfaces – Serial port, Parallel port, PCI, SCSI, and USB.	3	20%
·	Memory system – Hierarchy, Characteristics and Performance analysis, Semiconductor memories (RAM, ROM, EPROM Memory Cells – SRAM and DRAM, internal organization of memory chip, Organization of a memory unit.	4 1	
VI	Cache Memory – Concept/principle of cache memory, Cache size, mapping methods – direct, associated, set associated, Replacement algorithms, Write policy- Write through, Write back.	3	20%
	Virtual Memory – Memory management, Segmentation, Paging, Address translation, Page table, Translation look aside buffer.	3	

Question Paper Pattern (End Sem Exam)

-510

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark patterns are as per the syllabus with maximum80 % for theory and 20% for logical/numerical problems, derivation and proof.

Course	Course Name	L-T-P - Credits		r of luction
code EC208	ANALOG COMMUNICATION ENGINEERING	3-0-0-3		10000 16
	site: EC205 Electronic Circuits	3-0-0-3	20	10
Course O				
	study the concepts and types of modulation schemes.			
	study different types of radio transmitters and receivers.			
	• • • • • •			
То	study the effects of noise in analog communication systems. impart basic knowledge on public telephone systems.	AM		
Syllabus	TECHNING	- A 8		
Amplitude modulation Frequency	of communication system, Need for modulation, No modulator circuits, Demodulator circuits, AM transm n: principles of frequency modulation, phase modulati modulator circuits, FM transmitters, FM receiver, No phone systems, standard telephone set, cordless telephone	nitters, Types on, AM and ise in AM a	s of AM 1 FM Re	, Angle ceivers,
	l outcome .			
	its will be able to:			
i. unc	lerstand the different analog modulation schemes.			
ii. unc	lerstand the fundamental ideas of noises and its effect in c	ommunicatio	n system	s.
-	lain the principle and working of analog transmitters and	receivers.		
	w the basic idea of telephone systems.			
Text Boo				
	ennis Roody and John Coolen, Electronic Communicatio			
	corge Kennedy, Electronic Communication Systems, McG		2008.	
3. 10 Reference	masi, Electronic Communications System, Pearson, 5/e,	2011.		
	ke, Electronic Communication system, Cengage, 2/e, 201	2		
	on Haykin, Communication Systems, Wiley 4/e, 2006.	2.		
	b, Schilling, Saha, Principles of communication system, N	AcGraw Hill.	2013.	
	nasi, Advanced Electronic Communications Systems, Pea			
·	Course Plan	97		
Module	Contents		Hours	Sem. Exam Marks
	Introduction, Elements of communication systems, No modulation	eed for	2	
Ι			3	15%
Amplitude modulation:Sinusoidal AM, Modulation index, Average power, Effective voltage and current, Nonsinusoidal modulation.		nusoidal	4	15%
	Amplitude modulator circuits, Amplitude demodulator AM transmitters, Noise in AM Systems.	circuits,	5	
	FIRST INTERNAL EXAMINATION	N		
III	Single Sideband Modulation: Principles, Balanced mod Singly & doubly balanced modulators, SSB generation method, Phasing method & Third method, SSB reception	on, Filter	6	15%
	Modified SSB systems, Pilot carrier SSB & ISB, Compa			

IV	Angle modulation: Frequency modulation, Sinusoidal FM, Frequency spectrum, Modulation index, Average power, Non- sinusoidal modulation, Deviation ratio, Comparison of AM and FM.	4	15%
IV	AM & FM Receivers: Super heterodyne receiver, Tuning range, Tracking, Sensitivity and gain, Image rejection, Double conversion, Adjacent channel selectivity, Automatic Gain Control (AGC).	4	13%
	SECOND INTERNAL EXAMINATION	1	
	Phase modulation, Equivalence between PM and FM, Sinusoidal phase modulation, Digital phase modulation.	3	20%
V	Angle modulator Circuits: Varactor diode modulators, Transistor modulators. FM Transmitters: Direct and Indirect Methods.	3	
VI	Angle modulation detectors, Slope detector, Balanced slope detector, Foster-Seeley discriminator, PLL demodulator, Automatic Frequency Control (AFC), Amplitude limiters, Noise in FM systems, Pre-emphasis and De-emphasis.FM systems, Pre-emphasis and De-emphasis. Telephone systems, standard telephone set, basic call procedures	4	20%
	Telephone systems, standard telephone set, basic call procedures and tones, DTMF, cordless telephones.	4	
3)	END SEMESTER EXAM		

Assignment

Study of

- 1. The telephone circuit Local subscriber loop, Private-line circuits, Voice-frequency circuit arrangements.
- 2. The public telephone network Instruments, Local loops, Trunk circuits and exchanges, Local central exchanges, Automated central office switches and exchanges.

Question Paper Pattern (End Sem Exam)

Maximum Marks: 100

Time : 3 hours

The question paper shall consist of three parts. Part A covers modules I and II, Part B covers modules III and IV, and Part C covers modules V and VI. Each part has three questions uniformly covering the two modules and each question can have maximum four subdivisions. In each part, any two questions are to be answered. Mark patterns are as per the syllabus with maximum 60 % for theory and 40% for logical/numerical problems, derivation and proof.

Course code	Course Name	L-T-P - Credits	Year of
			Introduction
HS200	Business Economics	3-0-0-3	2016
Prerequisite: N	Nil	÷	

Course Objectives

- To familiarize the prospective engineers with elementary Principles of Economics and Business Economics.
- To acquaint the students with tools and techniques that are useful in their profession in Business Decision Making which will enhance their employability;
- To apply business analysis to the "firm" under different market conditions;
- To apply economic models to examine current economic scenario and evaluate policy options for addressing economic issues
- To gain understanding of some Macroeconomic concepts to improve their ability to understand the business climate;
- To prepare and analyse various business tools like balance sheet, cost benefit analysis and rate of returns at an elementary level

Syllabus

Business Economics - basic concepts, tools and analysis, scarcity and choices , resource allocation, marginal analysis, opportunity costs and production possibility curve. Fundamentals of microeconomics - Demand and Supply Analysis, equilibrium, elasticity, production and production function, cost analysis, break-even analysis and markets. Basics of macroeconomics - the circular flow models, national income analysis, inflation, trade cycles, money and credit, and monetary policy. Business decisions - investment analysis, Capital Budgeting decisions, forecasting techniques and elementary Balance Sheet and taxation, business financing, international investments

Expected outcome.

A student who has undergone this course would be able to

- i. make investment decisions based on capital budgeting methods in alignment with microeconomic and macroeconomic theories.
- ii. able to analyse the profitability of the firm, economy of operation, determination of price under various market situations with good grasp on the effect of trade cycles in business.
- iii. gain knowledge on Monetary theory, measures by RBI in controlling interest rate and emerging concepts like Bit Coin.
- iv. gain knowledge of elementary accounting concepts used for preparing balance sheet and interpretation of balance sheet

Text Books

- 1. Geetika, Piyali Ghosh and Chodhury, Managerial Economics, Tata McGraw Hill, 2015
- 2. Gregory Mankiw, Principles of Macroeconomics, Cengage Learning, 2006.
- 3. M.Kasi Reddy and S.Saraswathi, *Economics and Financial Accounting*. Prentice Hall of India. New Delhi.



References:

- 1. Dornbusch, Fischer and Startz, Macroeconomics, McGraw Hill, 11th edition, 2010.
- 2. Khan M Y, Indian Financial System, Tata McGraw Hill, 7th edition, 2011.
- 3. Samuelson, Managerial Economics, 6th edition, Wiley
- 4. Snyder C and Nicholson W, *Fundamentals of Microeconomics*, Cengage Learning (India), 2010.
- 5. Truett, Managerial Economics: Analysis, Problems, Cases, 8th Edition, Wiley
- 6. Welch, *Economics: Theory and Practice* 7th Edition, Wiley
- 7. Uma Kapila, Indian Economy Since Independence, 26th Edition: A Comprehensive and Critical Analysis of India's Economy, 1947-2015
- 8. C Rangarajan, *Indian Economy, Essays on monetary and finance*, UBS Publishers'Distributors, 1998
- 9. A.Ramachandra Aryasri, *Managerial Economics and Financial Analysis*, Tata McGraw-Hill, New Delhi.
- 10. Dominick Salvatore, *Managerial Economics in Global Economy*, Thomas Western College Publishing, Singapore.
- 11. I.M. Pandey, Financial Management, Vikas Publishing House. New Delhi.
- 12. Dominick Salvatore, *Theory and Problems of Micro Economic Theory*. Tata Mac Graw-Hill, New Delhi.
- 13. T.N.Hajela. Money, Banking and Public Finance. Anne Books. New Delhi.
- 14. G.S.Gupta. Macro Economics-Theory and Applications. Tata Mac Graw-Hill, New Delhi.
- 15. Yogesh, Maheswari, Management Economics, PHI learning, NewDelhi, 2012
- 16. Timothy Taylor, Principles of Economics, 3rd edition, TEXTBOOK MEDIA.
- 17. Varshney and Maheshwari. Managerial Economics. Sultan Chand. New Delhi

Course Plan					
Module	Contents	Hours	Sem. Exam Marks		
I	Business Economics and its role in managerial decision making- meaning-scope-relevance-economic problems-scarcity Vs choice (2 Hrs)-Basic concepts in economics-scarcity, choice, resource allocation- Trade-off-opportunity cost-marginal analysis- marginal utility theory, Law of diminishing marginal utility -production	4	15%		
	possibility curve (2 Hrs)				
п	Basics of Micro Economics I Demand and Supply analysis- equillibrium-elasticity (demand and supply) (3 Hrs.) -Production concepts-average product-marginal product-law of variable proportions- Production function-Cobb Douglas function-problems (3 Hrs.)	6	15%		
	FIRST INTERNAL EXAMINATION				
ш	Basics of Micro Economics II Concept of costs-marginal, average, fixed, variable costs-cost curves-shut down point-long run and short run (3 Hrs.)- Break Even Analysis-Problem-Markets-Perfect Competition, Monopoly and Monopolistic Competition, Oligopoly-Cartel and collusion (3 Hrs.).	6	15%		
IV	Basics of Macro Economics - Circular flow of income-two sector and multi-sector models- National Income Concepts-Measurement methods-problems-Inflation, deflation (4 Hrs.)-Trade cycles-Money- stock and flow concept-Quantity theory of money-Fischer's Equation and Cambridge Equation -velocity of circulation of money-credit control methods-SLR, CRR, Open Market Operations-Repo and Reverse Repo rate-emerging concepts in money-bit coin (4 Hrs.).	8	15%		

SECOND INTERNAL EXAMINATION					
	Business Decisions I-Investment analysis-Capital Budgeting-NPV,		20%		
\mathbf{V}	IRR, Profitability Index, ARR, Payback Period (5 Hrs.)- Business				
v	decisions under certainty-uncertainty-selection of alternatives-risk	9			
	and sensitivity- cost benefit analysis-resource management (4 Hrs.).	-			
	Business Decisions II Balance sheet preparation-principles and		20%		
	interpretation-forecasting techniques (7 Hrs.)-business financing-				
VI	sources of capital- Capital and money markets-international	9			
	financing-FDI, FPI, FII-Basic Principles of taxation-direct tax,				
	indirect tax-GST (2 hrs.).	1			
FND SEMESTER FXAM					

END SEMESTER EXAM

Question Paper Pattern

Max. marks: 100, Time: 3 hours

The question paper shall consist of three parts

Part A

4 questions uniformly covering modules I and II. Each question carries 10 marks Students will have to answer any three questions out of 4 (3X10 marks = 30 marks)

Part B

4 questions uniformly covering modules III and IV. Each question carries 10 marks Students will have to answer any three questions out of 4 (3X10 marks =30 marks)

Part C

6 questions uniformly covering modules V and VI. Each question carries 10 marks Students will have to answer any four questions out of 6 (4X10 marks =40 marks)

Note: In all parts, each question can have a maximum of four sub questions, if needed.





Course code	Course Name	L-T-P- Credits	Year of Introduction
HS210	LIFE SKILLS	2-0-2	2016
Prerequisite :	Nil		
Course Objec	tives		
• To dev	elop communication competence in pro	ospective engineer	·S.
• To ena	ble them to convey thoughts and ideas	with clarity and fo	ocus.
• To dev	elop report writing skills.	VAL	A A A
• To equ	ip them to face interview & Group Disc	cussion.	$\pm 1 \times 1$
• To inc	lcate critical thinking process.	CIC	AI
• To pre	pare them on problem solving skills.	JUIC	AL
• To pro descrip	ovide symbolic, verbal, and graphical otion.	interpretations o	f statements in a problem
-	erstand team dynamics & effectiveness		
	ate an awareness on Engineering Ethics		es
	ill Moral and Social Values, Loyalty an		
others.	in fioral and Social Values, Loyarty an		approvide die fights of
	n leadership qualities and practice them	ı	
Application, F Group Discuss Critical Thin Intelligence, P Teamwork: C Dynamics, Ma Ethics, Mora Engineering as ASME, ASCE Leadership S Transactions	kills: Leadership, Levels of Leadershi Vs Transformational Leadership, VUC ship Formulation.	ation and Body I ased Communicat Lateral thinking, d Mapping & Ana formation proce nflicts. Values, Civic R cal Ethics, Global p, Making of a lo	Language, Interview Skills ion. Critical thinking, Multipl alytical Thinking. ss, Stages of Group, Grou ights, Engineering Ethics Issues, Code of Ethics lik
Expected ou	will be able to 2014		
	unicate effectively.		
	effective presentations.		
	lifferent types of reports.		
	atterview & group discussion.		
	lly think on a particular problem.		
	problems.		
-	n Group & Teams		
	1		
Handle	Engineering Ethics and Human Values		
	e Engineering Ethics and Human Values e an effective leader.	5.	

Resource Book:

Life Skills for Engineers, Complied by ICT Academy of Kerala, McGraw Hill Education (India) Private Ltd., 2016

References:

- Barun K. Mitra; (2011), "Personality Development & Soft Skills", First Edition; Oxford Publishers.
- Kalyana; (2015) "Soft Skill for Managers"; First Edition; Wiley Publishing Ltd.
- Larry James (2016); "The First Book of Life Skills"; First Edition; Embassy Books.
- Shalini Verma (2014); "Development of Life Skills and Professional Practice"; First Edition; Sultan Chand (G/L) & Company
- John C. Maxwell (2014); "The 5 Levels of Leadership", Centre Street, A division of Hachette Book Group Inc.

	Course Plan			
Module	Contents	Hou L-T L		Sem. Exam Marks
Ι	 Need for Effective Communication, Levels of communication; Flow of communication; Use of language in communication; Communication networks; Significance of technical communication, Types of barriers; Miscommunication; Noise; Overcoming measures, Listening as an active skill; Types of Listeners; Listening for general content; Listening to fill up information; Intensive Listening; Listening for specific information; Developing effective listening skills; Barriers to effective listening skills. Technical Writing: Differences between technical and literary style, Elements of style; Common Errors, Letter Writing: Formal, informal and demi-official letters; business letters, Job Application: Cover letter, Differences between bio-data, CV and Resume, Report Writing: Basics of Report Writing; Structure of a report; Types of reports. Non-verbal Communication and Body Language: Forms of non-verbal communication; Interpreting body-language cues; Kinesics; Proxemics; Chronemics; Effective use of body language Interview Skills: Types of Interviews; Ensuring success in job interviews; Appropriate use of non-verbal communication, Group Discussion: Differences between group discussion and debate; Ensuring success in group discussions, Presentation Skills: Oral presentation and public speaking skills; business presentations, Technology-based Communication: Netiquettes: effective e-mail messages; power-point presentation; enhancing editing skills using computer software. 	2	2 4 4	See evaluation scheme

	 Need for Creativity in the 21st century, Imagination, Intuition, Experience, Sources of Creativity, Lateral Thinking, Myths of creativity Critical thinking Vs Creative thinking, Functions of Left Brain & Right brain, Convergent & Divergent Thinking, Critical reading & Multiple Intelligence. 	2	
II	Steps in problem solving, Problem Solving Techniques, Problem Solving through Six Thinking Hats, Mind Mapping, Forced Connections.	2	2
	quantitative reasoning expressed in written form, Numeric, symbolic, and graphic reasoning, Solving application problems.		2
	Introduction to Groups and Teams, Team Composition, Managing Team Performance, Importance of Group, Stages of Group, Group Cycle, Group thinking, getting acquainted, Clarifying expectations.	3	
III	Group Problem Solving, Achieving Group Consensus. Group Dynamics techniques, Group vs Team, Team Dynamics, Teams for enhancing productivity, Building & Managing Successful Virtual Teams Managing Team	3	2
	Managing Successful Virtual Teams. Managing Team Performance & Managing Conflict in Teams. Working Together in Teams, Team Decision-Making, Team		2
	Culture & Power, Team Leader Development.Morals, Values and Ethics, Integrity, Work Ethic, Service	3	
IV	Learning, Civic Virtue, Respect for Others, Living Peacefully. Caring, Sharing, Honesty, Courage, Valuing Time, Cooperation, Commitment, Empathy, Self-Confidence, Character Spirituality, Senses of 'Engineering Ethics', variety of moral issued, Types of inquiry, moral dilemmas, moral autonomy, Kohlberg's theory, Gilligan's theory, Consensus and controversy, Models of Professional Roles, Theories about right action. Solf interest, sustains and roligion, application of	3	2
	right action, Self-interest, customs and religion, application of ethical theories. Engineering as experimentation, engineers as responsible experimenters, Codes of ethics, Balanced outlook on.	3	
	The challenger case study, Multinational corporations, Environmental ethics, computer ethics,		2

	Weapons development, engineers as managers, consulting engineers, engineers as expert witnesses and advisors, moral leadership, sample code of Ethics like ASME, ASCE, IEEE, Institution of Engineers(India), Indian Institute of Materials Management, Institution of electronics and telecommunication engineers(IETE), India, etc.	3		
	Introduction, a framework for considering leadership, entrepreneurial and moral leadership, vision, people selection	4		
	and development, cultural dimensions of leadership, style,	M		
	followers, crises.	1		
V	Growing as a leader, turnaround leadership, gaining control, trust, managing diverse stakeholders, crisis management		2	
	Implications of national culture and multicultural leadership	2		
	Types of Leadership, Leadership Traits.			
	Leadership Styles, VUCA Leadership, DART Leadership,			
	Transactional vs Transformational Leaders, Leadership Grid, Effective Leaders, making of a Leader, Formulate Leadership		2	
	Enective Leaders, making of a Leader, Formulate Leadership END SEMESTER EXAM			

EVALUATION SCHEME

Internal Evaluation

(Conducted by the College)

Total Marks: 100

Part – A

(To be started after completion of Module 1 and to be completed by 30th working day of the semester)

1. Group Discussion – Create groups of about 10 students each and engage them on a GD on a suitable topic for about 20 minutes. Parameters to be used for evaluation is as follows;

(i)	Communication Skills –	10 marks
(ii)	Subject Clarity –	10 marks
(iii)	Group Dynamics -	10 marks
(iv)	Behaviors & Mannerisms -	10 marks

(Marks: 40)

Credits :- APJ KTU | Fair Use Policy



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Part – B

(To be started from 31^{st} working day and to be completed before 60^{th} working day of the semester)

2. Presentation Skills – Identify a suitable topic and ask the students to prepare a presentation (preferably a power point presentation) for about 10 minutes. Parameters to be used for evaluation is as follows;

10 marks

10 marks

10 marks

- (i) Communication Skills*
- (ii) Platform Skills**
- (iii) Subject Clarity/Knowledge

(Marks: 30)

* Language fluency, auditability, voice modulation, rate of speech, listening, summarizes key learnings etc.

** Postures/Gestures, Smiles/Expressions, Movements, usage of floor area etc.

Part – C

(To be conducted before the termination of semester)

3. Sample Letter writing or report writing following the guidelines and procedures. Parameters to be used for evaluation is as follows;

(i)	Usage of English & Grammar	-	10 marks
(ii)	Following the format	-	10 marks
(iii)	Content clarity	-	10 marks

(Marks: 30)

External Evaluation (Conducted by the University)

Total Marks: 50

Time: 2 hrs.

Part – A Short Answer questions

There will be one question from each area (five questions in total). Each question should be written in about maximum of 400 words. Parameters to be used for evaluation are as follows;

- (i) Content Clarity/Subject Knowledge
- (ii) Presentation style
- (iii) Organization of content



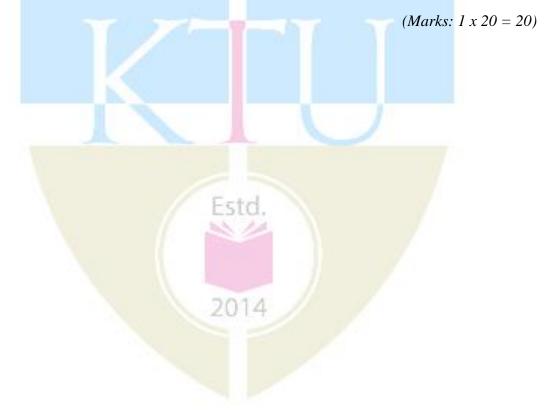
(*Marks*: $5 \times 6 = 30$)

Part – B

Case Study

The students will be given a case study with questions at the end the students have to analyze the case and answer the question at the end. Parameters to be used for evaluation are as follows;

- (i) Analyze the case situation
- (ii) Key players/characters of the case
- (iii) Identification of the problem (both major & minor if exists)
- (iv) Bring out alternatives
- (v) Analyze each alternative against the problem
- (vi) Choose the best alternative
- (vii) Implement as solution
- (viii) Conclusion
- (ix) Answer the question at the end of the case





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COURSE CODE	COURSE NAME	L-T-P- C	YEAR OF INTRODUCTION
EC230	LOGIC CIRCUIT DESIGN LAB	0-0-3-1	2016
Prerequisite:	EC207 Logic circuit design		
Course object	tives:		
• To stuc	ly the working of standard digital ICs and	l basic buildir	ng blocks
• To desi	ign and implement combinational circuits		
• To desi	ign and implement sequential circuits		
List of Experi	iments: -(Minimum 12 experiments are	to be done)	
1. Realiza	ation of functions using basic and universation	al gates (SOP	and POS forms).
2. Design	and Realization of half /full adder and su	btractor usin	g basic gates and universal
gates.			
	lder/subtractor and BCD adder using 7483	3.	
	binary comparator.		
•	to Gray and Gray to Binary converters.		
	of Flip Flops: S-R, D, T, JK and Master S		using NAND gates
•	aronous Counter: Realization of 4-bit cou		
•	nronous Counter: Realization of Mod-N c	ounters.	
•	aronous Counter:3 bit up/down counter		
-	ronous Counter: Realization of 4-bit up/do		
•	conous Counter: Realization of Mod-N co	unters.	
•	ronous Counter:3 bit up/down counter		
	egister: Study of shift right, SIPO, SISO,		(using FF & 7495)
-	ounter and Johnson Counter. (using FF &		
	ation of counters using IC's (7490, 7492,		
-	lexers and De-multiplexers using gates and		
	ation of combinational circuits using MU2	X & DEMUX	
	m sequence generator.		
	Display: Use of BCD to 7 Segment decode	-	· ·
	and Dynamic Characteristic of NAND gat	te (MOS/TTL	.)
Expected outo			
The student sh			
-	and demonstrate functioning of various c		
-	and demonstrate functioning of various s	-	
3 Function	on effectively as an individual and in a tes	m to accomm	lich the given teck

3. Function effectively as an individual and in a team to accomplish the given task

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC232	ANALOG INTEGRATED	0-0-3-1	2016
	CIRCUITS LAB		
Prerequisite	:.Should have registered for EC204 Anal	og Integrated Cir	cuits
Course object		<u> </u>	
_	quire skills in designing and testing analog	g integrated circi	uits
• To ex	pose the students to a variety of practical	circuits using var	rious analog ICs.
List of Expe	riments: (Minimum 12 experiments are	e to be done)	
1. Famil	iarization of Operational amplifiers -	Inverting and M	Non inverting amplifiers,
-	ency response, Adder, Integrator, compar	ators.	
	urement of Op-Amp parameters.		
	rence Amplifier and Instrumentation amp	lifier.	
4. Schm	itt trigger circuit using Op –Amps.		
5. Astab	le and Monostable multivibrator using O	p -Amps.	
6. Timer	r IC NE555		
7. Triang	gular and square wave generators using C) p- Amps.	
8. Wien	bridge oscillator using Op-Amp - without	t & with amplitu	de stabilization.
9. RC Pl	hase shift Oscillator.		
10. Precis	sion rectifiers using Op-Amp.		
11. Active	e second order filters using Op-Amp (LP)	F, HPF, BPF and	BSF).
12. Notch	a filters to eliminate the 50Hz power line	frequency.	
13. IC vo	ltage regulators.		
14. A/D c	converters- counter ramp and flash type.		
15. D/A C	Converters- ladder circuit.		
16. Study	of PLL IC: free running frequency lock	range capture ran	ge
Expected out			
The student s	hould able to:		
1. Desig	n and demonstrate functioning of various	analog circuits	
2. Stude	nts will be able to analyze and design var	ious applications	of analog circuits.

COURSE		L-T-P-				
CODE	COURSE NAME	С	YEAR OF INTRODUCTION			
EC 301	Digital Signal Processing	3-1-0-4	2015			
Prerequisite: EC 202 Signals & Systems,						
Course objectives:						
The course shall provide:						
1. Concepts of Discrete Fourier Transform, Fast Fourier Transform & Discrete Cosine						
Transform	S					
A TT 1 (1 1 1 1 1	. 1 . 1				

- 2. Understanding about the development of algorithms for efficient computation of DFT
- 3. Details about the concepts of design of IIR and FIR filters.
- 4. Understanding of the realization of various structures for IIR and FIR Filters.
- 5. Practical consideration about sampling, multirate conversion and its applications
- 6. Concepts of quantisation effects in digital implementation of IIR and FIR systems.
- 7. Introduction of the architecture of DSP processors

Syllabus:

DFT, DCT, FFT algorithm, Design of FIR and IIR filters, Realization structures for FIR and IIR filters, Introduction to digital signal processors, Multirate signal processing, Finite word length effects in DSP systems

Expected outcome:

After the course, the student will understand the principle of digital signal processing and applications. The utilization of DSP to electronics engineering will also studied.

Text Books:

1. Proakis J. G. and Manolakis D. G., Digital Signal Processing, 4/e, Pearson Education, 2007.

2. Mitra S. K., Digital Signal Processing: A Computer Based Approach, 4/e McGraw Hill(India), 2013.

3. Ifeachor E.C. and Jervis B. W., Digital Signal Processing: A Practical Approach, 2/e, Pearson Education, 2009.

References

- 1. Oppenheim A. V., Schafer R. W. and Buck J. R., Discrete Time Signal Processing, 3/e, Prentice Hall, 2007.
- 2. Singh A., and Srinivasan S., Digital Signal Processing: Imlementation Using DSP Microprocessors, Cenage Learning, 2012.
- 3. Salivahanan, Digital Signal Processing, 2e, Mc Graw –Hill Education New Delhi, 2009
- 4. NagoorKani, Digital Signal Processing, 1e, Mc Graw -Hill Education New Delhi, 2010
- 5. Vaidyanathan P. P., Multirate Systems and Filter Banks, Pearson Education, 2008.
- 6. Tan L., and Jiang J., Digital Signal Processing, 2/e, Elsevier, 2013.
- 7. 5. Kumar A. A., Digital Signal Processing, 2/e, Prentice Hall, 2012

Module	Module Course content Hours					
	The Discrete Fourier Transform: DFT as a linear transformation, Relationship of the DFT to other transforms	1				
Ι	Properties of DFT and examples	2	15			
	Linear Filtering methods based on the DFT	2				
	Frequency Analysis of Signals using the DFT	1				

	The Discrete Cosine Transform: Forward DCT, Inverse DCT and DCTY as an Orthogonal Transform	2	
	Computation of DFT: Radix-2 FFT Algorithms	2	
	IDFT computation using Radix-2 FFT Algorithms	1	
	DFT Computation using Radix-4 FFT Algorithms	2	
II	DFT Computation Using Split-Radix FFT Algorithms	2	15
		Z	
	Efficient computation of DFT of Two Real Sequences	1	
	and a 2N-Point Real Sequence		
	FIRST INTERNAL EXAM	1	
	Design of FIR Filters- Symmetric and Anti-symmetric	1	
	Design of linear phase FIR Filters using Window method	3	
III	Design of linear phase FIR Filters using Window	2	15
	method and Frequency Sampling Method		
	Design of Hilbert Transformers, Comparison of Design Methods for Linear Phase FIR Filters	2	
	Characteristics of Commonly Used Analog Filters	1	
	Design of Analog Butterworth Low Pass Filters	2	
IV	IIR Digital Filters from Analog Filters (Butterworth) by		15
1,	Impulse Invariance and Bilinear Transformation,	3	10
	Frequency Transformations in the Analog Domain	2	
	SECOND INTERNAL EXAM		
	Block diagram and signal flow graph representations	1	
	FIR Filter Structures: Direct Form, Cascade Form and	2	
	Lattice Structure	2	
	IIR Filter Structures: Direct Form, Transposed Form,	2	
V	Cascade Form and Parallel Form		20
	Computational Complexity of Digital filter structures	1	
	Digital Signal Processors: Computer architecture for		
	signal processing, General purpose and special purpose	2	
	DSP hardware, Architectural description of		
	TMC20005545 fixed maint disited series		
	TMS320C5545 fixed point digital signal processor Multi-rate Digital Signal Processing: Decimation and		
	TMS320C5545 fixed point digital signal processorMulti-rate Digital Signal Processing: Decimation andInterpolation (Time domain and Frequency Domain		
	Multi-rate Digital Signal Processing: Decimation and	2	
	Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain	2	
	Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factorsApplication examples: High quality analog-to-digital	2	
	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband 	2	
VI	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering. 		20
VI	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering. Analysis of finite word length effects in DSP systems: 		20
VI	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering. Analysis of finite word length effects in DSP systems: Introduction, fixed-point and floating-point DSP 	1	20
VI	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering. Analysis of finite word length effects in DSP systems: Introduction, fixed-point and floating-point DSP Finite word length effects in IIR digital filters: 	1	20
VI	 Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factors Application examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering. Analysis of finite word length effects in DSP systems: Introduction, fixed-point and floating-point DSP 	1	20
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VI	Multi-rate Digital Signal Processing: Decimation and Interpolation (Time domain and Frequency Domain Interpretation), Sampling Rate Conversion by non- integer factorsApplication examples: High quality analog-to-digital conversion for digital audio and multirate narrowband digital filtering.Analysis of finite word length effects in DSP systems: Introduction, fixed-point and floating-point DSP Finite word length effects in IIR digital filters: coefficient quantization errors overflow errors, scaling, product round off errors limit cycle oscillations	1	20

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 30 % for theory and 70% for logical/numerical problems, derivation and proof.

COURSE		LTDC		EAR OF	
CODE	COURSE NAME	L-T-P-C	INTR	ODUCTION	
EC 303	Applied Electromagnetic Theory	3-0-0-3		2015	
Prerequisit	e: : MA201 Linear Algebra & Co	mplex Analysis, MA	101Calc	culus,MA 102	
Differential	equations				
Course obj	ectives:				
 To develop a solid foundation in the analysis and application of electromagnetic fields, Maxwell's equations and Poynting theorem. To understand boundary conditions of Electric and Magnetic fields and their physical significances. To understand propagation of uniform plane waves in different media. 					
4. To u coef	nderstand propagation of uniform planderstand various parameters of tran ficient and impedance of transmissio mission line problems using Smith c	smission lines like VS on lines and to solve th	SWR, Ref		
Syllabus:					
Maxwell's e	te transformation, vector algebra, ve equations, Boundary condition, Solu n different media, Poynting vecto	tion of wave equation	, propaga	ation of plane	
Expected or	itcome:				
-	f the course, students shall be able to)			
1. To d	evelop a solid foundation and a fresh ectromagnetic fields.		alysis and	l application	
	nalyse the propagation of electromag	netic waves in differe	nt media.		
	nalyze the characteristics of transmis	-			
4. To se	olve the different transmission line pr	roblems using Smith c	hart		
5. To u	nderstand the different modes of prop	pagation in waveguide	es.		
Text Books	:				
1. Math 2010	new N O Sadiku, Elements of Electro	omagnetics, Oxford U	niversity	Press, 5/e,	
2. Jose 1995	ph A Edminister, Electromagnetics,	Schaum's Outline Ser	ries McG	raw Hill, 4/e,	
References					
	an S. Inan and Aziz S. Inan, Enginee	0		n , 2010.	
	I. Hayt, Engineering Electromagnetic				
6/e, 1	napaneni Narayana Rao, Elements of 2006.		-		
	. N. Raju, Eletromagnetic Field Theo	-	Lines, Pe	arson, 2005.	
	D. Kraus, Electromagnetics, 5/e, TM				
	in A Plonus, Applied Electromagne				
	d K. Cheng, Field and Wave Electro				
9. Mah	an and Balmain , Electromagnetic wa apathra, Principles of Electromagnet				
Delh	i,2015 Course Plan				
Module	Course rian Course content (42	hrs)		Sem. Exam	
mouule		AAA 13 J	Uourg	JUIN L'AAIII	

	Course Plan		
Module	Course content (42 hrs)	Hours	Sem. Exam Marks

	Review of vector calculus, Spherical and Cylindrical coordinate system, Coordinate transformation	1	
	Elemental displacement, area and volume for spherical	2	
	and cylindrical coordinate system. Curl, Divergence, Gradient in spherical and cylindrical		
	coordinate system.	1	
	Electric field – Coulomb's law, Stokes theorem, Gauss law and Amperes current law.	1	
Ι	Poisson and Laplace equations, Determination of E and V using Laplace equation.	1	15
	Derivation of capacitance and inductance of two wire transmission line and coaxial cable. Energy stored in Electric and Magnetic field.	2	
	Displacement current density, continuity equation. Magnetic vector potential. Relation between scalar potential and vector potential.	2	
	Maxwell's equation from fundamental laws.	1	
	Boundary condition of electric field and magnetic field from Maxwell's equations	1	
II	Solution of wave equation	1	20
	Propagation of plane EM wave in perfect dielectric, lossy medium, good conductor, media-attenuation, phase velocity, group velocity, skin depth.	3	
	FIRST INTERNAL EXAM		
	Reflection and refraction of plane electromagnetic waves at boundaries for normal & oblique incidence (parallel and perpendicular polarization) Snell's law of refraction, Brewster angle.	4	
III	Power density of EM wave, Poynting vector theorem, Complex Poynting vector.	3	20
	Polarization of electromagnetic wave-linear, circular and elliptical polarisation.	2	
	Uniform lossless transmission line - line parameters	1	
IV	Transmission line equations, Voltage and Current distribution of a line terminated with load	2	15
	Reflection coefficient and VSWR. Derivation of input impedance of transmission line.	2	
	SECOND INTERNAL EXAM		
	Transmission line as circuit elements (L and C).	1	
	Half wave and quarter wave transmission lines.	1	
V	Development of Smith chart - calculation of line impedance and VSWR using smith chart.	2	15
	Single stub matching (Smith chart and analytical method).	2	
	Parallel-Plate Waveguide - TE & TM waves.	2	
VI	The hollow rectangular wave guide – modes of propagation of wave- dominant mode, group velocity and	2	15

Attenuation	in	wave	guides,	guide	wavelength	and	2	
	E	ND SE	MESTE	R EXA	Μ			

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 50 % for theory and 50% for logical/numerical problems, derivation and proof.

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
0022	MICROPROCESSOR &		
EC 305	MICROCONTROLLER	2-1-0 -3	2015
Prerequisite	EC207 LOGIC CIRCUIT DES	GN	
Course objec	ctives:		
To differe	entiate microprocessor and microco	ntroller & far	niliarize the working of a
Micropro	-		C
• To progra	m the controller to make various p	eripherals wo	rk in connection with the
applicatio	n.		
	unicate with various devices using		
-	a microcontroller based system wi	th the help of	the above interfacing devices
Syllabus:			
8085 micro between 808 programming	et, instruction classification. Over processor (8251,8253,8255,8257, 6,80286,80386,80486 and Pentit for 8085(internal examination onl	8259,8275,82 1m. Simple	279).Comparison (tabular form) examples in assembly language
instruction se Interrupts in language prog	nization, registers, I/O ports, pin o t, instruction classification. Assem 8051, Timer/Counter programmi gramming), PIC Microcontrollers,I	configuration bly language ng,Interfacing	and functions. Addressing modes programming examples for 8051 g (block schematic and assembly
instruction se Interrupts in language prog Expected out	nization, registers, I/O ports, pin o t, instruction classification. Assem 8051, Timer/Counter programmi gramming), PIC Microcontrollers,I	configuration bly language ng,Interfacing	and functions. Addressing modes programming examples for 8051 g (block schematic and assembly
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Jack Ganssle, Embedded Hardware: Know It All, Newness
 MandaL, Microprocessors and Microcontrollers 1e, McGraw Hill Education India, 2011

- 6. Nagoorkani, Microprocessors and Microcontrollers 2e, McGraw Hill Education India, 2012
- 7. PATEL, The 8051 Microcontrollers Based Embedded Systems 1e, McGraw Hill Education India, 2014

	Course Plan		
Module	Course content (42 hrs)	Hours	Sem. Exam Marks
Ι	Microprocessors: Introduction, organization of a microprocessor based system, evolution of microprocessors, 8085 architecture and its operation, microprocessor initiated operations and bus organization, pin configuration and functions, generation of control signals for external operations- fetch, IO/M, read/write. machine cycles and bus timings.	5	15
II	Addressing modes, instruction set, instruction classification. Overview/concept of peripheral IC interfacing with 8085 microprocessor (8251,8253,8255,8257,8259,8275,8279). Comparison (tabular form) between 8086,80286,80386,80486 and Pentium.	5	15
	Simple examples in assembly language programming for 8085(internal examination only)	2	0
	FIRST INTERNAL EXAM		
ш	Microcontrollers: Introduction, comparison between microprocessors and microcontrollers, microcontroller families, 8051- features, architecture, memory organization, registers, I/O ports, pin configuration and functions. Addressing modes, instruction set, instruction classification.	7	
	Assembly language programming examples for 8051.	3	
	Interrupts in 8051: Types, interrupt source, interrupt handling and programming	2	
IV	Timer/Counter programming: Operating modes, time delay generation, Waveform generation.	2	15
	Serial communication: RS 232 interface, registers in UART, modes of operation, programming examples for serial data transmission and reception	2	
	SECOND INTERNAL EXAM		
V	Interfacing: Interfacing (block schematic and assembly language programming) of DIP switch, DIP switches, stepper motor, ADC, DAC, LEDs, 7 segment displays, alphanumeric LCD module with 8051. LEDs & 7 Segment displays	8	20

VI	PIC Microcontrollers: Overview of PIC microcontrollers, PIC 18 family, features, programming model, CPU, registers, addressing modes, instruction format, instruction set, resets, timers and CCP devices.	5	20
	Introduction to development tools: IDE, cross assembler, builder, linker and debugger.	1	0
	END SEMESTER EXAM		

Question Paper Pattern

The question paper consists of three parts. Part A covers modules I and II, Part B covers modules III and IV and Part C covers modules V and VI. Each part has three questions. Each question have a maximum of four subparts. Among the three questions one will be a compulsory question covering both the modules and the remaining two questions will be as one question from each module, of which one is to be answered. Mark pattern is according to the syllabus with maximum 50 % for theory and 50% for logical/numerical problems and programming.

COURSE					0.000	
CODE		L-T-P-C	YEAR OF IN	TRODU	CTION	
	Power Electronics &	2002		015		
EC307	Instrumentation	<u>3-0-0-3</u>	A	2015		
-	e: EC205 ELECTRONIC CIRCUI	15				
Course obj						
-	an insight on the concepts of Power E					
	he applications of Power electronic	s such as	Switched mo	de regula	tors and	
inverters.	understonding of the concept of Trees	du an	d Disital in star			
To develop understanding of the concept of Transducers and Digital instruments.						
Syllabus:						
•	conductor switches and its static an	d dynami	abarastaristia	Switch	nd mode	
	SMPS, Switched mode inverters, UPS			s. Switch	eu moue	
•	e characteristics of instruments, Mea		of passive com	nonents]	Differen	
	s, Digital Instruments.	surement		ponents, i	Jinteren	
Expected o	-					
-	should able to:					
	erstand the concepts of Power Electro	onics and th	ne various appli	cations		
	an insight on various electronic instru					
	surements using them.	incines, the	in configuration	unu		
	erstand the principle of operation of T	ransducer	s			
Text Books			<u> </u>			
	anand L., Power Electronics Essentials	s and App	ications, Wiley	India, 20	15.	
	D. A., Electronic Instrumentation and					
References						
1. Moł	an N. and T. M. Undeland, Power Ele	ectronics:	Converters, App	olications	and	
	gn, John Wiley, 2007.					
	idal, Power Electronics 1e, McGraw					
	ra, Instrumentation, Measurement and	d Analysis	,4e, Mc Graw –	Hill Educ	ation	
	Delhi,2016		0.4.4			
	iel W. Hart, Power Electronics, McG					
	blin E., Measurement Systems, 5/e, M			1		
	rick A. D. and W. D. Cooper: Modern		c Instrumentati	on and		
	surement Techniques, 5/e, PHI, 2003. anabis D., Principles of Electronic Ins		on DIII 2009			
	ore K. L., Electronic Measurements a			Doorson 7	000	
	i H. S., Electronic Instrumentation, 3/				009.	
1. IXd1	Course Plan	<i>c</i> , <i>i</i> ata 1910	<u>- 51uw 1111, 201</u>			
Module	Course content (4	2 hrs)			Sem.	
mouult	Course content (4	<u>~ 1113</u> j		Hours	Exam	
				liouis	Marks	
	Linear Electronics versus Power Elect	tronics - P	ower			
	semiconductor switches.		-	1		
	Power diodes-structure, static and dy	namic cha	racteristics	2		
I	Power transistors - Power BJT, Power				15	
			,	3	1	

	Steady state and switching characteristics of Power BJT, Power MOSFET and IGBT.	2	
	Switched mode regulators	1	
	Buck, Boost and Buck-Boost DC-DC converters	2	
п	Waveforms and expression of DC-DC converters for output voltage, voltage and current ripple under continuous conduction mode. (Derivation not required)	1	15
п	Overview of SMPS	1	15
	Isolated converters - Flyback, Forward, Push Pull, Half Bridge and Full Bridge Converters - waveforms and governing equations. (Derivation not required)	3	
	FIRST INTERNAL EXAM		
	Switched mode inverters- Principles of PWM switching schemes.	1	
III	Single phase inverters - half bridge, full bridge and push pull.	2	15
111	UPS - on line and off line.	1	
	Three phase inverters - PWM and Space vector modulation in three phase inverters.	3	
	Generalized configurations of instruments - Functional elements. Classification of instruments	1	
IV	Generalized performance characteristics of instruments - Static characteristics and Dynamic characteristics.	2	15
	Measurement of resistance, inductance and capacitance using bridges.	2	
	SECOND INTERNAL EXAM		
	Transducers - Classification, Selection of transducers.	1	
	Resistance transducers - Principle of operation, resistance, potentiometers, strain gauge.	2	
V	Inductive Transducers - Induction potentiometer, variable reluctance transducers, LVDT, eddy current transducers, synchros and resolvers.	2	20
	Capacitive transducers - different types, capacitor microphone. Hall Effect transducer, proximity transducer, magnetostrictive transducers.	2	
	Electronic Multimeter, Audio Power Meter, RF power meter, True RMS meter.	2	
VI	Digital Instruments - Basics, digital measurement of time, phase, frequency, Digital LCR meter and digital voltmeter.	2	20
V I	Frequency synthesizer, Spectrum analyzers, Logic State analyzers (block diagram only).	1	20
	Digital storage oscilloscope – Operation –controls – applications.	2	
	END SEMESTER EXAM		

Question Paper Pattern

The question paper consists of three parts. Part A covers modules I and II, Part B covers modules III and IV and Part C covers modules V and VI. Each part has three questions. Each question have a maximum of four subparts. Among the three questions one will be a compulsory question covering both the modules and the remaining two questions will be as one question from each module, of which one is to be answered. Mark pattern is according to the syllabus with maximum 100 % for theory.

COURS	SE						
CODI	COURSE NAME	L-T-P-C	YEAR OF INTRODU	CTION			
EC 36	1 DIGITAL SYSTEM DESIGN	2-1-0 -3					
Prerequi	site: EC207 LOGIC CIRCUIT DESI	GN					
Course objectives:							
• To study synthesis and design of CSSN							
• To study synthesis and design of ASC							
• To study hazards and design hazard free circuits							
To study PLA folding							
• To study architecture of one CPLDs and FPGA family							
Syllabus							
Clocked	l synchronous networks ,asynchro	nous seque	ntial circuits, Hazards,	Faults,			
PLA,CPL	Ds and FPGA						
Expected	outcome:						
The stude	nt should able to:						
•	e and design clocked synchronous sequ		S				
-	e and design asynchronous sequential c						
	neir knowledge in diagnosing faults in o	ligital circuit	s ,PLA				
*	et architecture of CPLDs and FPGA						
TEXT B							
	onald G Givone, Digital Principles & D	0					
	hn M Yarbrough, Digital Logic Applic						
	hn F Wakerly, Digital Design, Pearson	Education, D	Delhi 2002				
	N. Biswas, Logic Design Theory, PHI			••			
	chard E. Haskell, Darrin M. Hanna , In	troduction to	Digital Design Using Dig	ılent			
REFERE	PGA Boards , LBE Books- LLC						
	iron Abramovici, Melvin A. Breuer and	l Arthur D F	riedman Digital Systems	Testing			
	d Testable Design, John Wiley & Sons		fiedman, Digitar Systems	resting			
	Kohavi, Switching and Finite Automata		ed., 2001, TMH				
3. M	orris Mano, M.D.Ciletti, Digital Design	n, 5 th Edition	, PHI.				
4. Sa	muel C. Lee, Digital Circuits and Logi	c Design, PH	I				
	Course Pla	n					
Module	Course content ((42 hrs)		Sem.			
			Hours	Exam			
			1 (222)	Marks			
	Analysis of clocked Synchronous Sequ						
Ι	I Modelling of CSSN – State assignment and reduction 1 15%						
*	Design of CSSN		2	10/0			
	Iterative circuits		1				
	ASM Chart and its realization		2				
TT	Analysis of Asynchronous Sequential	Circuits (AS	C) 2	15%			
II	Flow table reduction- Races in ASC			150/			

	State assignment problem and the transition table- Design of AS	2	
	Design of Vending Machine controller.	2	
	FIRST INTERNAL EXAM		
	Hazards – static and dynamic hazards – essential	1	
	Design of Hazard free circuits – Data synchronizers	1	
III	mixed operating mode asynchronous circuits	1	15%
	practical issues such as clock skew	1	
	Synchronous and asynchronous inputs – switch bouncing	2	
	Fault table method – path sensitization method – Boolean difference method	2	4 = 0 /
IV	Kohavi algorithm	2	15%
	Automatic test pattern generation – Built in Self Test(BIST)	3	
	SECOND INTERNAL EXAM		
	PLA Minimization – PLA folding	2	
v	Foldable compatibility Matrix- Practical PLA	2	20%
•	Fault model in PLA		2070
	Test generation and Testable PLA Design.	3	
	CPLDs and FPGAs – Xilinx XC 9500 CPLD family, function block – architecture – input output block architecture – switch matrix	3	
VI	FPGAs – Xilinx XC 4000 FPGA family – configurable logic block – input output block	3	20%
	Programmable interconnect.	1	
	END SEMESTER EXAM		

Question Paper Pattern

The question paper consists of three parts. Part A covers modules I and II, Part B covers modules III and IV and Part C covers modules V and VI. Each part has three questions. Each question have a maximum of four subparts. Among the three questions one will be a compulsory question covering both the modules and the remaining two questions will be as one question from each module, of which one is to be answered. Mark pattern is according to the syllabus with maximum 50 % for theory, derivation, proof and 50% for logical/numerical problems.

COURS	E				YEAR O	F
CODE		COURSE NAME	L-T-P-C	INT	RODUC	ΓΙΟΝ
EC363		OPTIMIZATION TECHNIQUES	4-0-0-4		2015	
Prerequisit	te:nil					
Course obj	ectiv	es:				
	• U	nderstand the need and origin of the optim	nization methods			
	• G	et a broad picture of the various applic	cations of optim	nization	methods	used in
		ngineering.				
	• D	efine optimization problem and its various	s components.			
mathematic problems/te Mathematic solutions, C Duality in Network pa Genetic algo Expected o • On optim	al pro- cchnic cal fo Graph linea ath M orithr orithr outcon comp mizat	neering applications of optimization, ogramming problems, objective function, ques, necessary and sufficient conditions rmulation of LP Problems, Reduction of tical solution methods, optimality cond ar programming, dual simplex method, fodels, Nonlinear unconstrained optimiz n. Introduction to optimization tools and s me: pletion of this course, the students we ion techniques will be able to formulate and solving the e	constraints, class for optimality, of a LPP to the litions, degene Transportation ation, Modern oftwares.	ssificatio uni-mode standar racy, Si Probler methods	n of optin dality, co rd form. mplex alg n, Game of optin understan	mization nvexity, Feasible gorithm, theory, nization, ding of
 H.A. Ta Hadley, Kalynan 	su S I aha, " , G. " moy l	Rao, "Engineering optimization Theory an Operations Research", Fifth Edn. Macmi Linear programming", Narosa Publishing Deb. "Optimization for Engineering Desig	llan Publishing (House, New De	Company lhi	y, 1992.	al, 2009
		l of India Pvt. Ltd., New Delhi,				
Eng 2. Kan 3. J. S. 4. A. R	nok D ineeri ti Sw Aror Ravine	Belegundu, Tirupathi R Chandrupatla, "C ing", Pearson Education. aroop – " Operations Research" a, Introduction to Optimum Design, McG dran, D. T. Phillips, J. J. Solberg, Operatic ey and Sons.	raw-Hill Book (Company	7.	
		bros& Wilde, Principles of Optimal Design	n, Cambridge Ui	niversity	Press, 20	08
		Course Plan				
Module		Course content (42 hrs)		Hours	Sem. Exam Marks
	of c objec probl	lems/techniques.	ogramming pro tion of optim	oblems, nization	2	15
	and	mization techniques: Classical optimizatio multivariable minimization- necessary an ptimality, uni-modality, convexity.			5	

II	Linear programming problems-I: Mathematical formulation of LP Problems, slack, surplus and artificial variables. Reduction of a LPP to the standard form, feasible solutions. Graphical solution method, simplex algorithm and solution using tabular method, optimality conditions and degeneracy.	7	15
ш	FIRST INTERNAL EXAMLinear programming problems-II: Duality in linear programming, dual simplex method.Transportation Problem: Formulation of transportation problem, Basic feasible solution using different methods- East West corner method, Vogel approximation method, Optimality methods, MODI method, Unbalanced transportation problem, Degeneracy in transportation problems, Applications of transportation problems.	8	15
IV	Game theory : Introduction, 2- person zero – sum game; Saddle point ; Mini-Max and Maxi-Min Theorems (statement only); Graphical solution (2x n, m x 2 game), dominance property. Network path Models: Tree Networks – Minimal Spanning Tree - Prim's Algorithm. Shortest path problems- solution methods – Dijkstra's Method.	8	15
	SECOND INTERNAL EXAM		
V	Nonlinear unconstrained optimization: Single variable optimization methods- Fibonacci search method, Newton-Raphson method. Multi-variable methodss- Hook-Jeeves pattern search method, Cauchy's (steepest descent) method.	7	20
VI	Modern methods of optimization: Genetic algorithm Introduction. Examples of applications in electronics engineering. Introduction to optimization tools and softwares. Solution of optimization Problems using MATLAB	5	20
	END SEMESTER EXAM		

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 40 % for theory, derivation, proof and 60% for logical/numerical problems and algorithms.

COURSE					
CODE	COURSE NAME	L-T-P-C	YEAR OF IN	FRODU	CTION
EC365	Biomedical Engineering	3-0-0-3	20	015	
Prerequisite	EC307 Power Electronics &Instrum	entation			
Course obje	ctives:				
• To in	roduce student to basic biomedical er	ngineering tech	nology		
	derstand the anatomy & physiology of	of major system	ns of the body in de	signing	
	ments for medical treatments.				
	part knowledge about the principle ar	nd working of o	different types of bi	io-medica	1
	onic equipments/devices.				
Syllabus:					
	y-overview, Physiological systems	-			
	d therapeutic devices, Medical labor	atory equipme	nts, Telemetry in	patient ca	re, Patient
	al imaging system				
Expected ou					
	y to understand diagnosis and therapy			c 1'	
	rstanding the problem and ability to ic	ientify the nece	essity of equipment	for diagn	iosis and
therap 3. Unde	by. rstanding the importance of electronic	on ginooring	in modical field		
	rstanding the importance of telemetry				
Text Books:	istanding the importance of telementy	in patient car			
	pur, "Hand book of Biomedical instru	umentation" T	ata McGraw Hill 2	nd e/d	
	omwell, Fred J. Weibell, Erich A. Pfe				surements
	Edition, 2004	liter, Diemeur		und mou	sur ennemes,
References:	,				
1. J J Carr,	'Introduction to Biomedical Equipment	nt Technology	": Pearson Educati	on 4th e/d	l.
	Vebster, "Medical Instrumentation app			3rd e/d.	
	Aston, "Principle of Biomedical Instru				
4. Barbara (Christe, Introduction to Biomedical In		Cambridge Univer	sity Press	, 2008
	Course Pla				
Module	Course content	, ,		Hours	
	Introduction, bio-medical instrument	•	overview of		
	anatomy and physiological systems of	•		<u> </u>	
	Bio-electric potential: Resting and a	-		3	
	equivalent of cell, Nernest relation, b	-			1 7
Ι	characteristics of ECG, EEG, EMG,				15
	Bio potential electrodes and sensors:			1	
	and characteristics, method of selecti				
	Transducers for biological applicatio			3	
	measurement of pressure, flow, pulse	e and respiratio	лп.		

	Bio-signal acquisition and safety: Physiological signal amplifiers, isolation amplifier, bridge amplifier and chopper amplifier, Electrical safety: physiological effects due to current passage, micro current shock, macro current shock, leakage current, devices to protect against electrical hazards, safety codes for electro medical equipments, electromagnetic interference to medical electronic equipments.	3	
	Measurement of blood pressure: Direct, indirect and relative methods of blood pressure measurement, auscultatory method, oscillometric and ultrasonic non-invasive pressure measurements.	2	
	Measurement of blood flow: Electromagnetic blood flow meters and	2	15
п	ultrasonic blood flow meters. Electrocardiography: Cardiac action potential, electrocardiogram, , ECG lead configurations, ECG recording system, analysis of ECG signals, basic concepts of vector cardiography, phonocardiography and echocardiography.	2	15
	FIRSTINTERNAL EXAM	1	
	The human nervous system. Neuron, action potential of brain, brain waves, types of electrodes, placement of electrodes, evoked potential, EEG recording, analysis of EEG. Electromyography: Nerve conduction velocity, instrumentation system for EMG.	3	
III	Physiology of Respiratory system, Tests and Instrumentation for the respiratory measurements, respiratory gas analyzers. Diagnosis Equipments: Principle, block schematic diagram,	2	15
	working and applications of oxi meters, plethysmograph, pH meter, blood cell counter, flame photometer, spectrophotometer, colorimeter and chromatographs.	3	
IV	Therapeutic Equipments: Principle, block schematic diagram, working and applications of pacemakers, cardiac defibrillators, heart–lung machine, dialyzers, surgical diathermy equipment, electrotherapy, infant incubators, ventilators and automatic drug delivery systems.	5	15
	SECOND INTERNAL EXAM		
V	 Medical Imaging systems: (Basic Principle only) X-ray imaging: Properties and production of X-rays, X-ray machine, applications of X-rays in medicine, radiography and fluorography. Computed Tomography: Principle, image reconstruction, scanning system and applications. Ultrasonic imaging systems: Basic pulse echo system, propagation of ultrasonic through tissues and reflections, display types, A-Scan, B-Scan, M-Scan, applications, real-time ultrasonic imaging systems and probes. Magnetic Resonance Imaging: principle, magnetic relaxation and MRI parameters, basic NMR imaging system, biological effects of NMR imaging, MRI instrumentation system, advantages, risks and limitations Positron Emission Tomography: Principle, scanning, PET instrumentation system, advantages of PET scan. 	11	20

VI	Biomedical Telemetry system: Components of biotelemetry system, application of telemetry in medicine, single channel telemetry system for ECG and temperature, multi channel telemetry system, implantable telemetry system.	2	20
END SEMESTER EXAM			

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 100 % for theory.

COURSE		L-T-P-	
CODE	COURSE NAME	С	YEAR OF INTRODUCTION
EC 360?	SOFT COMPUTING	3-0-0 -3	2016

Course objectives:

• To familiarize various components of soft computing like fuzzy logic, neural networks and genetic algorithm.

• To give an overview of fuzzy Logic and to understand the concepts and terminologies of fuzzy systems.

• To give a description on artificial neural networks with its advantages and application.

• To study the fundamentals of Genetic Algorithm (GA).

• To understand the concepts of hybrid systems.

Syllabus:

Fuzzy sets and systems. Neural Networks - Applications - typical architecture, pattern Classification and pattern Association. Fundamentals of Genetic Algorithm, AI search algorithm and hybrid structure.

Expected outcome:

The student should able to:

1. Identify and describe soft computing techniques and their roles in building intelligent Machines.

2. Apply fuzzy logic and reasoning to handle uncertainty and solve engineering problems.

3. Recognize the feasibility of applying a soft computing methodology for a particular Problem.

4. Apply neural networks to pattern classification and regression problems.

5. Apply genetic algorithms to combinatorial optimization problems.

Text Books:

1. Timothy J. Ross, "Fuzzy Logic with Engineering Applications" Wiley India.

2. Laurene V. Fausett, (1993) "Fundamentals of Neural Networks: Architecture, Algorithms and Applications", Prentice Hall.

3. D.E. Goldberg, "*Genetic Algorithms: Search, Optimization and Machine Learning*", Addison Wesley, N.Y, 1989.

References:

1. Lin C. T. and C.S. G. Lee, Neural Fuzzy Systems, Prentice Hall, 1996.

2. Ibrahim A. M., Introduction to Applied Fuzzy Electronics, PHI, 2013.

- 3. S. Rajsekaran & G.A. Vijayalakshmi Pai, "Neural Networks, Fuzzy Logic and Genetic Algorithm: Synthesis and Applications" Prentice Hall of India.
- 4. K.H.Lee.. First Course on Fuzzy Theory and Applications, Springer-Verlag.
- 5. J. Yen and R. Langari.. Fuzzy Logic, Intelligence, Control and Information, Pearson Education.

	Course Plan		
Module	Course content (42hrs)	Hours	Sem. Exam Marks
I	Soft computing: Introduction of soft computing, soft computing vs hard computing, various types of soft computing techniques, applications of soft computing.	2	15

	Introduction to fuzzy sets and systems-crispness, vagueness, uncertainty and fuzziness. Basics of fuzzy sets,		
	membership functions, support of a fuzzy set height, normalized fuzzy set, alpha cuts.	2	
	Type- 2 fuzzy sets. Operation on fuzzy set-complement, intersection, union, Demorgan's Law Equality & subset hood.	2	
	Extension Principle and its application. Fuzzy relation- operations, projection, max-min, min-max composition, cylindrical extension.	2	
II	Reflexivity, symmetry and transitivity of fuzzy relations. Fuzzy prepositions, fuzzy connectives, linguistic variables, hedges.	3	15
	Approximate reasoning or fuzzy inference, Fuzzy rule based system. Fuzzification and defuzzification using centroid, centre of sums.	3	
	FIRST INTERNAL EXAM		
	Introduction to Neural Networks - Applications – Biological neuron- Typical architecture of Artificial Neural Networks - Common activation function.	2	
III	Mc. Culloh Pitts Neuron – Architecture, logic implementatons. Supervised and Unsupervised learning-Learning Algorithms .Linear Separability.	3	15
	Pattern Classification – Hebb Net, Perceptrons, ADALINE networks (Architecture, Algorithm and simple Applications).	3	
	Pattern Association- training algorithms- Hetro Associative Network, Auto Associative Network, Hopfield Network, BAM Network.	3	
IV	Back propogation learning methods-back propagation algorithm, factors affecting backpropagation training & applications. (Architecture, Algorithm and simple Applications).	3	15
	SECOND INTERNAL EXAM		
V	Genetic Algorithm (GA) Basic concepts, Genetic representations, (encoding) Initialization and selection, Survival of the Fittest - Fitness Computations.	3	20
	Cross over - Mutation –Reproduction, applications. Rank method–Rank space method AI search algorithm.	3	
	Introduction to Neural Fuzzy Controller- Neural Fuzzy controller with hybrid structure.	2	
VI	Parameter learning for Neural fuzzy controllers – Neural Fuzzy controller with Fuzzy singleton Rules.	3	20
	Integration of neural networks, fuzzy logic and genetic algorithms.	3	

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 40 % for theory, derivation, proof and 60% for logical/numerical problems and algorithms.

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC333	Digital Signal Processing Lab	0-0-3-1	2015
Prerequisit	e:		
	tronics Design Automation Lab, EC 202 Signa	als & Systems, EC	301 Digital Signal Processing
Course obj			
	ble the students to explore the concepts of desi	gn, simulation and	l implementation of various
Syste List of Exp	ems using MATLAB and DSP kit.		
List of Exp	er mients.		
Part A: Ex	periments on Digital Signal Processor/ DSP	kits: (All experi	ments are mandatory)
1. Gene	eration of sine wave and standard test signals.		
	volution : Linear and Circular		
	Time FIR Filter implementation (Low-pass, H	High-pass and Ban	id-pass) by inputting a signal
	the signal generator	Lich page and Dan	d page) by inputting a signal
	Time IIR Filter implementation (Low-pass, In the signal generator	ingn-pass and Ban	id-pass) by inputting a signal
	pling of analog signal and study of aliasing.		
	1 6		
Part B: Ex	periments based on MATLAB (7 experiments)	nts are mandator	y)
1. Gene	eration of Waveforms (Continuous and Discre	te)	
2. Veri	fication of Sampling Theorem.		
	e and Frequency Response of LTI systems (Fin		
	ar Convolution, Circular Convolution and Lin		sing Circular Convolution.
	ind the DFT and IDFT for the given input sequar convolution using DFT (Overlap-add and C		ode)
	ind the DCT and IDCT for the given input seq		lous).
	ind FFT and IFFT for the given input sequence		
	and IIR filter design using Filter Design Toolt		
	Filter (Low-pass, High-pass and Band-pass)de	U V	·
	Filter (Low-pass, High-pass and Band-pass)de	-	and Chebychev).
	eration of AM, FM & PWM waveforms and the	neir spectrum.	
	eration of DTMF signal. y of sampling rate conversion (Decimation, In	ternolation Ratio	nal factor)
	ring of noisy signals	nerpolation, Ratio	
	lementation of simple algorithms in audio proc	cessing (delay, rev	erb, flange etc.).
-	ementation of simple algorithms in image pro-		
Expected o	utcome:		
-	should able to:		
1 Desi	an simulate and realize various systems relate	ed to DSP	
1. Desi	gn, simulate and realize various systems relate		

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC335	Power Electronics & Instrumentation Lab	0-0-3-1	2015
Prerequisit	e: EC307 Power Electronics & Instrumentati	ion	
Course obje	ectives:		
• To d	esign and implement basic power electronic cire	cuits	
	tudy the working of transducers		
• To tr	rain the usage of Digital Instruments		
List of Exp	eriments:		
1. I	Design and Step up DC-DC converter		
2. I	Design and Step up Push pull DC- DC Converte	er	
3. I	Design and Step up Buck DC-DC Converters		
4. I	Design and Step up Simple SMPS		
	Design and Step up Half bridge and full bridge	converters	
	Design and Step up basic Inverter Circuits		
	Fransducer measurements using diode thermome	eter	
	Fransducer measurements using LVDT		
	Transducer measurements using Strain gauge.		
	Fransducer measurements using Pressure transdu		
	Fransducer measurements using Thermocouple	& RTDS	
	Fransducer measurements using Photocells	C ·	
	Study of Digital LCR meter, Frequency synthesi	zer, Spectrum ana	llyzer and Logic State analyzer
	application.		
Expected or			
	should able to:		
	gn and demonstrate basic power electronic circu	uits	
2. Use	transducers for application		

3. Function effectively as an individual and in a team to accomplish the given task

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC302	DIGITAL COMMUNICATION	4-0-0-4	2015
	MA201 Linear Algebra & Complex Analysi		
	umerical Methods, EC301 Digital Signal Pro		
Course Objectiv			
1. To under	stand the concept of Digital representation o	f analog source	
	stand the Performance comparison various p		
	ss Inter Symbol Interference (ISI) problem in		cation and to derive
	ist Criteria for zero ISI in data Transmission		
	stand signal space representation of signal us	sing Gram Schmi	dt orthonormalisation
procedur		1	
•	se the error probability for different modu	lation schemes li	ike BPSK, BFSK, and
QPSK.	stand the principle of spread spectrum comn	nunication and to	illustrate the concept
	and DSSS		mustrate the concept
	stand various Multiple Access Techniques		
7. 10 under	stand various maniple recess reeninques		
Expected outco	me:		
At the end of the	course, students will be able to		
	rate the digital representation of analog sour		
	pare the performance of various Digital Pulse		
	y the knowledge of ISI problems in Digital c	ommunication to	derive Nyquist criteria
	ero ISI		
	yse the need for introducing ISI in Digital Co		
	truct signal space representation of signal us	ing Gram Schmid	it orthonormalisation
proce	oare the error probability for different digital	modulation sche	mas lika BDSK BESK
QPSI		modulation selle.	mes nike di SK, di SK
•	ribe the principle of spread spectrum commu	nication and to ill	lustrate the concept of
	S and DSSS		fushing the concept of
	rstand various Diversity Technique		
Syllabus			
•	igital Communication, Pulse Code Modu	lation (PCM), M	Iodifications of PCM
Transmission ov	ver baseband channel, Transmission over	AWGN Channe	el, Digital Modulation
Schemes, Spread	l spectrum communication, Transmission ov	er fading channel	,Diversity techniques
Text Books			
	ns, Digital Communication Systems, Wiley		
2. John G Proaki	s, Masoud Salehi, Digital Communication, N	McGraw Hill Edu	cation Edition, 2014
References:			
1. John G P	roakis, Masoud Salehi, Gerhard Bauch, Moo	lern Communicat	ion Systems using
	Cengage Learning India Pvt Ltd, 2013		, O
	N, Digital Communication, Cengage Learni	ng India Pvt Ltd,	2016
	laykins, Communication Systems, 4/e Wiley	-	
•	al, Digital Communication, McGraw Hill Ed		vt Ltd, 2015

- 5. Ramakrishna Rao, Digital communication, Tata McGraw Hill Education Pvt. Limited.
- 6. Hari Bhat, Ganesh Rao, Digital Communication, 3/e, Pearson, 2010

L

7. Robert G. Gallagar/Principles of Digital Communication, Cambridge University Press, 2008

	Course Plan		
Module	Course content (54 hrs)	Hours	Sem. Exam Marks
Ι	 Overview of Digital Communication- Comparison with Analog Communication Overview of Random variables and Random process -Stationarity, Transmission of Random Process through LTI systems, Power Spectral Density (PSD), Importance of random variables and random process in digital communication 		15
	Pulse Code Modulation (PCM) : Pulse Modulation, Sampling process, Performance comparison of various sampling techniques Aliasing, Reconstruction, PAM, Quantization, Noise in PCM system,	5	
п	Modifications of PCM: Delta modulation, DPCM, ADPCM, ADM, Performance comparison of various pulse modulation schemes, Line codes, PSD of various Line codes.		15
	Transmission over baseband channel: Matched filter, Inter Symbol Interference (ISI), Nyquist Criteria for zero ISI, Ideal solution, Raised cosine spectrum, Eye Pattern	5	15
	FIRST INTERNAL EXAM		
	Signal Space Analysis: Geometric representation of signals, Gram Schmidt orthogonization procedure.	5	
III	Transmission Over AWGN Channel : Conversion of the continuous AWGN channel into a vector channel, Likelihood function, Maximum Likelihood Decoding, Correlation Receiver	5	15
IV	Digital Modulation Schemes: Pass band transmission model, Coherent Modulation Schemes-BASK, BPSK, QPSK, BFSK, Non-Coherent orthogonal modulation schemes, Differential Phase Shift Keying (DPSK), Detection of Binary modulation schemes in the presence of noise, BER for BASK, BPSK, QPSK, BFSK	8	15
	SECOND INTERNAL EXAM		
V	Spread spectrum communication: Pseudo noise sequences, Properties of PN sequences. Generation of PN Sequences, Direct Sequence Spread Spectrum (DSSS), Anti jam Characteristics, Frequency Hop spread spectrum with MFSK, Slow and Fast frequency hopping.	6	20
	Multicarrier Communication: Overview of Orthogonal Frequency		1

	Division Multiplexing (OFDM), Generation and demodulation of OFDM		
VI	Transmission over fading channel : multipath channels, classification, Coherence time, Coherence bandwidth, Statistical characterization of multi path channels Diversity techniques: Diversity in time, frequency and space.	6	20
	END SEMESTER EXAM		

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC304	VLSI	3-0-0-3	2015

Prerequisite:

PH 100 Engineering Physics, EC203 Solid State Devices, EC204 Analog Integrated Circuit. Course objectives:

To get the knowledge about IC Fabrication Techniques and to get the skill of analysis and design of MOSFET and CMOS logic circuits.

Syllabus:

IC Fabrication Technology, CMOS IC Fabrication Sequence, CMOS inverters, Design rules, Static CMOS Design, Dynamic CMOS circuits, Pass transistor, Read Only Memory, Random Access Memory, Sense amplifiers, Adders, multipliers, Testing of VLSI circuits

Expected outcome:

• At the end of the course, students will be able to Design and Analysis of various MOSFET and CMOS logic circuits

Text Books:

- 1. S.M SZE, VLSI Technology, 2/e, Indian Edition, McGraw-Hill, 2003
- 2. John P Uyemura, Introduction to VLSI Circuits and Systems, Wiley India, 2006

References:

Т

- 1. Sung –Mo Kang & Yusuf Leblebici, CMOS Digital Integrated Circuits- Analysis & Design, McGraw-Hill, Third Ed., 2003.
- 2. Razavi Design of Analog CMOS Integrated Circuits,1e, McGraw Hill Education India Education, New Delhi, 2003.
- 3. Jan M.Rabaey, Digital Integrated Circuits- A Design Perspective, Prentice Hall, Second Edition, 2005.
- 4. Neil H.E.Weste, Kamran Eshraghian, Principles of CMOS VLSI Design- A Systems Perspective, Second Edition. Pearson Publication, 2005
- 5. Yuan Taur& Ning, Fundamentals of Modern VLSI Devices, Cambridge University Press, 2008

	Course Plan		
Module	Course content (42 hrs)	Hours	Sem. Exam Marks
I	Material Preparation- Purification, Crystal growth (CZ and FZ process), wafer preparation Thermal Oxidation- Growth mechanisms, Dry and Wet oxidation, Deal Grove model.	4	15
	Diffusion- Fick's Laws, Diffusion with constant surface concentration and from a constant source, diffusion techniques. Ion implantation -Technique, Range Theory, annealing.	3	

II	Epitaxy : Vapour phase epitaxy and molecular beam epitaxy Lithography- Photo lithographic sequence, Electron Beam Lithography, Etching and metal deposition	4		
	Methods of isolation Circuit component fabrication: transistor, diodes, resistors, capacitors, N-well CMOS IC Fabrication Sequence	3	15	
	FIRST INTERNAL EXAM			
III	CMOS inverters - DC characteristics, switching characteristics, power dissipation	4	15	
111	Layout Design rules , layout of CMOS Inverter, two input NAND and NOR gates	3	- 15	
IV	Static CMOS Design - basic concept, multiple input CMOS logic circuits, static properties, propagation delay and transistor sizing Dynamic CMOS circuits - Issues with dynamic circuits, Domino logic	4	15	
	MOSFET Logic Design -Pass transistor logic, Complementary pass transistor logic and transmission gate logic , realization of functions	3		
	SECOND INTERNAL EXAM			
V	Read Only Memory -4x4 MOS ROM Cell Arrays(OR,NOR,NAND) Random Access Memory –SRAM-Six transistor CMOS SRAM cell, DRAM –Three transistor and One transistor Dynamic Memory Cell	4	20	
	Sense amplifiers –Differential Voltage Sensing Amplifiers Introduction to PLDs and FPGAs, Design of PLAs.	3		
X 7 I	Adders- Static adder, Carry-By pass adder, Linear Carry- Select adder, Square- root carry- select adder, Carry-Look ahead adder Multipliers-Array multiplier.	4	20	
VI	Design for Testability – Fault types and models, Controllability and Observability, Scan based Techniques, Built-In Self-Test Techniques tools.	3	20	
	END SEMESTER EXAM			

COURS		COURSE NAME	L-T-P-C	YEAR INTRODU				
EC306		ANTENNA & WAVE PROPAGATION	3-0-0-3	201				
		C303 Applied Electromagnetic Theory	0000	201	0			
Course o								
	0	the basic working of antennas.						
		various antennas, arrays and radiation patterns of a	ntennas.					
	 To understand various techniques involved in various antenna parameter measurements. 							
		stand the propagation of radio waves in the atmosp	*					
Syllabus:	:							
fields and arrays and antennas. Horn, Para Design of modes, eff	directiv design Travelli abolic d rectang fect of e	of antenna and antenna parameters. Duality of anten vity of short dipole and half wave dipole. Measuren of End fire, broadside, binomial and Dolph Cheby ing wave antennas, principle and applications of V lish antenna and Cassegrain antenna Log periodic a gular Patch antennas. Principle of smart antenna Ra earth's magnetic field, Fading and diversity techniq	nent of antenn shev arrays P and rhombic antenna array a dio wave prop	a parameters rinciples of p antennas Prin and Helical an	Antenna ractical ciples of ntenna.			
Expected								
		of the course the student will be able to know: working of antennas						
		intennas, arrays and radiation patterns of antennas						
		echniques involved in various antenna parameter n	neasurements.					
		agation of radio waves in the atmosphere.						
Text Book	ks:	- -						
1. Jo	hn D.	Krauss, Antennas for all Applications, 3/e, TM	IH.					
		Antenna Theory and Design, 3/e, Wiley Public						
Referenc	es:							
 Collin Thoma Raju C 	R.E, A as A. M G.S.N.,	& K G Balmain, Electromagnetic Waves & Radiatin Intennas & Radio Wave Propagation, McGraw Hill Iilligan, Modern Antenna Design, IEEE PRESS, 2/ Antenna and Wave Propagation, Pearson, 2013. Annapurna Das, Antenna and Wave Propagation, N	l. 1985. e, Wiley Inter	science,2005				
Module		Course content (42 hrs)			Sem.			
				Hours	Exam Marks			
I	propag	wave propagation, Modes, structure of atmosphe gation, effect of earth's magnetic field, Ionospher malities and absorption, space wave propagation,	ic	4	15			
·	radio j divers	strength of space wave, duct propagation, VHF and propagation, tropospheric scatter propagation, fadinity ity techniques.	ng and	4	15			
II	Princi	ple of Log periodic antenna array and He	lical antenna	ı. <u>3</u>	15			

	Antennas for mobile base station and handsets.,		
	Design of rectangular Patch antennas. Principle of smart antenna.	3	
	FIRST INTERNAL EXAM		
III	Basic principle of beam steering. Traveling wave antennas. Principle and applications of V and rhombic antennas. Principles of Horn, Parabolic dish antenna, Cassegrain antenna	6	15
IV	Arrays of point sources - field of two isotropic point sources - principle of pattern multiplication - linear arrays of 'n' isotropic point sources. Grating lobes.	4	15
	Design of Broadside, Endfire & Binomial arrays. Design of Dolph Chebyshev arrays.	4	
	SECOND INTERNAL EXAM		
v	Concept of retarded potential. Field, directivity and radiation resistance of a short dipole and half wave dipole.	4	20
•	Measurement of radiation pattern, gain, directivity and impedance of antenna	3	
VI	Basic antenna parameters - gain, directivity, beam solid angle, beam width and effective aperture calculations. Effective height - wave polarization - antenna temperature - radiation resistance - radiation efficiency - antenna field zones - principles of reciprocity. Duality of antennas.	7	20
	END SEMESTER EXAM		

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF I	NTROD	UCTION		
EC 308	EMBEDDED SYSTEMS	3-0-0 -3		2015			
Prerequisite: EC206 Computer Organization, EC305 Microprocessors & Microcontrollers							
 To have To study To study To study 	 To study the basics of RTOS for Embedded systems. To study the programming concepts of Embedded Systems 						
Syllabus:							
communication	Embedded Systems, Embedde standards and devices, Memory de ramming - Embedded C++ and em	evices and de	vice drivers, Prog	gramming	g concepts of		
Expected outco	ome:						
The student sho	uld able to:						
	and the basics of an embedded syste	em					
-	program for an embedded system.						
-	implement and test an embedded sy	ystem.					
Text Books:							
0	amal, Embedded Systems Architec Shibu - Introduction to Embedded		0 0				
References:		•					
1. Wayne V	Wolf, Computers as Components: I	Principles of	Embedded Comp	outing Sy	stem Design,		
•	Kaufman Publishers - Elsevier 3e	-	1	0.	C /		
2. Tammy	Noergaard, Embedded Systems An	rchitecture, A	Comprehensive	e Guide f	or Engineers		
and Prog	grammers, Newnes – Elsevier 2ed, 2	2012					
	eath, Embedded Systems Design, N						
	Simon, An Embedded Software Pr	rimer, Pearso	n Education Asia	a, First Ir	idian Reprint		
2000.	abid and Tana Circuits Full 11	d Creater D	A TT C	1 TTax-1			
	 Frank Vahid and Tony Givargis, Embedded Systems Design – A Unified Hardware / Software Introduction, John Wiley, 2002. 						
6. Iyer - Er	nbedded Real time Systems, 1e, Mo	cGraw Hill E	ducation New De	elhi, 2003			
	Course Plan	l					
Module	Course content ((42hrs)			Sem.		
				Hours	Exam Marks		

	ntroduction to Embedded Systems- Components of embedded		
I Pr Bi D	ystem hardware–Software embedded into the system –Embedded rocessors - CPU architecture of PIC and ARM processors – CPU sus Organization and Protocol. Design and Development life cycle model - Embedded system esign process – Challenges in Embedded system design.	7	15
	erial Communication Standards and Devices - UART, HDLC, CI and SPI. erial Bus Protocols - I2C Bus, CAN Bus and USB Bus. barallel communication standards ISA, PCI and PCI-X Bus.	6	15
	FIRST INTERNAL EXAM		
III –	Memory devices and systems - memory map – DMA - I/O Devices Interrupts - ISR – Device drivers for handling ISR – Memory Device Drivers – Device Drivers for on-board bus.	6	15
IV E	Programming concepts of Embedded programming – Features of Embedded C++ and Embedded Java. Software Implementation, Pesting, Validation and debugging, system-on- chip. Design Examples: Mobile phones, ATM machine, Set top box.	7	15
SECOND INTERNAL EXAM			
V ar Se	nter Process Communication and Synchronization -Process, tasks nd threads –Shared data– Inter process communication - Signals – emaphore – Message Queues – Mailboxes – Pipes –Sockets – temote Procedure Calls (RPCs).	8	20
- 1 M VI M Fu Rd	Real time operating systems - Services- Goals – Structures - Kernel Process Management – Memory Management – Device Management – File System Organization. Micro C/OS-II RTOS - System Level Functions – Task Service Functions – Memory Allocation Related Functions – Semaphore Related Functions. tudy of other popular Real Time Operating Systems.	8	20
	END SEMESTER EXAM		

SYLLABUS AND COURSE PLAN					
COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION		
EC 312	OBJECT ORIENTED PROGRAMMING	3-0-0-3	2015		
Prerequisite:Nl	L	•			
Course objectiv	/es:				
To intro	luce the Object Oriented Programming paradign	n using C++ a	nd Java as the		
language	·S.				
To learn	simple Android application development from t	he fundament	als.		
Syllabus:					
	Programming and basics of C++, Advanced fe				
-	ing and templates. Object oriented features		-		
	res of Java including packages, multithreading	and error mai	nagement. Introduction		
	cation development with a case study.				
Expected outco					
1	on of this course, the students have:				
	gh understanding of the features of OOP like cla	ass construction	on, polymorphism and		
	ce of C++ and Java.				
functions		-			
Knowled managen	lge of advanced features of Java such as multithment.	reading, packa	iges and error		
• Skills in	designing android application development.				
• Skills in	debugging, deploying and testing mobile application	ations.			
Text Books:					
	rian, and Bill Phillips, Android Programming: T	The Big Nerd	Ranch Guide.		
	-Wesley Professional, 2013.				
	rrusamy, Object Oriented Programming with C+	+ and JAVA,	McGrawHill, 2015		
References:		a 1.t			
	, Debasis, Object-Oriented programming with	C++ and Jav	va, PHI Learning Pvt.		
Ltd., 200		mon Educatio	n India 1096		
	p, Bjarne. The C++ programming language, Peann, Cay S., and Gary Cornell., Core Java 2:				
Educatio		volume I, I	unuamentais, reaisoli		
	Harvey M., and Paul J. Deitel., Java how to	program7th	International edition."		
(2007): 3		r,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			
	h, R. A. Maksimchuk, M. W. Engel, and B J. Y	0 0	-oriented Analysis and		
	vith Applications, Addison-Wesley, 3rd Edition,	2007.			
6. www.tut	orialspoint.com/android/android_tutorial.pdf		I		
	Course Plan				

Module	Course content (42 hrs)	Hours	Sem. Exam Marks
Ι	Concepts of OOP - Introduction to OOP, Procedural Vs. Object Oriented Programming, Principles of OOP, Benefits and applications of OOP.	2	15
	Beginning with C++: Overview and Structure of C++ Program, Classes and Objects, Constructors and Destructors.	4	
	Operator Overloading and Inheritance - Overloading Unary Operators, Overloading Binary Operators, Overloading Binary Operators using Friends, Manipulation of Strings Using Operators.	4	
Π	Inheritance - Multilevel Inheritance, Multiple Inheritance, Hierarchical Inheritance, Hybrid Inheritance. Virtual Base Classes, Abstract Classes, Constructors in Derived Classes, Member Classes: Nesting of Classes	4	15
	FIRST INTERNAL EXAM		
III	Virtual Functions and Polymorphism - Pointers to objects, this pointer, Pointers to derived classes, Virtual functions, Virtual Constructors and Destructors.	6	15
	Templates and Exception Handling	2	
IV	Programming with JAVA - Overview of Java Language, Classes Objects and Methods, Method Overloading and Inheritance, Overriding Methods, Final Variables and Methods, Working with files – File stream operation, file pointers and their manipulation, File updation.	6	15
	SECOND INTERNAL EXAM		
v	Interfaces, Packages and Multithreading - Interfaces: Multiple Inheritance, Packages - Java API packages, Multithreaded programming, Managing Errors and Exceptions.	7	20
VI	Introduction to Android : Setting up Development Environment, Basic Building blocks - Activities, Services, Broadcast Receivers & Content providers, UI Components - Views & notifications, Components for communication -Intents & Intent Filters, Application Structure-Android Manifest.xml, uses-permission & uses-sdk, Layouts & Drawable Resources, First sample Application, Emulator-Android Virtual Device, Basic UI design, Styles & Themes, Content Providers-SQLite Programming, Case study – Develop an App to demonstrate database usage.	7	20
	END SEMESTER EXAM		

Assignment:

- 1. A group assignment on simple android mobile app (eg: managing students' details and rank calculation of a class).
- 2. Assignment for implementing virtual base class in C++ related to some application.

3. Assignment for implementing a simple interactive applet in Java (eg: calculator)

Question Paper

COURS CODE			EAR OF ODUCTION
EC 362			2015
Prerequis Processing	ite: MA204 Probability, Random Processes and Numerical Metho	ds, EC301	Digital Signal
Course of	ojectives:		
	part the basic concepts of modeling and simulation of Communicat ady and evaluate the behavior and performance of the systems.	ion Syster	ns
generation Estimation	Simulation and Modelling Methodology, Review of Random Pro , Modelling of Transmitter and Receiver subsystems, Communicat a of parameters in simulation, Estimation of performance me f simulation results.	ion chann	els and models,
Expected	outcome:		
The stude	nt should be able to		
• A	pply modelling and computational techniques to problems in the co	mmunicat	tion field.
Text Bool			
	. Jeruchim, Philip Balaban , K.Sam Shanmugam, Simulation of con	municatio	on systems,
	ver Academic/Plenum Press, New York, 2000	1.0	1001
	ain. The Art of Computer Systems Performance Analysis, John Wild pter 25)	ey and Soi	is, 1991
(Cin	Course Plan		
Module	Course content (42hrs)	Hours	Sem. Exam Marks
	Simulation and Modelling Methodology: Review of Random Processes, Univariate and multivariate models, Transformation of random variables		
Ι	Bounds and approximations, Random process models, Markov		
	and ARMA Sequences, Poisson Process, Gaussian Process	3	15
		3	15
	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences Testing Random Number Generators	1 1	15
	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences	1 1	15
п	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences Testing Random Number Generators Modelling of Transmitter and Receiver subsystems: Information	1 1	15
п	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences Testing Random Number Generators Modelling of Transmitter and Receiver subsystems: Information sources Channel coding ,Radio frequency and optical modulation, Demodulation and detection , Filtering	1 1 1	
п	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences Testing Random Number Generators Modelling of Transmitter and Receiver subsystems: Information sources Channel coding ,Radio frequency and optical modulation,	1 1 1 2	
Π	and ARMA Sequences, Poisson Process, Gaussian Process Random Number Generation , Generation of Random sequences Testing Random Number Generators Modelling of Transmitter and Receiver subsystems: Information sources Channel coding ,Radio frequency and optical modulation, Demodulation and detection , Filtering	1 1 1 2 1	

	Conducting and Guided wave media	1			
	Finite state channel models, Methodology for simulating Communication systems operating over Fading Channels.	4			
	Estimation of parameters in simulation: Quality of an estimator, Estimating the average level of a waveform,	3			
IV	Estimating the average power of a waveform, Estimating the power spectral density of a process	2	15		
	Estimating Delay and Phase.	2			
	SECOND INTERNAL EXAM				
	Estimation of performance measures from simulation: Estimation of SNR	3			
V	Estimating Performance measures for digital systems-The Monte Carlo Method	2	20		
	Importance sampling method	2			
	Analysis of simulation results: Model Verification Techniques, Model Validation Techniques	3	20		
VI	Transient Removal, Terminating Simulations	2			
	Stopping Criteria, Variance Reduction	2			
	END SEMESTER EXAM				

COURS					EAR OF	
CODE	2	COURSE NAME	L-T-P-C	INTR	ODUCTION	
EC364		COMPUTER VISION	3-0-0-3		2015	
-		A204 Probability, Random Processes and Numeri	cal Methods,	EC301 I	Digital Signal	
Processing						
Course ob	-					
		v image processing techniques for computer vision	1			
		stand shape and region analysis stand three-dimensional image analysis techniques	and motion a	nolucio		
		some applications of computer vision algorithms	and motion a	narysis		
	•	uce methods and concepts which will enable the s	tudent to impl	ement co	mnuter	
		stems with emphasis on applications and problem		ement eo	inputer	
Syllabus:	on oje					
÷	Imag	e processing operations, Image formation mod	els. Image p	ocessing	and feature	
	-	on Estimation, Shape representation and Object rec		0		
Expected of			0			
The studen						
1. Imp	olemer	nt fundamental image processing techniques requir	red for compu	ter vision	L	
2. Per	form s	hape analysis and boundary tracking techniques	Ĩ			
3. Imp	olemer	nt motion related techniques				
4. To	develo	op applications using computer vision techniques				
Text Book						
	-	outer Vision - A modern approach, by D. Forsyth a	ind J. Ponce, F	Prentice H	Iall,2002	
		t Vision, B. K. P. Horn, McGraw-Hill,1986				
References				2012		
		ries, Computer & Machine Vision, Fourth Edition,				
	ss, 201	D. Prince, Computer Vision: Models, Learning, a	nd interence,	Cambridg	ge University	
	· ·	ki, Computer Vision: Algorithms and Applications	Springer 201	1		
J. R. (5201151	Course Plan	, opinger 201	. 1		
Module		Course content			Sem.	
1.1000010				Hours	Exam	
					Marks	
	Revie	ew of image processing techniques : filtering, three	esholding	1		
	Math	ematical morphology, Texture		1		
Ι		ry shape analysis, connectedness, object labelling	and		15	
	coun		unu	2		
		idary descriptors		1		
	Monocular and binocular imaging system 2					
Π		ographic & Perspective Projection		2	15	
11		era models		2	10	
	Cuill			L		

	Camera Calibration, Stereo vision: introduction; concept of disparity and its relationship with depth	3	
	FIRST INTERNAL EXAM		
	Image Processing for Feature Detection and Image Synthesis, Edge detection	1	
III	Corner detection, Harris corner detection algorithm, Line and curve detection, Hough transform	3	15
	SIFT operator, Mosaics, snakes	2	
	Shape from X - Shape from shading, Photometric stereo, Texture, Occluding contour detection.	3	
IV	Motion Analysis- Regularization theory,Optical Flow: brightness constancy equation, aperture problem, Horn-Shunck method, Lucas-Kanade method	4	15
	Structure from motion.	2	
	SECOND INTERNAL EXAM		
	Object recognition: Hough transforms and other simple object recognition methods	3	
V	Shape correspondence and shape matching ,Principal Component Analysis	3	20
	Shape priors for recognition	1	
VI	Application: Photo album, Face detection, Face recognition, Eigen faces, Active appearance and 3D shape models of faces	3	20
VI	Application: In-vehicle vision system: locating roadway, road markings, identifying road signs, locating pedestrians	3	20
	END SEMESTER EXAM		

COURSE	COURSE NAME L-T-P		AR OF
CODE			DUCTION
EC366 Proroquisit	REAL TIME OPERATING SYSTEMS3-0-0te: EC206 Computer Organization	3 2	015
rrerequisi	e: EC200 Computer Organization		
Course obj	ectives:		
	understand the basics of operating systems tasks and basic (elop these to RTOS)S architecture	s and
• To t	inderstand concepts of task scheduling		
• To t	inderstand problems and issues related with multitasking		
• To l	earn strategies to interface memory and I/O with RTOS kee	nels	
	mpart skills necessary to develop software for embedded co- time operating system.	omputer system	ns using a
Syllabus:	unie operating system.		
•	n to OS and RTOS, Process management of OS/RTOS,	Process Synch	ronization.
	d I/O management, Applications of RTOS		,
2. C.M References 1. 2 2. 7 3. 1 4. 1	Wayne Wolf, Computers as Components: Principles of Emb System Design, 2/e, Kindle Publishers,2005. Tanenbaum, Modern Operating Systems, 3/e, Pearson Edition Real-Time Embedded Components and Systems: With Line (Engineering) by Sam Siewert, John Pratt ,2015 Micro C/OS-II, The Real Time Kernel, CMP Books, Jean J VxWorks: Programmer's Guide 5.4, Windriver, 1999	oedded Comput on, 2007. ux and RTOS	ting
	Course Plan		
Module	Course content (42 hrs)	Hours	Sem. Exam Marks
	Operating system objectives and functions, Virtual Computers, Interaction of O. S. & hardware architecture, Evolution of operating systems	2	
Ι	Architecture of OS (Monolithic, Microkernel, Layered, Exkernel and Hybrid kernel structures)	3	15
	Batch, Multi programming, Multitasking, Multiuser, paral distributed & real –time O.S.	lel, 3	

		-	
	Uniprocessor Scheduling: Types of scheduling	2	
п	Scheduling algorithms: FCFS, SJF, Priority, Round Robin,	3	15
	UNIX Multi-level feedback queue scheduling, Thread Scheduling, Multiprocessor Scheduling concept	3	15
	Concurrency: Principles of Concurrency, Mutual Exclusion H/W Support, software approaches, Semaphores and Mutex, Message Passing techniques	2	
III	Classical Problems of Synchronization: Readers-Writers Problem, Producer Consumer Problem, Dining Philosopher problem.	3	15
	Deadlock: Principles of deadlock, Deadlock Prevention, Deadlock Avoidance, Deadlock Detection, An Integrated Deadlock Strategies.	3	
	Memory Management requirements, Memory partitioning: Fixed, dynamic, partitioning	2	
IV	Memory allocation Strategies (First Fit, Best Fit, Worst Fit, Next Fit), Fragmentation, Swapping, Segmentation, Paging, Virtual Memory, Demand paging	3	15
	Page Replacement Policies (FIFO, LRU, Optimal, clock), Thrashing, Working Set Model	2	
v	I/O Management and Disk Scheduling: I/O Devices, Organization of I/O functions	2	20
	Operating System Design issues, I/O Buffering, Disk Scheduling (FCFS, SCAN, C-SCAN, SSTF), Disk Caches	3	20
VI	Comparison and study of RTOS: Vxworks and µCOS	3	
VI	Case studies: RTOS for Control Systems.	3	20

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF IN	NTRODU	CTION
EC368	ROBOTICS	3-0-0 -3		2015	
-	ower Electronics &Inst	rumentation,	EC305 Mi	icroprocess	sors &
Microcontrollers					
Course objectives:					
To impart knowled	dge about the engineering as	pects of Rob	ots and their ap	plications.	
application, classification systems and actuators, Sp Stepper motor, Servo mo speed control using PWM processing techniques, kin kinematics for all serial Programming, Industrial a Robotics. Expected outcome: • On completion of	duction, anatomy, Robot sp of robots. Robotic arm, Specification, principle of op- otor and brushless DC moto M and direction control usi nematics, inverse kinematic manipulators, Digital and F applications of Robots, Mob	ensors, Enco eration and a or, Micropro ng H- Bridg s, Velocity k Programmabl- ile robots, M	oders, Tachome reas of applica cessor control e, Robotic visi inematics, App e Logic (PLC) icrobots , Rece	eters,Robot tion of: DO of electric on systems lication of controllers nt develop	tic drive C motor, motors, s, Image velocity s. Robot ments in
and their application	ons ble to analyse and design rol	otic structur	20		
Text Books:	ore to unaryse and design for				
2. Mikell and G Applications,McG	agar, Robot Dynamics and G roover, Industrial Robo araw Hill, 2e,2012 troduction to Robotics. Ana	tics – T	echnology, P	rogrammir	e
 Approach,PHI,200 2. Fu, K.S,Gonzalez McGraw-Hill,198' 3. John. J.Craig, Intra 4. Robert J. Schilling 5. S. R. Deb, Roboti 1994. 6. Ashitava Ghosal, 1 	z,R.C,Lee, C.S.G.,Robotics	, Control, S anics and Co : Analysis & e Automation	ensing, Vision ntrol, PHI, 2005 Control, Pearso n, Tata McGrav	and Inte 5. on Education w Hill, Nev	lligence, on,2000 w Delhi,
2006	Course Plan				
Module	Course content (4	12 hrs)			Sem.
	Course content (-	1 111 5 <i>)</i>		Hours	Exam Marks

Ι	Introduction – Definition and origin of robotics, Robot Anatomy, Robot specifications, Robot characteristics – accuracy, precision, repeatability, Areas of application, classification of robots. Robotic arm – Components and structure, Types of joints and workspace, Common kinematic arrangements, Wrists, End effectors- classifications, tools and grippers.	7	15
II	 Sensors: Types and applications of sensors in Robotics, position and displacement sensors, Tactile sensors, Proximity and Range Sensors, Strain gauge based force-torque sensors, Encoders, Tachometers. Robotic drive systems and actuators: Hydraulic, Pneumatic and Electric drives. Specification, principle of operation and areas of application of: DC motor, Stepper motor, Servo motor and brushless DC motor. Microprocessor control of electric motors, speed control using PWM and direction control using H- Bridge. 	б	15
	FIRST INTERNAL EXAM		
ш	 Robotic vision systems: Imaging, Sensing and Digitization, Image processing techniques, Areas of application in robotics and future scope. Introduction to kinematics: Position and orientation of objects, Rotation, Euler angles, Rigid motion representation using Homogenous Transformation matrix. 	7	15
IV	Forward kinematics: Link coordinates, Denavit-Hartenberg Representation, Application of DH convention to different serial kinematic arrangements fitted with spherical wrist. Inverse kinematics – General properties of solutions, Kinematic Decoupling, Inverse kinematic solutions for all basic types of three- link robotic arms fitted with a spherical wrist.	10	15
	SECOND INTERNAL EXAM		
V	 Velocity kinematics – Derivation of the Jacobian, Application of velocity kinematics for all serial manipulators, importance of Singularities. Manipulator Dynamics. Introduction to Legrangian mechanics and Dynamic equation for 2 DOF robots, Introduction to position control and force control of robotic manipulators, Robot actuation and control using PID, Digital and Programmable Logic (PLC) controllers. 	5	20
VI	Robot Programming – Programming methods, Robot language classification, Robot language structure, elements and its functions. Motion, End-effecter and Sensor commands in VAL programming language. Simple programs. Industrial applications of Robots in Material handling, Machine loading and unloading, Assembly and spray painting. Mobile robots, Microbots , Recent developments in Robotics.END SEMESTER EXAM	7	20

COURSE			YEA	
CODE	COURSE NAME	L-T-P-C	INTROD	
EC 370	DIGITAL IMAGE PROCESSING	3-0-0 -3	20	-
-	te: MA204 Probability, Random Processes and Nu	merical Me	thods, EC3)1 Digital
Signal Proc	-			
Course ob	•	C	с ·	
	study the image fundamentals and mathematical transform	istorms nece	essary for in	nage
	study the image enhancement techniques study image restoration procedures			
	study image compression procedures			
	study image compression procedures	חוופג		
Syllabus:	study image segmentation and representation teening	Jues		
•	age fundamentals, 2D Transforms, Image enhance	mont Imag	a restoratio	n Imaga
0	on, Image compression	mem, mag		m, mage
Expected of				
-	t should able to:			
		and math	amatical 4	
	 Distinguish / Analyse the various concepts necessary for image processing 	and mau	lematical t	ransionis
	 Differentiate and interpret the various image enh 	ancement te	chniques	
	3. Illustrate image segmentation algorithm		enniques	
	4. Analyse basic image compression techniques			
Text Book				
1. I.Go	onzalez Rafel C, Digital image Processing, Pearson l	Education, 2	009	
2. S Ja	yaraman, S Esakkirajan, Digital image processing, J	Fata Mc Gra	w Hill,2015	5
References	:			
1. Fun	damentals of digital image processing: Jain Anil K,	PHI,1988		
	ital image processing : Kenneth R Castleman, Pears		n,2e,2003	
3. Dig	ital Image Processing: Pratt William K, John Wiley	,4e,2007		
	Course Plan			
Module	Course content (42 hrs)			Sem.
			Hours	Exam
				Marks
	Image representation, basic relationship between pix			
	of DIP system, elements of visual perception-simple	e image	3	
	formation modelIVidicon and Digital Camera working principles1			
L –	brightness, contrast, hue, saturation, mach band effe		1	
	colour image fundamentals-RGB, CMY, HIS	models, 2	D 2	
	sampling, quantization.		~	
	Review of matrix theory, row and column ordering-	Toeplitz,	2	
	Circulant and block matrix,			15
	2D transforms - DFT, its properties, Walsh transform	n, Hadamar	d 3	

	transform, Haar transform,		
	DCT, KL transform and Singular Value Decomposition.		
	FIRST INTERNAL EXAM		
	Spatial domain methods: point processing- intensity transformations, histogram processing, image subtraction, image averaging	3	
III	Spatial filtering- smoothing filters, sharpening filters	1	15
	Frequency domain methods: low pass filtering, high pass filtering, homomorphic filter.	2	
	Degradation model, Unconstraint restoration- Lagrange multiplier and constraint restoration	2	
IV	IV inverse filtering- removal of blur caused by uniform linear motion, Weiner filtering,		15
	Geometric transformations-spatial transformations	2	
	SECOND INTERNAL EXAM		
	Classification of Image segmentation techniques, region approach, clustering techniques	2	
V	segmentation based on thresholding, edge based segmentation	2	20
	classification of edges, edge detection, hough transform, active contour	3	
VI	need for compression, redundancy, classification of image compression schemes, Huffman coding, arithmetic coding, dictionary based compression, transform based compression,	5	20
	Image compression standards- JPEG& MPEG, vector quantization, wavelet based image compression.	3	
	END SEMESTER EXAM		

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC332	COMMUNICATION ENGG LAB (ANALOG & DIGITAL)	0-0-3-1	2015
Prerequisite:			
U	Integrated Circuit, EC208 Analog Comm	unication Engine	eering, EC302 Digital
Communication.			
Course obje	ience on design, testing, and analysis of few	electronic circui	ts used for
communication e	· · ·	cicculonic circul	
List of Experim			
Cycle I (Six ma			
•	on using discrete components.		
-	ultiplier IC AD534 or AD633.		
	n using envelope detector.		
4. IF tuned am	olifier.		
5. FM using 55	5 IC.		
6. FM generati	on and demodulation using PLL.		
7. Frequency n	nultiplier using PLL		
8. Pre-emphasi	s and de-emphasis circuits		
9. Analog sign	al sampling & Reconstruction		
Cycle II (Six ma	andatory)		
10. Generation of	of Pseudo Noise Binary sequence using Shift	t registers	
11. Time Division	on Multiplexing and Demultiplexing		
12. Generation &	& Detection of DM/SIGMA DELTA/ ADM		
13. Generation &	& Detection of PAM/PWM/PPM		
14. Generation &	& Detection of BPSK/DPSK/DEPSK		
	& Detection of PCM		
16. 16 QPSK M	odulation and Demodulation		
Expected outcom	ne:		
The student shou	ld able to:		
1. Understar	nd the basic concepts of circuits used in com	munication syste	m

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION			
EC 334	MICROCONTROLLER LAB	0-0-3-1	2015			
Prerequisite: EC305 Micror	processors & Microcontrollers					
Course objectives:						
	lerstand Assembly Language/embeddec	1 C programm	ing of Microcontroller			
	erface simple peripheral devices to a Mi	1 0	•			
	ip student groups to design and implem					
List of Experi						
-	g experiments using 8051 simulator (1	KEIL).				
)*				
	on and subtraction.					
-	lication and division.					
	lication by shift and add method.					
	on of series of 8 bit binary and decimal	numbers.				
	ction of 2 decimal numbers.					
-	g of a series of 8 bit numbers.					
_	lication by shift and add method.					
	nd HCF of two 8 bit numbers.					
9. Matrix	addition					
Interface exp	eriments - Direct down loading the p	rograms fron	n Personal computer.			
1. Display	y (LED, Seven segments, LCD) interfa	ce.				
	l interfacing I/O ports (Matrix keyboard					
3. ADC in	nterface.					
4. DAC in	nterface with wave form generation.					
5. Steppe	r motor interface.					
6. Relay i						
	communication with PC					
	cing with serial EEPROM					
	mmunication with 8051: Read, write an	nd validate dat	a from a serial EPROM or I2C based			
-	ature sensor etc.					
-	e project work including multiple periph	neral interface	s.			
Expected out						
The student sh	ould able to:					
e	m Micro controllers.					
	ce various peripheral devices to Micro					
3. Function	on effectively as an individual and in a	team to accon	plish the given task.			

COURSE CODE	COURSE NAME	L-T-P-C		AR OF DUCTION
EC401 Prerequisite	INFORMATION THEORY & CODI	NG 4-0-0-4	2	015
-	bility, Random Processes and Numerical Met	hods.EC302 Digital Co	ommunicati	on
Course obje	•			
•	derstand the concept of information			
	derstand the limits of error free representation	of information signals	and the tran	smission
	h signals over a noisy channel			
	sign and analyze data compression techniques			
	lerstand the concept of various theorems prop ession and reliable transmission	osed by Shannon for el	ficient data	
	ve idea on the different coding techniques for the	reliable data transmissi	on	
	sign an optimum decoder for various coding so		on	
	ncept of amount of information, Entropy, S		l Capacity.	Shannon's
	Distortion Theory, Channel Coding, Linear			
	l Codes, Viterbi Algorithm			
Expected ou				
	the course, students will be able to	1 1 01		1 0
	the knowledge of Shannon's source coding		el coding 1	heorem for
	ing an efficient and error free communication ve various coding schemes	link.		
	an optimum decoder for various coding sche	mes used		
Text Books:	an optimum deceder for various county sene	ines used.		
	mon Haykins: Digital Communication System	ns, Wiley India, 2013.		
	S.Sathya Narayana: Concepts of Information 7		aram	
Р	blications,2005			
References:				
	Information theory coding and cryptography,			2016
	itode, Information Theory and Coding, Techn			
	t & Suhov, Information theory and coding by		-	
	in & Daniel J. Costello.Jr., Error Control Codi entice Hall Inc., Englewood Cliffs, NJ, 2004	ng : Fundamentals and	Applicatio	ns,
,	. Denning, Cryptography and Data Security, A	Addison Wesley 1983		
	J.C Mackay, Information Theory, Inference a	-	s. Cambrid	ge.2005.
	Farrett, The mathematics of Coding Theory, Pr		is, cumoria	50,2000.
	ullick Chatterjee, Principles of Digital commu		rn Ltd, 198	6
	Course Plan			
				Sem.
Module	Course content (54 hrs)		Hours	Exam
				Marks
	roduction to Information Theory. Concept of			
	tropy, marginal, conditional and joint entropie	s, relation among	9	15
I entropies, mutual information, information rate. 9 Source coding: Instantaneous codes, construction of instantaneous				
C	urce coding. Instantaneous codes construction	n of instantaneous		

II	Noiseless coding theorem , construction of basic source codes, Shannon – Fano Algorithm, Huffman coding, Channel capacity – redundancy and efficiency of a channel, binary symmetric channel (BSC), Binary erasure channel (BEC) – capacity of band limited Gaussian channels	9	
	FIRST INTERNAL EXAM		
ш	Continuous Sources and Channels: Differential Entropy, Mutual information, Waveform channels, Gaussian channels, Shannon – Hartley theorem, bandwidth, SNR trade off, capacity of a channel of infinite bandwidth, Shannon's limit	9	15
IV	Introduction to rings, fields, and Galois fields. Codes for error detection and correction – parity check coding – linear block codes – error detecting and correcting capabilities – generator and parity check matrices – Standard array and syndrome decoding –	9	15
V	Perfect codes, Hamming codes, encoding and decoding Cyclic codes, polynomial and matrix descriptions, generation of cyclic codes, decoding of cyclic codes BCH codes, Construction and decoding, Reed Solomon codes	9	20
VI	Convolutional Codes – encoding – time and frequency domain approaches, State Tree & Trellis diagrams – transfer function and minimum free distance – Maximum likelihood decoding of convolutional codes – The Viterbi Algorithm. Sequential decoding.	9	20
	END SEMESTER EXAM		

COURS CODE		COURSE NAME	L-T-P-C		AR OF DUCTION
EC403		MICROWAVE & RADAR ENGINEERING	3-0-0-3		015
Prerequis			5-0-0-5		015
-		Electromagnetic Theory, EC306 Antenna & Wave	Propagation		
Course ob	•				
	•	various microwave sources, their principle of oper-	ation and measur	rement of	various
parame 2. To stud		various microwave hybrid circuits and formulate th	hair S matricas		
	study the various microwave hybrid circuits and formulate their S matrices. understand the basic concepts, types, working of radar and introduce to radar transmitters and				
receive					
Syllabus:					
		troduction, advantages, Cavity Resonators, Micr		• •	
		n Amplifiers, Reflex Klystron Oscillators, Magnetr			
		surements, Microwave hybrid circuits, Direction	· · · · ·	olid state	microwave
Expected		odes, Radar, MTI Radar, Radar Transmitters, Rada	ii receivers.		
-		course, students will be able to understand the bas	ics of microway	e engineer	ing and
radar syste				••••8•••••	
Text Book	s:				
		7. Liao, Microwave Devices and Circuits, 3/e, Pears			
		Skolnik, Introduction to Radar Systems,3/e, Tata M	AcGraw Hill , 20	08.	
Reference					
		rowave Engineering , 3e, McGraw Hill Education 1			
		M, Microwave and Radar Engineering, 4/e, Umesh Collin, Foundation of Microwave Engineering, 2/e			
		rowave Engineering, 2/e, PHI, 2012.	e, whey man, 2	012.	
		Pozar, Microwave Engineering,4/e, Wiley India,	2012.		
-		N. S., Elements of Electronic Navigation, 2/e, Tata		2001.	
		Mitra, Microwave Semiconductor Devices, PHI, 20			
		S. N., Microwave Engineering, I.K. International, 24 Aicrowave Engineering 1e, McGraw Hill Education			
<i>9</i> . vas	JUKI, N	Course Plan	1 maia, 2015		
lT					Sem.
Module		Course content (42hrs)		Hours	Exam
					Marks
		owaves: introduction, advantages, Cavity Resonate			
		angular and Circular wave guide resonators- Deriva	ition of	4	
Ι		ance frequency of Rectangular cavity.	Visite		
		owave vacuum type amplifiers and sour	•	Λ	15
	-	lifiers - Re-entrant cavities, Velocity modulat	uon, Bunching	4	
		iding analysis), Output power and beam loading. X Klystron Oscillators : Derivation of Power output	ut efficiency		
II	NCHE	A INITIAL OSCILLATORS. DELIVATION OF FOWER OULP	ai, emerency	2	

	Magnetron oscillators - Cylindrical magnetron, Cyclotron angular frequency, Power output and efficiency.	3	
	FIRST INTERNAL EXAM		
III	Travelling Wave Tube - Slow wave structures, Helix TWT, Amplification process, Derivation of convection current, axial electric field, wave modes and gain.	4	15
	Microwave measurements – Measurement of impedance, frequency and power	2	
IV	Microwave hybrid circuits – Scattering parameters, Waveguide tees- Magic tees, Hybrid rings, Corners, Bends, and Twists. Formulation of S-matrix.	5	15
	Directional couplers : Two hole directional couplers, S-matrix of a directional coupler. Circulators and isolators.	4	
V	Solid state microwave devices – Microwave bipolar transistors, Physical structures, Power frequency limitations equivalent circuit. Principle of Tunnel diodes and tunnel diode oscillators.	4	20
	Gunn diodes – Different modes, Principle of operation Gunn Diode Oscillators.	2	
VI	 Radar: The simple Radar equation. Pulse Radar, CW Radar, CW Radar with non zero IF, Equation for doppler frequency FM-CW Radar using sideband super heterodyne receiver. MTI Radar-Delay line canceller, MTI Radar with power amplifier & power oscillator, Non coherent MTI Radar, Pulse Doppler Radar 	5	20
	Radar Transmitters. Radar Modulator-Block diagram, Radar receivers- noise figure, low noise front ends, Mixers, Radar	3	
	END SEMESTER EXAM		

Note:- Analysis is not required in this course

Question Paper

COURSE			YEA	AR OF
CODE	COURSE NAME	L-T-P-C		DUCTION
EC405	OPTICAL COMMUNICATION	3-0-0-3	2	015
Prerequisite:	•			
	ate Devices. EC205 Electronic Circuits			
Course objectiv				
	nderstand the concept of light transmission through	1		
	nderstand the concept of optical sources and detect		1	
	nderstand the performance comparison of various nderstand the working of optical components.	optical transmissi	on scheme	2 S .
	nderstand the principle of operation of optical amp	lifiers		
	nderstand WDM technique.			
0. 10 u	nderstand while teeningde.			
	allight wave system, advantages ,classification of 1			
	ffects in fibres, Fibre materials, fabrication of fibre	· •		
-	s, Optical receivers, Digital transmission systems,		rs, WDM (concept,
	free space optics, Optical Time Domain Reflectom	eter (OIDR).		
Expected outco	e course, students will be able to:-			
	e working of optical source and detectors.			
	the performance of various optical modulation sc	hemes		
	e knowledge of optical amplifiers in the design of			
	the performance of optical amplifiers.	optical link.		
	e concept of WDM			
	the principle of FSO and LiFi.			
Text Books:	· ·			
1. Gerd Ke	iser: Optical Fiber Communications,5/e,McGraw H	Hill, 2013.		
2. Mishra a	nd Ugale, Fiberoptic Communication, Wiley, 2013			
References:				
1. Joseph C	2. Palais – Fiber Optic Communications, 5/e Pearso	on, 2013.		
2. John M.	Senior- Optical communications, 3/e, Pearson, 200	9.		
,	Optical fiber communication, Elsavier, 2014			
	arthi,Optical Fiber Communicatio, McGraw Hill, 2			
	, Scheiner, Fiberoptic Communication Technolog			
• 1	adhay, Optical communicatoion and networks.PH			
	iber optics and optoelectronics, Oxford university	-		2
	mar sarkar, Optical fibers and fiberoptic communic	•		
	Optical Communication Essentials (SIE), 1e McG			m, 2008
-	am, Optical communication and sensors, Anuradha gal, Optical Fiber Communications Principles and	-		[nivo
Press, 20		Applications, Ca	inonage C	mversity
r1ess, 20				
I	Course Plan		_	~
Module	Course content (42hrs)		Hours	Sem. Exam Marks

Generallight wave system, advantages, classification of light wave systems. Fibres: types and refractive index profiles, mode theory of		
I fibres: modes in SI and GI fibres, linear and non linear effects in fibres, dispersion, Group Velocity Dispersion, modal, wave guide and Polarization Mode	8	
Dispersion, attenuation- absorption, bending and scattering losses.Fibre materials, fabrication of fibres, photonic crystal fibre, index guiding PCF, photonic bandgap fibre, fibre cables.Optical sources, LEDs and LDs, structures, characteristics, modulators using LEDs and LDs. coupling with fibres, noise in Laser diodes, Amplified Spontaneous Emission noise, effects of Laser diode noise 	7	15
FIRST INTERNAL EXAM		
IIIOptical detectors, types and characteristics, structure and working of PIN and AP, noise in detectors, comparison of performance. Optical receivers, Ideal photo receiver and quantum limit of detection.	6	15
 IV Digital transmission systems, design of IMDD links- power and rise time budgets, coherent Systems, sensitivity of a coherent receiver, comparison with IMDD systems. Introduction to soliton transmission, soliton links using optical amplifiers, GH effect, soliton-soliton interaction, amplifier gain fluctuations, and design guide lines of soliton based links. 	8	15
V Optical Amplifiers ,basic concept, applications, types, doped fibre amplifiers, EDFA, basic theory, structure and working, Semiconductor laser amplifier, Raman amplifiers, TDFA, amplifier configurations, performance comparison.	6	20
VIThe WDM concept, WDM standards, WDM components, couplers, splitters, Add/ Drop multiplexers, gratings, tunable filters, system performance parameters. Introduction to optical networks. Introduction to free space optics, LiFi technology and VLC.Optical Time Domain Reflectometer (OTDR) – fault detection, length and refractive index measurements.	7	20
END SEMESTER EXAM		

COURSE			YEA	R OF
CODE	COURSE NAME	L-T-P-C	INTROD	UCTION
EC 407	COMPUTER COMMUNICATION	3-0-0-3	20	15
Prerequisit		5-0-0-5	20	13
-				
Course obje		and how data as	mmunicatio	n 00001 m 0
	stand the basic concepts of computer network a computer network.	and now data co	mmumcatio	II occurs
e	•	d in implementi	ng coouro n	atruorly
	uce students to the fundamental techniques use	-	-	etwork
	cations, and give them an understanding of con			NT - 4
	Introduction to computer communication			Networks,
	on of Networks: Internetwork, Network mod hysical Layer, Data Link Layer, Media access			
0	eless LAN(802.11), Virtual LAN, Networkin			0
	ess mapping, Subnetting, CIDR, ICMP, IGM			0
	Control & Quality of Service, Application Lay			
	urity attacks, security services and mechanism			
	trusion detection, IDS, Malicious software and			
	countermeasures, denial of service attacks, Ha		-	
Expected or	tcome:			
On completi	on of this course, the students will have a thoro	ugh understandi	ng of:	
• Diffe	rent types of network topologies and protocols			
	ayers of the OSI model and TCP/IP with their t	functions		
	concept of subnetting and routing mechanisms.			
	basic protocols of computer networks, and how	they can be use	d to assist in	network
-	n and implementation.			
	ity aspects in designing a secure computer con	nmunication syst	tem.	
Text Books				TT'11
1. Data 2006	Communications and Networking, 4/e, Behrou	z A Forouzan, I	ata McGraw	'-H111,
	ography & Network Security, Behrouz A. For	ouzan IV Editic	n Tata McC	raw_Hill
2. Cryp 2008	ography & Network Security, Demouz A. For			1111, ¹
References:				
	Peterson and Bruce S Davie: Computer Netwo	ork- A System A	pproach, 4/e	e, Elsevier
•	2011.	·		
2. JFK	urose, Computer Network A Topdown Approa	ch Featuring the	Internet,3/e	,Pearson
	ation, 2010			
	hav: An Engineering Approach to Computer N			
•	ut S.Godbole Data Communication and Netwo Delhi,2011	rking,2e, McGra	ıw –Hill Edi	ication
	Course Plan			
Module	Course content (42 hrs)			Sem.
			Hours	Exam
				Marks

Ι	Introduction to computer communication:		15
1	Transmission modes- serial and parallel transmission,		13
	asynchronous, synchronous, simplex, half duplex, full duplex	2	
	communication.		
	Switching: circuit switching and packet switching		
	Networks: Network criteria, physical structures, network	2	
	models, categories of networks, Interconnection of Networks:	2	
	Internetwork		
	Network models: Layered tasks, OSI model, Layers in OSI	2	
	model, TCP/IP protocol suite.		
II	Physical Layer: Guided and unguided transmission media	2	15
	(Co-axial cable, UTP,STP, Fiber optic cable)		
	Data Link Layer: Framing, Flow control(stop and wait, sliding	2	
	window flow control)		
	Error control, Error detection(check sum, CRC), Bit stuffing,	2	
	HDLC		_
	Media access control: Ethernet(802.3), CSMA/CD, Logical link control, Wireless LAN(802.11), CSMA/CA	2	
	FIRST INTERNAL EXAM		
	Network Layer Logical addressing : IPv4 & IPV6,	2	15
		2	13
	Address Resolution protocols (ARP, RARP)	2	_
	Subnetting, Classless Routing(CIDR), ICMP,IGMP,DHCP	3	
III	Virtual LAN, Networking devices (Hubs, Bridges & Switches)	1	
IV	Routing: Routing and Forwarding, Static routing and Dynamic	1	15
	routing		
	Routing Algorithms: Distance vector routing algorithm, Link	2	
	state routing(Dijkstra's algorithm)		
	Routing Protocols: Routing Information protocol(RIP), Open	3	
	Shortest Path First(OSPF), Border Gateway Protocol(BGP),	5	
	MPLS		
	SECOND INTERNAL EXAM	1	20
T 7		1	20
V	Transport Layer –UDP, TCP	1	20
V			
V	Congestion Control & Quality of Service – Data traffic,	4	
V	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop &		
V	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop & Congestion control in TCP), QoS and Flow Characteristics	4	_
V	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop &		_
V VI	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop & Congestion control in TCP), QoS and Flow Characteristics Application Layer – DNS, Remote Logging (Telnet), SMTP,	4	20
	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop & Congestion control in TCP), QoS and Flow Characteristics Application Layer – DNS, Remote Logging (Telnet), SMTP, FTP, WWW, HTTP,POP3,MIME, SNMP Introduction to information system security, common attacks	4 3 1	-
	Congestion Control & Quality of Service – Data traffic, Congestion, Congestion Control (Open Loop, Closed Loop & Congestion control in TCP), QoS and Flow Characteristics Application Layer – DNS, Remote Logging (Telnet), SMTP, FTP, WWW, HTTP,POP3,MIME, SNMP	4	-

Defense and counter measures: Firewalls and their types. DMZ, Limitations of firewalls, Intrusion Detection Systems - Host based, Network based, and Hybrid IDSs	2			
END SEMESTER EXAM				

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC409	CONTROL SYSTEMS	3-0-0-3	2015

Prerequisite:

MA 101 Calculus, MA102 Differential Equations, MA201 Linear Algebra & Complex Analysis, MA204 Probability, Random Processes and Numerical Methods, EC202 Signals & Systems

Course objectives:

- To introduce the elements of control system and their modeling the system
- To introduce methods for analyzing the time response, the frequency response and the stability of systems.
- To design control systems with compensating techniques.
- To introduce the state variable analysis method.
- To introduce basic concepts of digital control systems.

Syllabus: Control system, types and application, feedback system, mathematically modelling of control systems, block diagram representation, signal flow graph, Mason's formula, test signals, time response analysis, frequency analysis, stability concepts and analysis, state variable analysis, Observability and controllability, digital control systems, state space analysis, Jury's test

Expected outcome:

Students should be able to

- Represent mathematically a systems and deriving their transfer function model.
- Analyse the time response and frequency response of the systems for any input
- Find the stability of system
- Design a control system with suitable compensation techniques
- Analyse a digital control system.

Text Books

- 1. Farid Golnaraghi, Benjamin C. Kuo, Automatic Control Systems, 9/e, Wiley India.
- 2. Ogata K., Discrete-time Control Systems, 2/e, Pearson Education.
- 3. Gopal Control Systems, 4e, McGraw Hill Education India Education , 2012.

References

- 1. Norman S Nise ,Control System Engineering,5/e, Wiley India
- 2. Ogata K., Modern Control Engineering, Prentice Hall of India, 4/e, Pearson Education, 2002.
- 3. Richard C Dorf and Robert H Bishop, Modern Control Systems, 9/e, Pearson Education, 2001.
- 4. Gopal Digital Control and State Variable Method, 4e, McGraw Hill Education India 2012.

Course Plan			
Module	Course content (42 hrs)	Hours	Marks
I	Basic Components of a Control System, Applications, Open-Loop Control Systems and Closed-Loop Control Systems	1	15
	Effects of Feedback on Overall Gain, Stability, External, Disturbance or Noise,	1	

	Types of Feedback Control Systems, Linear versus Nonlinear Control	1	
	Systems ,Time-Invariant versus Time-Varying Systems .Overview of solving differential equations using Laplace transforms	1	-
	Mathematical modeling of control systems - Mechanical and electromechanical systems.	2	
	Block diagram representation and reduction methods Signal flow graph and Mason's rule formula.	22	-
II	Signal now graph and mason state formula. Standard test signals. Time response specifications. Time response of first and second order systems to unit step input, ramp inputs. time domain specifications	$\frac{1}{2}$	15
	Steady state error and static error coefficients. Dynamic error coefficient and its evaluation.	1	_
	FIRST INTERNAL EXAM	1	
TTT	Stability of linear control systems: methods of determining stability, Routh's Hurwitz Criterion.	2	
III	Root Locus Technique: Introduction, properties and its construction.Frequency domain analysis: Frequency domain specifications,	2	15
	correlation between time and frequency responses.Nyquist stability criterion: fundamentals and analysis	2	_
IV	Relative stability: gain margin and phase margin. Stability analysis with Bode plot.	2	1.7
	Design of Control Systems: PD and PI controllers Design with phase-lead and phase-lag controllers (frequency domain	2 2	- 15
	approach). SECOND INTERNAL EXAM		
	State variable analysis: state transition matrix and equation, State	2	
V	space representation of Continuous Time systems Transfer function from State Variable Representation, Solutions of	2	20
	the state equations Concepts of Controllability and Observability Kalman Test	2	_
	Discrete Control systems fundamentals: Overview of Z transforms. State space representation for Discrete time systems.	2	
VI	Sampled Data control systems ,Sampling Theorem, Sample & Hold, Open loop & Closed loop sampled data systems.	2	20
	State space analysis : Solving discrete time state space equations, pulse transfer function, Discretization of continuous time state space equations	3	
	Stability analysis of discrete time systems Jury's test	1	
	END SEMESTER EXAM		

COURS		LTDC		EAR OF
CODE		L-T-P-C	INTR	ODUCTION
EC461		3-0-0-3		2015
Prerequisi	crowave & Radar Engineering			
Course ob				
	study microwave semiconductor devices & applications.			
	study microwave sources and amplifiers.			
	analyse microwave networks			
• To	introduce microwave integrated circuits			
Syllabus:	-			
generation Microwave filters, Fil Introduction Expected Students sl microwave Text Book 1. Sar 2. Rol 3. Dav Reference 1. Bha Inte	nould be able to understand with active & passive microve communication systems and analyse microwave networks: nuel Y. Liao, Microwave Devices and Circuits, 3/e, Pear bert E. Collin, Foundation of Microwave Engineering, 2/ vid M. Pozar, Microwave Engineering,4/e, Wiley India,	es, Bipolar t sis, Signal flo insformation ted circuits, D wave devices of tks. rson Education (e, Wiley India 2012 mission Lines	n, 2003.	s, MESFET, s, Microwave plementation, rol devices nents used in
	Maloratsky, Passive RF and Microwave Integrated Circuits, BSI		, 2006.	
	Course Plan			
Module	Course content		Hours	Sem. Exam Marks
	Introduction, Characteristic, features of microwaves, Li conventional solid state devices at Microwave.		1	
Ι	Gunn – effect diodes – Gunn effect, Ridley – Watkins- theory, Modes of operation, Limited space – Charge ac (LSA) mode of Gunn diode.		2	15
	Microwave generation and amplification. Structure, Op	peration.	•	
	Power output and efficiency of IMPATT and TRAPAT	T diodes	2	
	Power output and efficiency of IMPATT and TRAPAT Bipolar transistors – biasing, FET – biasing, MESFET Operation.	T diodes – Structure,	4	
п	Power output and efficiency of IMPATT and TRAPAT Bipolar transistors – biasing, FET – biasing, MESFET	T diodes – Structure, ain and		15

	FIRST INTERNAL EXAM			
Ш	Microwave Network Analysis – Equivalent voltages and currents, Impedance and Admittance matrices, Scattering matrix, The transmission matrix.	3	15	
111	Signal flow graphs. Impedance matching and tuning – Matching with lumped elements, Single stub tuning, Double stub tuning. Quarter wave transformer, Theory of small reflections.	4	15	
IV	Microwave filters – Periodic structures – Analysis of infinite periodic structures and terminated periodic structures, Filter design by image parameter method – Constant k, m-derived and composite. Filter design by insertion loss method. Filter transformation and implementation.	7	15	
SECOND INTERNAL EXAM				
X 7	Introduction to MIC's:-Technology of hybrid MICs, monolithis MICs. Comparison of both MICs.	4		
V	Planar transmission lines such as stripline, microstrip line, slotline etc	3	20	
VI	Distributed and lumped elements of integrated circuits – capacitors, inductors, resistors, terminations, attenuators, resonators and discontinuities.	5	20	
	Diode control devices – switches, attenuators, limiters. Diode phase shifter. Circulators and isolators.	2	-	
	END SEMESTER EXAM			

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 70 % for theory and 30% for logical/numerical problems, derivation and proof.

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC 361	Speech And Audio Signal Processing	3-0-0-3	2015
	C301 Digital Signal Processing		
Course objectiv			
	amiliarize the basic mechanism of speech pro	duction and learn	the basic concepts of
	nethods for speech analysis and parametric repre	1	
	et a overall picture about various applications o		-
	tudy of Perception of Sound, Psycho-acoustic	analysis, Spatial	Audio Perception and
	endering, tudu of Audio Commencian Schemes		
	tudy of Audio Compression Schemes	domoin on olymia (Constant an alexain LDC
	n production, Time domain analysis, Frequency		
• •	coding, Speech recognition, Speech enhanceme els of Audio Perception, Psycho-acoustic analys	· ·	0
	compression methods, Parametric Coding of N		
_	dio quality analysis.		o, mansform county of
Expected outco			
-	tand basic concepts of speech production	. speech analysis	s. speech coding and
	tric representation of speech and apply it in prac-		,
-	to develop systems for various applications of s		
	Signal processing models of sound perception		f perception models in
audio s	ignal processing.		
4. Acquire	e ability to implement audio compression algori	thms and standard	S.
Text Books:			
-	s O'Shaughnessy, Speech Communications	: Human & M	lachine, IEEE Press,
	ver 2nd edition, 1999; ISBN: 0780334493.		
	Morgan and Ben Gold, Speech and Audio Sign	-	cessing and Perception
*	and Music, July 1999, John Wiley & Sons, ISB	N: 04/135154/	
References:			
	Schafer, Digital Processing of Speech Signals, I		
	Juang, Fundamentals of Speech Recognition, Pr		
	Quatieri, Discrete-Time Speech Signal Processin	ig: Principles and	Practice, Prentice Hall;
	2942X; 1st edition Childers, Speech Processing and Synthesis Too	lhoved John Wil	au & Sana Santambar
	0471349593	nuoxes, joini wii	ey & sons, september
	l Processing and Coding, by Andreas Spanias, 7	Fed Painter and W	enkitterem Atti Wilev-
	publication, 2006		cirkittarani 73tti, winey-
	Guojun Lu; Kai Ming Ting; Dengsheng Zhan	g: . "A Survey o	f Audio-Based Music
•	n and Annotation," Multimedia, IEEE Transac		
	1109/TMM.2010.2098858	······································	, rr
7. Scaringella,	N.; Zoia, G.; Mlynek, D.; "Automatic genre cl	assification of mu	sic content: a survey,"
-	•	no.2, pp.133-1	-
	MSP.2006.1598089		
8. Loizou, P. (1	998). "Mimicking the human ear," IEEE Signa	l Processing Maga	zine, 15(5), 101-130.

Module	Course content (42hrs)	Hours	Sem. Exam Marks
Ι	Speech Production: Acoustic theory of speech production. Speech Analysis: Short-Time Speech Analysis, Time domain analysis (Short time energy, short time zero crossing Rate, ACF). Parametric representation of speech: AR Model, ARMA model. LPC Analysis (LPC model, Auto correlation method).	5 15	
II	Frequency domain analysis (Filter Banks, STFT, Spectrogram), Cepstral Analysis, MFCC. Fundamentals of Speech recognition and Text-to-speech conversion	8	
	FIRST INTERNAL EXAM		
III	Speech coding, speech enhancement, Speaker Verification, Language Identification	7	15
IV	Signal Processing Models of Audio Perception: Basic anatomy of hearing System. Auditory Filter Banks, Psycho-acoustic analysis: Critical Band Structure, Absolute Threshold of Hearing, Simultaneous Masking, Temporal Masking, Quantization Noise Shaping, MPEG psycho-acoustic model.	6	15
V	Audio compression methods: Sampling rate and bandwidth requirement for digital audio, Redundancy removal and perceptual irrelevancy removal, Transform coding of digital audio: MPEG2-AAC coding standard, MDCT and its properties, Pre-echo and pre-echo suppression, psycho-acoustic modelling, adaptive quantization and bit allocation methods, Loss less coding methods.	8	20
VI	Spatial Audio Perception and rendering: The physical and psycho- acoustical basis of sound localization and space perception. Spatial audio standards. Parametric Coding of Multi-channel audio: Mid- Side Stereo, Intensity Stereo, Binaural Cue Coding. Audio quality analysis: Objective analysis methods- PEAQ, Subjective analysis methods - MOS score, MUSHRA score	8	20
	END SEMESTER EXAM		

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 50 % for theory and 50% for logical/numerical problems, derivation and proof.

COURSE			
CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC465	MEMS	3-0-0 -3	2015

Prerequisite:NIL

Course objectives:

• To understand the operation of major classes of MEMS devices/systems

• To grasp the fundamentals of standard micro fabrication techniques and processes

• To understand the unique demands, environments and applications of MEMS devices

• To create interest for further study in this area

Syllabus:

MEMS and Microsystems applications, Review of Mechanical concepts, Actuation and Sensing techniques, Scaling laws in miniaturization, Materials for MEMS, Micro System fabrication techniques, Micro manufacturing, Micro system Packaging, Bonding techniques for MEMS, Overview of MEMS areas

Expected outcome:

The student should be able to:

- 1. Understand the working principles of micro sensors and actuators
- 2. Understand the application of scaling laws in the design of micro systems
- 3. Understand the typical materials used for fabrication of micro systems
- 4. Understand the principles of standard micro fabrication techniques
- 5. Appreciate the challenges in the design and fabrication of Micro systems

Text Books:

1. Tai-Ran Hsu, MEMS and Microsystems Design and Manufacture, TMH, 2002

2. Chang Liu, Foundations of MEMS, Pearson 2012

References:

- 1. Mark Madou, "Fundamentals of Micro fabrication", CRC Press, New York, 1997
- 2. Stephen D. Senturia, Microsystem design, Springer (India), 2006.
- 3. Chang C Y and Sze S M, "VLSI Technology", McGraw-Hill, New York, 2000
- 4. Julian W Gardner, "Microsensors: Principles and Applications", John Wiley & Sons, 1994
- 5. Thomas B. Jones, Electromechanics and MEMS, Cambridge University Press, 2001

	Course Plan		
Module	Course content (42hrs)	Hours	Sem. Exam Marks

MEMS and Microsystems: Applications – Multidisciplinary nature of MEMS – principles and examples of Micro sensors and micro actuators – micro accelerometer –comb drives - Micro grippers –micro motors, micro valves, micro pumps , Shape Memory Alloys.	4	
Review of Mechanical concepts: Stress, Strain, Modulus of Elasticity, yield strength, ultimate strength – General stress strain relations – compliance matrix. Overview of commonly used mechanical structures in MEMS - Beams, Cantilevers, Plates, Diaphragms – Typical applications	3	15
II Flexural beams: Types of Beams, longitudinal strain under pure bending – Deflection of beams – Spring constant of cantilever – Intrinsic stresses		15
Actuation and Sensing techniques : Thermal sensors and actuators, Electrostatic sensors and actuators , Piezoelectric sensors and actuators, magnetic actuators	4	15
FIRST INTERNAL EXAM		
Scaling laws in miniaturization - scaling in geometry, scaling in rigid body dynamics, Trimmer force scaling vector, scaling in electrostatic and electromagnetic forces, scaling in electricity and fluidic dynamics, scaling in heat conducting and heat convection.		15
Materials for MEMS – Silicon – Silicon compounds – Silicon Nitride, Silicon Dioxide, Silicon carbide, Poly Silicon, GaAs, Silicon Piezo resistors,	4	
Polymers in MEMS – SU-8, PMMA, PDMS, Langmuir – Blodgett Films, Micro System fabrication – Photolithography – Ion implantation- Diffusion – Oxidation – Chemicalvapour deposition – Etching	5	15
SECOND INTERNAL EXAM		
Overview of Micro manufacturing – Bulk micro manufacturing, Surface micro machining , LIGA process –Microstereo lithography	6	20
Micro system Packaging: general considerations in packaging design – Levels of Micro system packaging	3	20
Bonding techniques for MEMS : Surface bonding , Anodic bonding , Silicon - on - Insulator , wire bonding , Sealing – Assembly of micro systems	3	20
Overview of MEMS areas : RF MEMS, BioMEMS, MOEMS, NEMS	2	
END SEMESTER EXAM		•
	actuators – micro accelerometer –comb drives - Micro grippers –micro motors, micro valves, micro pumps , Shape Memory Alloys. Review of Mechanical concepts: Stress, Strain, Modulus of Elasticity, yield strength, ultimate strength – General stress strain relations – compliance matrix. Overview of commonly used mechanical structures in MEMS - Beams, Cantilevers, Plates, Diaphragms – Typical applications Flexural beams: Types of Beams, longitudinal strain under pure bending – Deflection of beams – Spring constant of cantilever – Intrinsic stresses Actuation and Sensing techniques : Thermal sensors and actuators, Electrostatic sensors and actuators , Piezoelectric sensors and actuators, magnetic actuators FIRST INTERNAL EXAM Scaling laws in miniaturization - scaling in geometry, scaling in rigid body dynamics, Trimmer force scaling vector, scaling in electrostatic and electromagnetic forces, scaling in electricity and fluidie dynamics, scaling in heat conducting and heat convection. Materials for MEMS – SU-8, PMMA, PDMS, Langmuir – Blodgett Films, Micro System fabrication – Photolithography – Ion implantation-Diffusion – Oxidation – Chemicalvapour deposition – Etching SECOND INTERNAL EXAM Overview of Micro manufacturing – Bulk micro manufacturing, Surface micro machining , LIGA process –Microstereo lithography Micro system Packaging: general considerations in packaging design – Levels of Micro system packaging Bonding techniques for MEMS : Surface bonding , Anodic bonding , Silicon - on - Insulator , wire bonding , Sealing – Assembly of micro systems Overview of MEMS areas : RF MEMS, BioMEMS, MOEMS, NEMS	MEMS – principles and examples of Micro sensors and micro actuators – micro accelerometer – comb drives - Micro grippers –micro motors, micro valves, micro pumps , Shape Memory Alloys. 4 Review of Mechanical concepts: Stress, Strain, Modulus of Elasticity, yield strength, ultimate strength – General stress strain relations – compliance matrix. Overview of commonly used mechanical structures in MEMS - Beams, Cantilevers, Plates, Diaphragms – Typical applications 3 Flexural beams: Types of Beams, longitudinal strain under pure bending – Deflection of beams – Spring constant of cantilever – Intrinsic stresses 3 Actuation and Sensing techniques : Thermal sensors and actuators, Electrostatic sensors and actuators , Piezoelectric sensors and actuators, magnetic actuators 4 Scaling laws in miniaturization - scaling in geometry, scaling in rigid body dynamics, Scaling in heat conducting and heat convection. 5 Materials for MEMS – System fabrication – Photolithography – Ion implantation - Diffusion – Oxidation – Chemicalvapour deposition – Etching 5 Scurview of Micro System fabrication – Photolithography – Ion implantation. Diffusion – Oxidation – Chemicalvapour deposition – Etching 6 Overview of Micro manufacturing – Bulk micro manufacturing, Surface micro machining , LIGA process –Microstereo lithography 3 Bonding techniques for MEMS : Surface bonding , Anodic bonding , Sufface micro machining , LIGA process –Microstereo lithography 6 Overview of Micro system packaging 3 3 Bonding techniques

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question

covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 70 % for theory and 30% for logical/numerical problems, derivation and proof.

COURSE CODE	COURSE NAME	L-T-P-C	YEAR OF INTRODUCTION
EC467	PATTERN RECOGNITION	3-0-0-3	2015
Prerequisit MA201 Lin Methods, Course obj • To s • To i Syllabus: Recognition ML estima Discriminan classificatio Expected of At the end of 1. the of 2. the n 3. the dime 4. imp	te: near Algebra & Complex Analysis, MA204 Probability, Ra ectives: study the fundamental algorithms for pattern recognition nstigate the various classification and clustering techniques Review of Probability Theory and Probability distribu n and its applications, Bayesian decision theory, Bayesian es- tion, EM algorithm, Supervised and unsupervised learn nt Functions, Non-parametric methods, Hidden Markov on, Linear models for regression and classification, Clustering nutcome: of the course, the student should have a clear understanding of design and construction and a pattern recognition system major approaches in statistical and syntactic pattern recognition theoretical issues involved in pattern recognition system ensionality. lementing pattern recognition techniques	ndom Proce tions, Intro timation: C ning, Featu models f: on. design su	esses and Numerical oduction to Pattern aussian distribution, re selection, Linear for sequential data
	da, P.E.Hart and D.G.Stork, Pattern Classification and scene sishop, Pattern Recognition and Machine Learning, Springer	analysis, Jo	
 Robert 2 & Sons Tom Mi Tou and Morton 1993. S.Theod 	J.Schalkoff, Pattern Recognition : Statistical, Structural and N Inc., New York, 2007. itchell, Machine Learning, McGraw-Hill I Gonzales, Pattern Recognition Principles, Wesley Publication Nadier and Eric Smith P., Pattern Recognition Engineering, J Ioridis and K. Koutroumbas, Pattern Recognition, 4th Edition asimha Murty, SusheelaDevi,Pattern Recognition:An Introduc Course Plan	on Company ohn Wiley , Academic	v, London, 1974. & Sons, New York, Press, 2009.
Module	Course content (42 hrs)	Hours	Marks
I	Introduction: Basics of pattern recognition system, various applications, Machine Perception, two main paradigms for pattern recognition problems - statistical and syntactic pattern recognition	3	15%

	Pattern recognition system, Design of Pattern recognition system, Object/process of a Pattern recognition system, Pattern recognition Life Cycle, Cost, Decision concepts and boundaries, Learning & Adaptation.	5	
	Statistical Pattern Recognition: Review of probability theory, Gaussian distribution, Bayes decision theory and Classifiers, Optimal solutions for minimum error and minimum risk criteria Normal density and discriminant functions, Decision surfaces	2	
	Parameter estimation methods:Maximum-Likelihoodestimation,Expectation-		
П	maximization method, Bayesian parameter estimation	3	150/
II	Concept of feature extraction and dimensionality, Curse of dimensionality, Dimension reduction methods - Fisher discriminant analysis, Principal component analysis Hidden Markov Models (HMM) basic concepts, Gaussian	4	15%
	FIRST INTERNAL EXAM		
	Non-Parameter methods: Non-parametric techniques for density estimation - Parzen- window method, K-Nearest Neighbour method.	4	
III	Non-metric methods for pattern classification: Non- numeric data or nominal data Decision trees: Concept of construction, splitting of nodes, choosing of attributes, overfitting, pruning	3	- 15%
IV	Linear Discriminant based algorithm: Perceptron,	6	15%
	Support Vector Machines		
	SECOND INTERNAL EXAM		
V	Non linear classifiers: Multilayer perceptrons, Back Propagation algorithm, Artificial Neural networks	4	20%
	Classifier Ensembles: Bagging, Boosting / AdaBoost	2	
VI	Unsupervised learning: Clustering - Criterion functions for clustering, Algorithms for clustering: K-means and Hierarchical methods, Cluster validation	6	20%
			1
	END SEMESTER EXAM		

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 70 % for theory and 30% for logical/numerical problems, derivation and proof.

COURS		COURSE NAME	L-T-P-C		AR OF DUCTION
EC46		OPTO ELECTRONIC DEVICES	3-0-0-3		015
Prerequis					~ ~ ~
-		ing Physics			
Course ob	-				
1. Explai	n the pl	hysics of absorption, recombination and photoemi	ssion from semic	conductors	
		rent types of photo detectors based on their perfor			
		rent LED structures with material properties and re	eliability aspects.		
		al modulators and optical components			
	ate diffe	erent types of lasers with distinct properties.			
Syllabus:					
Expected					
	-	of the course the student will be able to			
• Ex	plain th	e property of absorption, recombination and photo	oemission in sem	iconducto	ors.
• Illu	istrate d	lifferent types of lasers with distinct properties			
• Ex	plain di	ifferent LED structures with material properties			
• An	alyse d	ifferent types of photo detectors			
• Ex	plain oj	ptical modulators and optical components.			
Reference 1. Fur 2. Bar	e s: ndamen ndyopa	cs Optical Electronics in modern communication, tals of Photonics : B E Saleh and M C Teich, Wil- dhay ,Optical communicatoion and networks.PHI	ey-Interscience; , 2014.		06.
4. Pip 5. Ala	 Mynbaev ,Scheiner,Fiberoptic Communication Technology, Pearson, 2001. Piprek, Semiconductor Optoelectronic Devices, Elsevier, 2008. Alastair Buckley, Organic Light-Emitting Diodes,Woodhead , 2013. 				
200)9				
		Course Plan			
Module		Course content (42hrs)		Hours	Sem. Exam Marks
Ι	absorp effect,	al processes in semiconductors – electron hole otion, Franz-Keldysh effect, Stark effect, quantum deep level transitions, Auger recombination heat ation, heat sources.	n confined Stark	7	
II	Lasers axial feedba	 threshold condition for lasing, line broadening and transverse laser modes, heterojunction lasing took lasers, DBR lasers, quantum well lasers, to modulation of lasers. 	sers, distributed	7	15

FIRST INTERNAL EXAM

III	Nitride light emitters, nitride material properties, InGaN/GaN LED, structure and working ,performance parameters, InGaN/GaN Laser Diode, structure and working , performance parameters. White-light LEDs, generation of white light with LEDs ,generation of white light by dichromatic sources, ,generation of white light by trichromatic sources ,temperature dependence of trichromatic, , 7generation of white light by tetrachromatic and pentachromatic sources,white-light sources based onwavelength converters.	9	15
IV	Optical modulators using pn junction, electro-optical modulators, acousto-optical modulators, Raman-Nath modulators, Franz-Keldysh and Stark effect modulators, quantum well electro-absorption modulators, optical switching and logic devices, optical memory.	5	15
v	Optical detection – PIN, APD, modulated barrier photodiode, Schottky barrier photodiode, wavelength selective detection, micro cavity photodiodes. Optoelectronic ICs , advantages, integrated transmitters and receivers, guided wave devices. Working of LDR ,liquid crystal display, structure ,TFT display, structure, polymer LED, organic LED.	7	20
VI	Introduction to optical components, directional couplers, multiplexers, attenuators, isolators, circulators, tunable filters, fixed filters, add drop multiplexers, optical cross connects, wavelength convertors, optical bistable devices.	7	20
	END SEMESTER EXAM		

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COURSE			YEAR OF
CODE	COURSE NAME	L-T-P-C	INTRODUCTION
	COMMUNICATION SYSTEMS LAB		
EC431	(OPTICAL & MICROWAVE)	0-0-3-1	2015
Prerequisite:			
	ave & Radar Engineering, EC405 Optical Commu	unication	
Course objecti			
	perience on design, testing, and analysis of few	electronic device	s and circuits used for
	optical communication engineering.		
List of Experin			
	periments: (Six mandatory)		
	liode characteristics.		
	Alystron Mode Characteristics.		
	and Frequency measurement.		
	ne relation between Guide wave length, free space	e wave length and	cut off wave length
	ngular wave guide.		
	ment of E-plane and H-plane characteristics.		
	nal Coupler Characteristics.		
	n load impedance measurement using smith chart	and verification	using transmission line
equation			
	ment of dielectric constant for given solid dielectric	ric cell.	
	Pattern Measurement.		
10. Study of	Vector Network Analyser		
	ments: (Six mandatory)	1	1
	ment of Numerical Aperture of a fiber, after prepa	aring the fiber end	18.
	losses in Optical fiber		
	ip of Fiber optic Digital link.	1	
	ion of a Splice joint and measurement of the splic		
	's Current (P-I) characteristics and measure slope	efficiency of Lase	er Diode.
	Vs Current (V-I) characteristics of Laser Diode.	officiency of LEI	
	As Current (P-I) characteristics and measure slope V_{S} Current (V, I) characteristics of LED	entrency of LEI).
0	Vs Current (V-I) characteristics of LED. eristics of Photodiode and measure the responsivit	* 7	
	eristics of Avalanche Photo Diode (APD) and measure the responsivily		x, itx,
		-	
11. Measure	ment of fiber characteristics, fiber damage and sp	nce loss/connecto	$\mathbf{D} \mathbf{T} \mathbf{D} \mathbf{S} \mathbf{S} \mathbf{D} \mathbf{Y} \mathbf{U} \mathbf{T} \mathbf{D} \mathbf{K}.$

CODE COURSE NAME L-T-P-C YEAR OF INTROD	UCTION		
EC 402 NANOELECTRONICS 3-0-0-3 2015			
Prerequisite:			
PH 100 Engineering Physics ,EC203 Solid State Devices ,EC304 VLSI			
Course objectives:			
To learn and understand basic and advance concepts of nanoelectronics.			
Syllabus:	1		
Introduction to nanotechnology, Mesoscopic physics, trends in microelectronics and opt characteristic lengths in mesoscopic systems, Quantum mechanical coherence, S Equation, wave function, Low dimensional structures Quantum wells, Basic proper dimensional semiconductor nanostructures, Quantum wires and quantum dots, c tube,grapheme, Introduction to methods of fabrication of nano-layers, Introduction to charof nanostructures, Principle of operation of Scanning Tunnelling Microscope, X-Ray analysis, MOSFET structures, Quantum wells, modulation doped quantum wells, multi wells, The concept of super lattices, Transport of charge in magnetic field, Nanoelectonic devices, principle of NEMS Expected outcome:	chrodinger's rties of two arbon nand racterization Diffraction ple quantum		
The students should be able to understand basic concepts of nanoelectronic devices and na	no		
technology.			
Text Books:			
1. J.M. Martinez-Duart, R.J. Martin Palma, F. Agulle Rueda Nanotechnology for			
Microelectronics and optoelectronics, Elsevier, 2006			
2. W.R. Fahrner, Nanotechnology and Nanoelctronics, Springer, 2005			
References:			
 Chattopadhyay, Banerjee, Introduction to Nanoscience& Technology, PHI 2012 Poole, Introduction to Nanotechnology, John Wiley 2006. 			
 Poole, Introduction to Nanotechnology, John Whey 2006. George W. Hanson, Fundamentals of Nanoelectronics, Pearson Education, 2009. 			
 K. Goser, P. Glosekotter, J. Dienstuhl, Nanoelectronics and nanosystems, Springer 	2004		
Supriyo Dutta, Quantum Transport- Atom to transistor, Cambridge, 2013.			
6. Murty, Shankar, Text book of Nanoscience and Nanotechnology, Universities Pres	s,2012.		
7. Pradeep, Nano the Essentials, McGrawHill, 2007.			
8. Ramsden, Nanotechnology, Elsevier, 2011.			
9. Vladimir Mitin Michael A. Stroscio, Introduction to Nanoelectronics, Cambridge U	Jniversity		
Press, 2010			
Course Plan			
Module Course content (42hrs) Hou	Sem. rs Exam		
Introduction to nanotechnology, Impacts, Limitations of conventional microelectronics Trends in microelectronics and ontoelectronics	Marks		
migroalastronics Trands in migroalastronics and anteglastronics	Marks		
microelectronics, Trends in microelectronics and optoelectronics	Marks		
IMesoscopic physics, trends in microelectronics and optoelectronics, characteristic lengths in mesoscopic systems, Quantum mechanical2	Marks		

Low dimensional structures Quantum wells, wires and dots, Density of

1

	states and dimensionality		
	Basic properties of two dimensional semiconductor nanostructures, square quantum wells of finite depth, parabolic and triangular quantum wells,	2	
	Quantum wires and quantum dots, carbon nano tube, graphene	1	
	Introduction to methods of fabrication of nano-layers, different (approaches, physical vapour deposition, chemical vapour deposition)	2	
II	Molecular Beam Epitaxy, Ion Implantation, Formation of Silicon Dioxide- dry and wet oxidation methods.	2	
	Fabrication of nanoparticle- grinding with iron balls, laser ablation, reduction methods, sol gel, self assembly, precipitation of quantum	2	15
	dots.		
	FIRST INTERNAL EXAM Introduction to characterization of nanostructures, tools used for of		
	nano materials characterization, microscope-optical, electron, and electron microscope.	2	
III	Principle of operation of Scanning Tunnelling Microscope, Atomic Force Microscope, Scanning Electron microscope, Specimen interaction. Transmission Electron Microscope	2	15
	X-Ray Diffraction analysis, PL & UV Spectroscopy, Particle size analyser.	2	
	MOSFET struct (1996), Heterojunctions	2	
IV	Quantum wells, modulation doped quantum wells, multiple quantum wells	2	15
	The concept of super lattices Kron Penney model of super lattice.	2	
	Transport of charge in Nanostructures under Electric field - parallel transport, hot electrons, perpendicular transport.	2	
V	Quantum transport in nanostructures, Coulomb blockade	2	20
	Transport of charge in magnetic field - Effect of magnetic field on a crystal. Aharonov-Bohm effect, the Shubnikov-de Hass effect, the quantum Hall effect.	3	
	Nanoelectonic devices- MODFETS, heterojunction bipolar transistors	1	
	Resonant tunnel effect, RTD, RTT, Hot electron transistors	2	
1 77	Coulomb blockade effect and single electron transistor, CNT transistors	2	20
VI	Heterostructure semiconductor laser	1	20
	Quantum well laser, quantum dot LED, quantum dot laser	2	
	Quantum well optical modulator, quantum well sub band photo detectors, principle of NEMS.	2	
	END SEMESTER EXAM		

Question Paper The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four

subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 70 % for theory and 30% for logical/numerical problems, derivation and proof.

COURSE CODE	COURSE NAME	L-T-P- C		TEAR OF
EC404	ADVANCED COMMUNICATION SYSTEMS	3-0-0 -3		2015
Radar Engine Course obje	og Communication Engineering, EC302 Digital Commu	inication,	EC403	Microwave &
Satellite com Introduction technologies GSM system Expected ou		f mobile etworks, ntroductio	radio co Over vi on to M	ommunications, ew of WIMAX Iultiple Access
	tudent should able to understand the evolution, basics and nunication system	l technolo	ogy of ac	lvanced
Text Books:	numeation system			
Fram 2. Denn 3. Theo Educe 4. Simo References: 1. Singa 2. Natha 3. Mishi 4. W.C. 5. Joche 6. Dalal 7. Stalli 8. Schw	e Benoit, Digital Television Satellite, Cable, Terrestrial, IF ework, 3/e, Focal Press, Elsevier, 2008 is Roody, Satellite communication, 4/e, McGraw Hill, 200 dore S. Rappaport: Wireless communication principles and ation, 1990 n Haykin, Michael Mohar, Modern wireless communication ation, 1990 n Haykin, Michael Mohar, Modern wireless communication an, Wireless communications, Mc Graw Hill, 2010. an, Wireless communications, PHI, 2012. ra, Wireless communications and Networks, McGraw Hill Y.Lee, Mobile Cellular Telecommunication, McGraw Hill en Schiller, Mobile Communications, Pearson, 2008. , Wireless communication, Oxford Universities Press, 20 ngs, Wireless communications and Networks, Pearson, 2 artz Mobile, Wireless communications, Cambridge Universities si, Advanced Electronic Communication Systems, 6/e, Pe Course Plan	06. d practice on, Pears 1, 2/e, 201 1, 2010. 014. 2009. ersities Pr	e,2/e, Pe on Educ 13. ress, 201	arson ation,2008
				Sem. Exam
Module	Course content (42hrs)		Hours	Marks
I	Microwave Radio Communications : Introduction, Adva and Disadvantages , Analog vs digital microwave, freque amplitude modulation Frequency modulated microwave radio system, FM micro radio repeaters, Diversity, protection switching arrangements, FM micro radio stations, microwave repeater station, line of sight p characteristics.	ency vs rowave wave	1 1 2	15
II	Digital TV: Digitized Video, Source coding of Digitized Video, Compression of Frames, DCT based (JPED),		4	

	Compression of Moving Disturgs (MDEC) Desighter of		
	Compression of Moving Pictures (MPEG). Basic blocks of MPEG2 and MPE4,Digital Video Broadcasting (DVB)		
	Modulation: QAM (DVB-S, DVB-C), OFDM for Terrestrial Digital TV (DVB –T). Reception of Digital TV Signals (Cable, Satellite and terrestrial). Digital TV over IP, Digital terrestrial TV for mobile.	4	15
	Display Technologies: basic working of Plasma, LCD and LED Displays.	2	
	FIRST INTERNAL EXAM		
	Satellite Communication systems, introduction, Kepler's laws, orbits, orbital effects, orbital perturbations	2	
III	Satellite sub systems, Antennas, Transponders, earth station technology, Link calculation,	2	15
m	Satellite systems- GEO systems, non-GEO communication systems, Satellite Applications- Global Positioning System, Very Small Aperture Terminal system, Direct to Home Satellite Systems.	3	15
	Evolution of mobile radio communications, paging systems, Cordless telephone systems, comparison of various wireless systems	2	
IV	Introduction to Modern Wireless Communication Systems, Second generation cellular networks, third generation wireless networks, fourth generation wireless technologies	1	15
	Wireless in local loop, wireless local area networks, Blue tooth and Personal Area networks, Over view of WIMAX Technologies, architecture, spectrum allocation	2	
v	Cellular concept, hand off strategies, Interference and system capacity: Cell splitting, Sectoring, Repeaters, and Microcells. Cellular System Design Fundamentals: Frequency Reuse, channel assignment strategies, handoff Strategies, Interference and system capacity, tracking and grade off service, improving coverage and capacity	3	20
	Wireless propagation mechanism, free space propagation model, ground reflection model, knife edge diffraction model, path loss prediction in hilly terrain, introduction to fading and diversity techniques, Introduction to MIMO system	3	
	Introduction to Multiple Access, FDMA, TDMA, Spread Spectrum multiple Access, space division multiple access, CDMA, OFDM,	2	
VI	Wireless Networking, Difference between wireless and fixed telephone networks, development of wireless networks, fixed network transmission hierarchy, traffic routing in wireless networks, wireless data services, Wireless standards,	2	20
	GSM system architecture, radio link aspects, network aspects	1	
	Introduction to new data services like High Speed Circuit Switched Data (HSCSD), General Packet Radio Service (GPRS), Digital Enhanced Cordless Telecommunications	5	

Ultra wideband systems (UWB), Push To Talk (PTT) technology, Mobile IP	
(DECT), Enhanced Data Rate for Global Evolution (EDGE),	

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 60 % for theory and 40% for logical/numerical problems, derivation and proof.

CODE	COURSE NAME	L-T-P-C	YEAR INTRODU	
EC462	MIXED SIGNAL CIRCUIT DESIGN	3-0-0 -3	201	
Prerequisite	4 1			
	bg Integrated Circuit, EC 304 VLSI, EC308 E	Embedded Systems		
Course obje	ctives:			
-	knowledge about various analog and digital C	CMOS circuits and to	o get the skill	of analysis
0	f analog and digital CMOS circuits.			
Syllabus:				
Mirror, MOS amplifier,CM References, I	lifiers: CS,CG,CD stages, Cascoded stages,Fo SFET cascode current mirror, Differential Am IOS OP AMPS, Design of classical Two Stag Phase Locked Loop,Dynamic analog circuits, a Converters- Specifications ,DAC ,ADC Arc	plifiers,MOS telesco ge OP AMP ,Compa Data Converters, Sv	opic cascode rator,Band gap	р
Expected ou	• • • • • • • • • • • • • • • • • • •			
CMOS circu		nd Analysis of vario	us analog and	digital
Text Books:				
	vi B., Fundamentals of Microelectronics, Wild p E. Allen, Douglas R. Holbery, CMOS Anal	•		
References:				
1 Dogo	\mathbf{D} Design of Augles CMOC Intermeted C:			
	vi B., Design of Analog CMOS Integrated Cir r, Li, Boyce, CMOS: Circuits Design, Layout			lia, 2000
				lia, 2000
	r, Li, Boyce, CMOS: Circuits Design, Layout	and Simulation, Pre		lia, 2000 Sem. Exam Marks
2. Bake	r, Li, Boyce, CMOS: Circuits Design, Layout Course Plan Course content (42hr CMOS Amplifiers- Common Source with and current source load, CS stage with source stage and Source Follower (Only Voltage G	s) diode connected loa	Hours	Sem. Exam
2. Bake	r, Li, Boyce, CMOS: Circuits Design, Layout Course Plan Course content (42hr CMOS Amplifiers- Common Source with and current source load, CS stage with source	s and Simulation, Press s) diode connected loa ce degeneration, CG ain and Output	Hours	Sem. Exam
2. Bake Module I	r, Li, Boyce, CMOS: Circuits Design, Layout Course Plan Course content (42hr CMOS Amplifiers- Common Source with and current source load, CS stage with source stage and Source Follower (Only Voltage G impedance of circuits) Cascoded stages - Cascoded amplifier, Case	and Simulation, Press) diode connected loa ce degeneration, CG ain and Output coded amplifier with S and NMOS currer	Hours Hours A A A A A A A A A A A A A A A A A A A	Sem. Exam Marks
2. Bake	r, Li, Boyce, CMOS: Circuits Design, Layout Course Plan Course content (42hr CMOS Amplifiers- Common Source with and current source load, CS stage with source stage and Source Follower (Only Voltage G impedance of circuits) Cascoded stages - Cascoded amplifier, Casc cascoded loads , Folded cascode Amplifier MOS Current Mirror- Basic circuit ,PMO mirrors Current mirror copying circuits, MOSFET c	and Simulation, Press (s) diode connected loa ce degeneration, CG ain and Output coded amplifier with S and NMOS currer cascode current mirror fier with MOS currer current mirror load,	Hours Hours ds 4 h 4 ht 3 ent 4	Sem. Exam Marks
2. Bake Module I	r, Li, Boyce, CMOS: Circuits Design, Layout Course Plan Course content (42hr CMOS Amplifiers- Common Source with and current source load, CS stage with source stage and Source Follower (Only Voltage G impedance of circuits) Cascoded stages - Cascoded amplifier, Case cascoded loads , Folded cascode Amplifier MOS Current Mirror- Basic circuit ,PMO mirrors Current mirror copying circuits, MOSFET c circuits Differential Amplifiers-Differential Ampli source Load, with cascaded load and with o MOS telescopic cascode amplifier. (Only Ve	and Simulation, Press (s) diode connected load ce degeneration, CG ain and Output coded amplifier with S and NMOS current cascode current mirror fier with MOS current fier with MOS current current mirror load, oltage Gain and Out	Hours Hours ds 4 h 4 ht 3 ent 4	Sem. Exam Marks

	Comparator- Characterization of a comparator-static and dynamic ,A Two stage open loop comparator (analysis not required)	3	
IV	Band gap References- Supply Independent Biasing, Temperature independent references –band gap reference	5	15
ĨV	Phase Locked Loop – Simple PLL ,Basic PLL Topology ,Charge Pump PLL, Basic Charge Pump PLL	3	15
V	Dynamic analog circuits – charge injection and capacitive feed through in MOS switch, Reduction technique	3	20
v	Switched Capacitor Circuits - sample and hold circuits ,Switched Capacitor Integrator, Ladder filters	3	
VI	Data Converters- DAC Specifications-DNL, INL, latency, SNR, Dynamic Range ADC Specifications-Quantization error, Aliasing, SNR, Aperture error	4	20
	 DAC Architecture – Resistor String, Charge Scaling and Pipeline types. ADC Architecture- Flash and Pipe line types 	3	
	END SEMESTER EXAM		

The question raper The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 60 % for theory and 40% for logical/numerical problems, derivation and proof.

COURS						
CODE		COURSE NAME	L-T-P-C	YEAR OF IN		CTION
EC464		LOW POWER VLSI	3-0-0 -3	20	015	
Prerequisite: EC204 Analog Integrated Circuit, EC 204 VI SL EC208 Embedded Systems						
EC204 Analog Integrated Circuit, EC 304 VLSI, EC308 Embedded Systems Course objectives:						
	0		• •	· MOG1 ·	. 1	
•	 To identify the power dissipation mechanisms in various MOS logic styles To Familiarize with the suitable techniques to reduce power dissipation 					
• Syllabus:		Familiarize with the suitable techni	ques to redu	ce power dissipa	uon	
v		ver dissipation in MOSFET device	res Sources	of nower dissi	nation in	CMOS
•		ues for leakage power reduction,				
	-	design style, Adiabatic switching.	Design and			, 1,011
Expected						
-		ould able to:				
1. Id	entify	the sources of power dissipation in	n digital IC s	systems. Underst	and the in	npact of
	•	on system performance and reliability	-	•		
		and leakage sources and reduction	1			
		ise advanced issues in VLSI system	ns, specific (to the deep-subm	icron silic	con
	chnol	0				
Text Boo		the mechanisms of power dissipat	tion in CMC	S integrated circ	uits	
		k Roy, Sharat C Prasad, Low pov	ver CMOS	VI SI circuit des	ion Wile	v India
)00	rioy, shara e Trasad, Low por		VLDI eneun des	15 ¹¹ , ¹¹ 1	y mara,
2. G	ray Y	eap, Practical low power digital VI	LSI design, S	Springer, 1998		
Referenc	es:			÷ •		
	iat Sei ill, 20	ng Yeo, Kaushik Roy, Low voltage 04	e, low power	r VLSI sub system	ms, Tata I	McGraw
		P Chandrakasan, Robert W Bro	odersen, Lo	w power digital	CMOS	Design,
		Academic,1995		T		
		n Piguet, Low power CMOS circuit	•		T .J!	171
		tif Bellaouar, Mohamed I Elmas nic,1995	ry, Low po	wer digital VLS	i design,	Kluwer
	cauen	Course Plan	1			
Module		Course content (4				Sem.
		(~)		Hours	Exam
						Marks
	•	sics of Power dissipation in MOS		s	2	
	MIS	structure, Need for low power circ	uit design		Z	
	Thre	shold voltage, body effects,			1	
Ι	Shor	t channel effects-surface scattering	, punch thro	ugh, velocity	2	15
	satur	ation, impact ionization			Δ	
	effec				2	
		ces of power dissipation in CMO	S-Switching	g power	2	
II		pation,				15
	Shor	t circuit power dissipation, glitchin	g power dis	sipation	2	

	Leakage power dissipation , Transistor leakage mechanisms of deep submicron transistors	3	
	FIRST INTERNAL EXAM		
	Circuit techniques for leakage power reduction – standby leakage control using transistor stacks	2	
	multiple V _{th} techniques, Dynamic V _{th} techniques	2	
III	supply voltage scaling techniques, Deep submicron devices design issues	2	15
	Minimizing short channel effect	2	
	Design and test of low voltage CMOS – Circuit design style- clocked design style- Basic concept	2	
IV	Domino logic (domino NAND gate)	1	15
	Differential Current Switch Logic.	2	
	SECOND INTERNAL EXAM		
	Non clocked circuit design style-fully complementary logic	2	
v	NMOS and pseudo – NMOS logic	2	20
•	differential cascade voltage switch logic(DCVS),	2	20
	pass transistor logic	2	
	Adiabatic switching – Adiabatic charging, adiabatic amplification	2	
371	One stage and two stage adiabatic buffer	2	20
VI	fully adiabatic system	1	-
	Adiabatic logic gates, pulsed power supplies	2	
	END SEMESTER EXAM		

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 60 % for theory and 40% for logical/numerical problems, derivation and proof.

COURSE							
CODE		COURSE NAME		L-T-P-C	YEAR OF INT	RODUC	TION
EC466	5	CYBER SECURIT	Y	3-0-0 -3		2016	
Prerequisi	te:						
		Communication					
Course obj	jective	s:					
		rize various types of cybe		and cyber-	crimes.		
	0	overview of the cyber law					
	study t	he defensive techniques ag	gainst the	ese attacks			
Syllabus:							
		nning, tools for scanning,					
		Private Networks, Scan	ning for	web vulne	rabilities tools, C	yber crin	nes and law,
cyber crin							
Expected of							
		d able to understand cybe		• •		r laws and	d also how to
Text Book		and ultimately the entire In	nternet co	ommunity i	rom such attacks		
		er Tool Kit, Mike Shema,	Mo Grov	w U;11			
		urity Understanding Cybe			Forensics and L	ogal Persi	pectives Nina
-		nd Sunit Belpure, Wiley		s, compute	Torensies and Ex	igar r crsj	peetr ves,i vina
U100							
		na Sunn Beipure, wiley					
Referen	ces:	· · ·	d Networ	rking (Glob	al Edition) 5e, M	cGraw H	fill Education
Referen 1. For	ces:	Data Communication and	d Networ	rking (Glob	al Edition) 5e, M	cGraw H	fill Education
Referen 1. Fore Indi	c es: ouzan, ia, 201	Data Communication and		•		cGraw H	[ill Education
Referen 1. Fore Indi 2. Fore 3. Act	ouzan, ouzan, ia, 201 ouzan, nyut S.	Data Communication and 3. TCP/IP Protocol Suite 4e, Godbole Data Communic	McGraw	v Hill Educ	ation India, 2010		
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IV	Web Application Tools Scanning for web vulnerabilities tools: Nikto, W3af, HTTP utilities - Curl, OpenSSL and Stunnel, Application Inspection tools – Zed Attack Proxy, Sqlmap. DVWA, Webgoat, Password Cracking and Brute-Force Tools – John the Ripper, L0htcrack, Pwdump, HTC- Hydra	6	15
	SECOND INTERNAL EXAM		
v	Introduction to Cyber Crime and law Cyber Crimes, Types of Cybercrime, Hacking, Attack vectors, Cyberspace and Criminal Behavior, Clarification of Terms, Traditional Problems Associated with Computer Crime, Introduction to Incident Response, Digital Forensics, Computer Language, Network Language, Realms of the Cyber world, A Brief History of the Internet, Recognizing and Defining Computer Crime, Contemporary Crimes, Computers as Targets, Contaminants and Destruction of Data, Indian IT ACT 2000.	8	15
VI	Introduction to Cyber Crime Investigation Firewalls and Packet Filters, password Cracking, Keyloggers and Spyware, Virus and Warms, Trojan and backdoors, Steganography, DOS and DDOS attack, SQL injection, Buffer Overflow, Attack on wireless Networks	6	20

Question Paper The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 100 % for theory.

COURSE CODE	COURSE NAME	L-T-P-C		YEAR O RODUC	
EC468	SECURE COMMUNICATION	3-0-0-3	11911	2015	
Prerequisite:N		5-0-0-5		2013	
Course objecti					
•	tudents about the theory and technology be	hind the secur	e commun	ication.	
Syllabus:					
The Euclidean a Symmetric Cip encryption Stan Cipher, Public k Expected outco The student will 1. Expo main		Polynomial an asposition tech is Advanced I s, Password m security and t	ithmetic, S iniques ,B Encryption anagement he algorith	Symmetri lock Cip standard	ic Ciphers, hers, Data , The AES e for
impl	ementation				
Text Books:					
2. William	A. Fourcuzan, Cryptography and Network Stallings, Cryptography and Network secur Hall of India, New Delhi, 2002				
References:					
 Thomas Press,20 Tyagi ar Douglas Press Co Lawrence Press Co 	d Yadav, Cryptography and network secur A. Stinson, Cryptography, Theory and Pra- mpany, Washington, 2005. e C. Washington,Elliptic Curves: Theory a ompany, Washington, 2008. Dummit & Richard M Foote, Abstract Alg	ith Application rity, Dhanpatra ctice, 2nd Edit nd Cryptograp	ai, 2012 tion, Chapi shy, Chapn	man & H nan & Ha	all, CRC ıll, CRC
	Course Plan				
Module	Course content (42hrs)			Hours	Sem. Exam Marks
I atta	oduction on security, security goals and typ ck, active attack, attacks on confidentiality, availability, Security services and mechani	attacks on int		5	15
	lular arithmetic: Groups, Ring, Fields. The te fields of the form GF(p),	Euclidean alg	orithm,	4	
Pol	nomial arithmetic: Finite fields of the form	n GF (2n).		4	15
	FIRST INTERNAL EXAN	1			
III Syn	metric Ciphers, Symmetric Cipher Model			3	15

	Substitution Techniques, Caesar Cipher, Mono alphabetic Cipher, Play fair cipher, Hill cipher, Poly alphabetic Cipher, one time pad	4	
	Transposition techniques ,Block Ciphers, Data encryption Standards, DES Encryption, DES decryption	3	
IV	Differential and Linear Crypt analysis Advanced Encryption standard	2	15
	The AES Cipher, substitute bytes transformation, Shift row transformation, Mix Column transformation.	2	
V	Public key cryptosystem, Application for Public key cryptosystem requirements	2	20
v	RSA algorithm, Key management, Distribution of public key, public key certificates, Distribution of secret keys.	5	20
VI	Intruders: Intrusion techniques, Intrusion detection, Statistical anomaly detection, Rule based intrusion detection, Distributed intrusion detection, Honey pot, Intrusion detection exchange format.	5	20
	Password management: Password protection, password selection strategies.	2	
	END SEMESTER EXAM		

The question paper shall consist of three parts. Part A covers I and II module, Part B covers III and IV module, Part C covers V and VI module. Each part has three questions which may have maximum four subdivisions. Among the three questions one will be a compulsory question covering both modules and the remaining from each module, of which one to be answered. Mark patterns are as per the syllabus with maximum 50 % for theory and 50% for logical/numerical problems, algorithms, derivation and proof.

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CODE	1	COURSE NAME	L-T-P-C	YEAR OF IN	IKODU	TION
EC472	,	INTEGRATED OPTICS & PHOTONIC SYSTEMS	3-0-0 -3	2	015	
Prerequis		FHOTOMIC STSTEMS	3-0-0-3	2	015	
_		Electromagnetic Theory, EC405	Ontical Co	nmunication		
Course ob			Optical Col	minimation		
 This complete photon system The condesign current 	ourse ic syst opera ourse i tools, state-	discusses basic goals, principles ems, and explains how the various e and how they are integrated into includes study about various com- fabrication techniques, and the app of-the-art devices and systems will	bus optoelect a system. ponents like plications of also be inve	ronic devices of a optical waveguide optical integrated o stigated.	n integrat es, optica circuits. S	ted optical l couplers, ome of the
Waveguide n optical v n Wavegu aser, integ ntegrated	e Fabr wave g uides, grated circui	w of Electromagnetics: Maxwe cation Techniques, Electro-Optic uide, Wave guide input and outpu FFT-BPM, FD-BPM, Electro-Op semiconductor optical amplifier, a s, devices and systems for telect s, photonic crystals, nanophotonic	Waveguides t couplers, co otic Modulat integrated op communication	s, Polymer Waveg oupled mode theory ors: Types, Integr otical detectors, ap	uide Devi y, Light P ated sem plications	ce, Losses ropagatior iconductor of optical
Expected	-	· · ·				
 dev wa light The Ap Na 	vices the ve guid nt prop e fabrid plication no pho as:	have an in depth knowledge of at are basic components of integra- les, optical couplers, Lasers, Detec agation in waveguides cation process of Optical Integrated ons of Optical Integrated devices	ctors and mo		s includir	ng Optical
1. Ro	bert H	tonic devices	rv and techno	blogy 6/e Springer.	2009	
		unsperger, Integrated optics : Theoret ntegrated Photonics: Fundamentals	•	•• • •	2009	
2. Lif	ante, I	insperger, Integrated optics : Theorem	•	•• • •	2009	
2. Lif Reference 1. Ke 2. Pap 3. H. Pro RELATED	ante, I s: icoIizu opanna Nishi ofessio D LINH	insperger, Integrated optics : Theoret itegrated Photonics: Fundamentals ka, Elements of photonics, John W reddy, Introduction to light wave s hara, M. Haruna, and T. Sul hal, 1989. S photonics society: <u>www.ieee.org/</u>	viley, 2002 . systems,Artenara, Optica	2003 ch House,1995		:Graw-Hill
2. Lif Reference 1. Ke 2. Pap 3. H. Pro RELATED	ante, I s: icoIizu opanna Nishi ofessio D LINH	Insperger, Integrated optics : Theoretegrated Photonics: Fundamentals ka, Elements of photonics, John W reddy, Introduction to light wave s hara, M. Haruna, and T. Sul nal, 1989.	viley, 2002 . systems,Artenara, Optica	2003 ch House,1995		Graw-Hill
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END SEMESTER EXAM					
VI	Devices and Systems for Telecommunications- Microwave Carrier Generation by Optical Techniques, - Photonic Crystals- Nanophotonic Device.	4	20		
	Applications of Optical Integrated Circuits-Spectrum Analyser- Temperature and High Voltage Sensors,	3			
	Integrated semiconductor laser, integrated semiconductor optical amplifier, integrated optical detectors, structures.	3			
V	Electro-Optic Modulators - Basic Operating Characteristics- The Electro-Optic Effect,Mach-Zehnder Modulator, acousto optic modulator,	4	20		
IV	Light Propagation in Waveguides: The Beam Propagation Method- Fresnel Equation - Fast Fourier Transform Method (FFT-BPM) - Solution based on discrete fourier transform - Method Based on Finite Differences (FD-BPM), Boundary Conditions	7	15		
	Optical Fiber Couplers and Splitters, coupled mode theory	3	1		
III	Losses in optical wave guide, measurement of losses. Wave guide input and output couplers, types of couplers, coupling between wave guides,	4	15		
FIRST INTERNAL EXAM					
II	Types of Polymers-Polymer Waveguide Devices, Optical Fiber Waveguide Devices	3	15		
TT	Waveguide Fabrication Techniques -substrate materials for optical IC, Epitaxially Grown Waveguides- Electro-Optic Waveguides,				

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